

ADC32J4x 具有 JESD204B 接口的双通道、14 位、50MSPS 至 160MSPS 模数转换器

1 特性

- 双通道
- 14 位分辨率
- 单电源：1.8V
- 支持 1 分频、2 分频和 4 分频的灵活输入时钟缓冲器
- $f_{IN} = 70\text{MHz}$ 时，信噪比 (SNR) = 72.2dBFS，无杂散动态范围 (SFDR) = 87dBc
- 超低功耗：
 - 160MSPS 时为每通道 227mW
- 通道隔离：105dB
- 内部抖动
- JESD204B 串口：
 - 兼容子类 0、1、2，速率最高达 3.2Gbps
 - 支持每个 ADC 一条通道（高达 160MSPS）
- 支持多芯片同步
- 与 12 位版本器件 (ADC32J2X) 引脚到引脚兼容
- 封装：超薄四方扁平无引线 (VQFN)-48 (7mm x 7mm)

2 应用

- 多载波、多模式蜂窝基站
- 雷达和智能天线阵列
- 炮弹制导
- 电机控制反馈
- 网络和矢量分析器
- 通信测试设备
- 无损检测
- 微波接收器
- 软件定义无线电 (SDR)
- 正交和分集无线电接收器

3 说明

ADC32J4x 属于高线性度、超低功耗、双通道、14 位、50MSPS 至 160MSPS 模数转换器 (ADC) 系列。此类器件专门设计用于支持具有宽动态范围需求且要求苛刻的高输入频率信号。时钟输入分频器可给予系统时钟架构设计更高的灵活性，SYSREF 输入可实现整个系统同步。ADC32J4x 系列支持 JESD204B 接口，减少了接口线路数，从而实现高系统集成度。

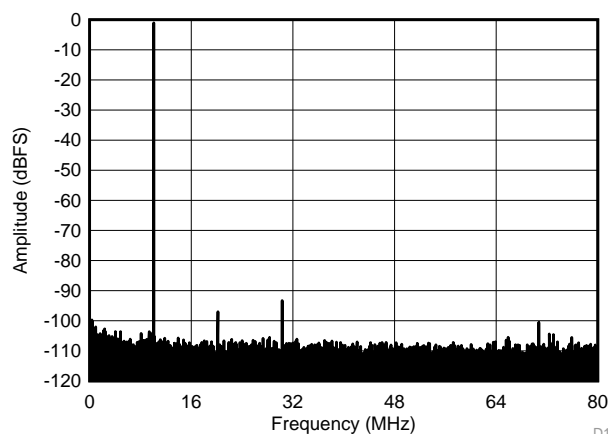
JESD204B 接口是串行接口，仅通过一个差分对即可串行输出每个 ADC 的数据。内部锁相环 (PLL) 会将传入的 ADC 采样时钟乘以 20，以获得串行化各通道的 14 位数据时所使用的位时钟。该器件支持子类 1，接口速率高达 3.2Gbps。

器件信息⁽¹⁾

| 器件型号 | 封装 | 封装尺寸 (标称值) |
|----------|-----------|-----------------|
| ADC32J4x | VQFN (48) | 7.00mm x 7.00mm |

(1) 要了解所有可用封装，请见数据表末尾的封装选项附录。

$f_S = 160\text{MSPS}$ 且 $f_{IN} = 10\text{MHz}$ 时的性能
(SNR = 72.5dBFS, SFDR = 92dBc)



D101



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4 修订历史记录

Changes from Original (May 2014) to Revision A

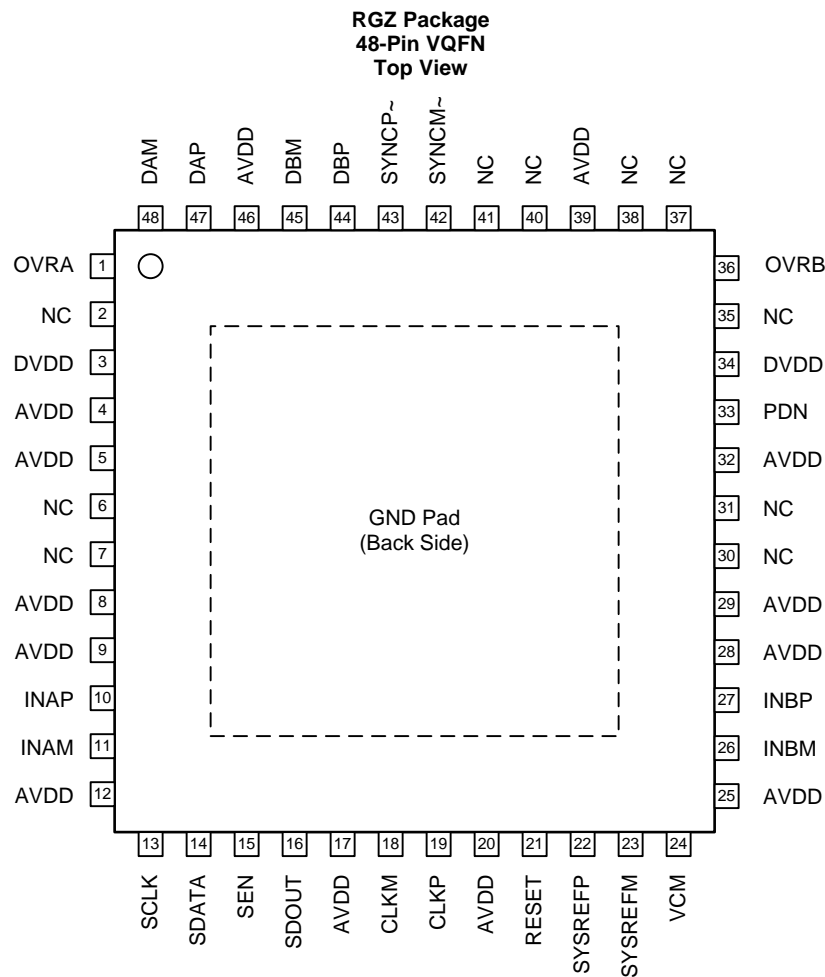
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| | | |
|---|---------------------|----------|
| • | 已从产品预览更改为量产数据 | 1 |
|---|---------------------|----------|

5 Device Comparison Table

| INTERFACE | RESOLUTION (Bits) | 25 MSPS | 50 MSPS | 80 MSPS | 125 MSPS | 160 MSPS |
|-------------|-------------------|---------|----------|----------|----------|----------|
| Serial LVDS | 12 | ADC3221 | ADC3222 | ADC3223 | ADC3224 | — |
| | 14 | ADC3241 | ADC3242 | ADC3243 | ADC3244 | — |
| JESD204B | 12 | — | ADC32J22 | ADC32J23 | ADC32J24 | ADC32J25 |
| | 14 | — | ADC32J42 | ADC32J43 | ADC32J44 | ADC32J45 |

6 Pin Configuration and Functions



Pin Functions

| PIN | | I/O | DESCRIPTION |
|---------|--|-----|---|
| NAME | NO. | | |
| AVDD | 4, 5, 8, 9, 12, 17, 20, 25, 28, 29, 32, 39, 46 | I | Analog 1.8-V power supply |
| CLKM | 18 | I | Negative differential clock input for the ADC |
| CLKP | 19 | I | Positive differential clock input for the ADC |
| DAM | 48 | O | Negative serial JESD204B output for channel A |
| DAP | 47 | O | Positive serial JESD204B output for channel A |
| DBM | 45 | O | Negative serial JESD204B output for channel B |
| DBP | 44 | O | Positive serial JESD204B output for channel B |
| DVDD | 3,34 | I | Digital 1.8-V power supply |
| GND | PowerPAD™ | I | Ground, 0 V |
| INAM | 11 | I | Negative differential analog input for channel A |
| INAP | 10 | I | Positive differential analog input for channel A |
| INBM | 26 | I | Negative differential analog input for channel B |
| INBP | 27 | I | Positive differential analog input for channel B |
| NC | 2, 6, 7, 30, 31, 35, 37, 38, 40, 41 | — | Do not connect |
| OVRA | 1 | O | Overrange indicator for channel A |
| OVRB | 36 | O | Overrange indicator for channel B |
| PDN | 33 | I | Power-down control. This pin has an internal 150-kΩ pulldown resistor. |
| RESET | 21 | I | Hardware reset; active high. This pin has an internal 150-kΩ pulldown resistor. |
| SCLK | 13 | I | Serial interface clock input. This pin has an internal 150-kΩ pulldown resistor. |
| SDATA | 14 | I | Serial Interface data input. This pin has an internal 150-kΩ pulldown resistor. |
| SDOUT | 16 | O | Serial interface data output |
| SEN | 15 | I | Serial interface enable. This pin has an internal 150-kΩ pullup resistor to AVDD. |
| SYNCM~ | 42 | I | Positive JESD204B SYNC~ input |
| SYNCP~ | 43 | I | Negative JESD204B SYNC~ input |
| SYSREFM | 23 | I | Negative external SYSREF input |
| SYSREFP | 22 | I | Positive external SYSREF input |
| VCM | 24 | O | Common-mode voltage output for analog inputs |

7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | MIN | MAX | UNIT |
|--------------------------------|--|------|------------------------------|------|
| Supply voltage range, AVDD | | -0.3 | 2.1 | V |
| Supply voltage range, DVDD | | -0.3 | 2.1 | V |
| Voltage applied to input pins: | INAP, INBP, INCP, INDP, INAM, INBM, INCM, INDM | -0.3 | Minimum (AVDD + 0.3, 2.1) | V |
| | CLKP, CLKM ⁽²⁾ | -0.3 | Minimum (AVDD + 0.3, 2.1) | V |
| | SYSREFP, SYSREFM, SYNCN~, SYNCM~ | -0.3 | Minimum (AVDD + 0.3, 2.1) | V |
| | SCLK, SEN, SDATA, RESET, PDN | -0.3 | 3.6 | V |
| Temperature | Operating free-air, T _A | -40 | 85 | °C |
| | Operating junction, T _J | | 125 | °C |
| | Storage, T _{stg} | -65 | 150 | °C |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) When AVDD is turned off, TI recommends switching off the input clock (or ensuring the voltage on CLKP, CLKM is less than |0.3 V|). This configuration prevents the ESD protection diodes at the clock input pins from turning on.

7.2 ESD Ratings

| | | | VALUE | UNIT |
|--------------------|-------------------------|---|-------|------|
| V _(ESD) | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾ | ±2000 | V |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | MIN | NOM | MAX | UNIT |
|--------------------------------------|---|---------------------------------|-----|------|--------------------|
| SUPPLIES | | | | | |
| AVDD | Analog supply voltage range | 1.7 | 1.8 | 1.9 | V |
| DVDD | Digital supply voltage range | 1.7 | 1.8 | 1.9 | V |
| ANALOG INPUT | | | | | |
| V _{ID} | Differential input voltage | For input frequencies < 450 MHz | | 2 | V _{PP} |
| | | For input frequencies < 600 MHz | | 1 | V _{PP} |
| V _{IC} | Input common-mode voltage | VCM ± 0.025 | | | V |
| CLOCK INPUT | | | | | |
| Input clock frequency | | Sampling clock frequency | | 15 | 160 ⁽²⁾ |
| Input clock amplitude (differential) | | Sine wave, ac-coupled | | 0.2 | 1.5 |
| | | LVPECL, ac-coupled | | | 1.6 |
| | | LVDS, ac-coupled | | | 0.7 |
| Input clock duty cycle | | 35% | 50% | 65% | |
| Input clock common-mode voltage | | | | 0.95 | V |
| DIGITAL OUTPUTS | | | | | |
| C _{LOAD} | Maximum external load capacitance from each output pin to GND | | | 3.3 | pF |
| R _{LOAD} | Single-ended load resistance | | | 50 | Ω |

- (1) After power-up, to reset the device for the first time, only use the RESET pin; see the [Register Initialization](#) section.
- (2) With the clock divider enabled by default for divide-by-1. Maximum sampling clock frequency for the divide-by-4 option is 640 MSPS.

7.4 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | ADC32J4x | UNIT |
|-------------------------------|--|------------|------|
| | | RGZ (VQFN) | |
| | | 48 PINS | |
| R _{θJA} | Junction-to-ambient thermal resistance | 25.7 | °C/W |
| R _{θJC(top)} | Junction-to-case (top) thermal resistance | 18.9 | °C/W |
| R _{θJB} | Junction-to-board thermal resistance | 3.0 | °C/W |
| ψ _{JT} | Junction-to-top characterization parameter | 0.2 | °C/W |
| ψ _{JB} | Junction-to-board characterization parameter | 3 | °C/W |
| R _{θJC(bot)} | Junction-to-case (bottom) thermal resistance | 0.5 | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

7.5 Electrical Characteristics

Typical values are over the operating free-air temperature range, at T_A = 25°C, full temperature range is T_{MIN} = -40°C to T_{MAX} = 85°C, maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and -1-dBFS differential input, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------------------------|---|---|--------|-----|-----------------|
| ANALOG INPUT | | | | | |
| | Differential input full-scale | | 2.0 | | V _{PP} |
| r _i | Input resistance | Differential at dc | 6.5 | | kΩ |
| c _i | Input capacitance | Differential at dc | 5.2 | | pF |
| V _{OC(VCM)} | VCM common-mode voltage output | | 0.95 | | V |
| | VCM output current capability | | 10 | | mA |
| | Input common-mode current | Per analog input pin | 1.5 | | μA/MSPS |
| | Analog input bandwidth (3 dB) | 50-Ω differential source driving a 50-Ω termination across INP, INM | 450 | | MHz |
| DC ACCURACY | | | | | |
| E _O | Offset error | | -20 | 20 | mV |
| E _{G(REF)} | Gain error as a result of internal reference inaccuracy alone | | -3 | 3 | %FS |
| E _{G(CHAN)} | Gain error of channel alone | | ±1 | | %FS |
| α _(EGCHAN) | Temperature coefficient of E _{G(CHAN)} | | -0.017 | | Δ%FS/Ch |
| CHANNEL-TO-CHANNEL ISOLATION | | | | | |
| Crosstalk ⁽¹⁾ | f _{IN} = 10 MHz | | 105 | | dB |
| | f _{IN} = 100 MHz | | 105 | | dB |
| | f _{IN} = 200 MHz | | 105 | | dB |
| | f _{IN} = 230 MHz | | 105 | | dB |
| | f _{IN} = 300 MHz | | 105 | | dB |

(1) Crosstalk is measured with a -1-dBFS input signal on aggressor channel and no input on victim channel.

7.6 Electrical Characteristics: ADC32J44, ADC32J45

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input, unless otherwise noted.

| PARAMETER | ADC32J44 | | | ADC32J45 | | | UNIT |
|--------------------------------------|----------|-----|-----|----------|-----|-----|------|
| | MIN | TYP | MAX | MIN | TYP | MAX | |
| ADC clock frequency | | | 125 | | | 160 | MSPS |
| Resolution | 14 | | | 14 | | | Bits |
| 1.8-V analog supply current | | 177 | 292 | | 192 | 302 | mA |
| 1.8-V digital supply current | | 46 | 65 | | 56 | 80 | mA |
| Total power dissipation | | 401 | 535 | | 454 | 560 | mW |
| Global power-down dissipation | | 5 | | | 5 | | mW |
| Wake-up time from global power-down | | 85 | | | 85 | | us |
| Standby power-down dissipation | | 112 | | | 118 | | mW |
| Wake-up time from standby power-down | | 35 | | | 35 | | μs |

7.7 Electrical Characteristics: ADC32J42, ADC32J43

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, maximum sampling rate, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input, unless otherwise noted.

| PARAMETER | ADC32J42 | | | ADC32J43 | | | UNIT |
|--------------------------------------|----------|-----|-----|----------|-----|-----|------|
| | MIN | TYP | MAX | MIN | TYP | MAX | |
| ADC clock frequency | | | 50 | | | 80 | MSPS |
| Resolution | 14 | | | 14 | | | Bits |
| 1.8-V analog supply current | | 134 | 267 | | 152 | 272 | mA |
| 1.8-V digital supply current | | 22 | 45 | | 31 | 46 | mA |
| Total power dissipation | | 281 | 435 | | 329 | 450 | mW |
| Global power-down dissipation | | 5 | | | 5 | | mW |
| Wake-up time from global power-down | | 85 | | | 85 | | us |
| Standby power-down dissipation | | 99 | | | 105 | | mW |
| Wake-up time from standby power-down | | 35 | | | 35 | | μs |

7.8 AC Performance: ADC32J45

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, ADC sampling rate = 160 MSPS, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and -1-dBFS differential input, unless otherwise noted.

| PARAMETER | | TEST CONDITIONS | ADC32J45 ($f_S = 160$ MSPS) | | | | | | UNIT |
|-----------------------------------|--|---------------------------|------------------------------|-------|-----|------------|-----|-----|---------|
| | | | DITHER ON | | | DITHER OFF | | | |
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| DYNAMIC AC CHARACTERISTICS | | | | | | | | | |
| SNR | Signal-to-noise ratio | $f_{\text{IN}} = 10$ MHz | 72.5 | | | 72.8 | | | dBFS |
| | | $f_{\text{IN}} = 70$ MHz | 70.2 | 71.7 | | 72.0 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 71.3 | | | 71.6 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 70.1 | | | 70.7 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 68.9 | | | 69.5 | | | |
| NSD | Noise spectral density (averaged across Nyquist zone) | $f_{\text{IN}} = 10$ MHz | 151.5 | | | 151.8 | | | dBFS/Hz |
| | | $f_{\text{IN}} = 70$ MHz | -149.5 | 150.7 | | 151.0 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 150.3 | | | 150.6 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 149.1 | | | 149.7 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 147.9 | | | 148.5 | | | |
| SINAD | Signal-to-noise and distortion ratio | $f_{\text{IN}} = 10$ MHz | 72.3 | | | 72.6 | | | dBFS |
| | | $f_{\text{IN}} = 70$ MHz | 68.3 | 71.5 | | 71.8 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 71.0 | | | 71.2 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 69.6 | | | 70.1 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 68.3 | | | 68.4 | | | |
| ENOB | Effective number of bits | $f_{\text{IN}} = 10$ MHz | 11.7 | | | 11.8 | | | Bits |
| | | $f_{\text{IN}} = 70$ MHz | 11.1 | 11.6 | | 11.6 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 11.5 | | | 11.5 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 11.3 | | | 11.3 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 11.0 | | | 11.1 | | | |
| SFDR | Spurious-free dynamic range | $f_{\text{IN}} = 10$ MHz | 90 | | | 88 | | | dBc |
| | | $f_{\text{IN}} = 70$ MHz | 81 | 85 | | 85 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 85 | | | 84 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 84 | | | 83 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 81 | | | 80 | | | |
| HD2 | Second-order harmonic distortion | $f_{\text{IN}} = 10$ MHz | 90 | | | 91 | | | dBc |
| | | $f_{\text{IN}} = 70$ MHz | 81 | 91 | | 92 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 88 | | | 86 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 84 | | | 83 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 81 | | | 80 | | | |
| HD3 | Third-order harmonic distortion | $f_{\text{IN}} = 10$ MHz | 91 | | | 88 | | | dBc |
| | | $f_{\text{IN}} = 70$ MHz | 81 | 85 | | 84 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 85 | | | 84 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 91 | | | 86 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 86 | | | 87 | | | |
| Non HD2, HD3 | Spurious-free dynamic range (excluding HD2, HD3) | $f_{\text{IN}} = 10$ MHz | 98 | | | 95 | | | dBc |
| | | $f_{\text{IN}} = 70$ MHz | 87 | 99 | | 95 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 97 | | | 94 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 92 | | | 91 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 91 | | | 89 | | | |

AC Performance: ADC32J45 (continued)

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, ADC sampling rate = 160 MSPS, 50% clock duty cycle, $AV_{\text{DD}} = DV_{\text{DD}} = 1.8\text{ V}$, and -1-dBFS differential input, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | ADC32J45 ($f_s = 160\text{ MSPS}$) | | | | | | UNIT | |
|-----------|--|--|-----------|-----|------------|-----------|-----|------|------|
| | | DITHER ON | | | DITHER OFF | | | | |
| | | MIN | TYP | MAX | MIN | TYP | MAX | | |
| THD | Total harmonic distortion | $f_{\text{IN}} = 10\text{ MHz}$ | 87 | | | 84 | | | dBc |
| | | $f_{\text{IN}} = 70\text{ MHz}$ | 78 | 84 | | 83 | | | |
| | | $f_{\text{IN}} = 100\text{ MHz}$ | 83 | | | 82 | | | |
| | | $f_{\text{IN}} = 170\text{ MHz}$ | 82 | | | 80 | | | |
| | | $f_{\text{IN}} = 230\text{ MHz}$ | 79 | | | 77 | | | |
| IMD3 | Two-tone, third-order intermodulation distortion | $f_{\text{IN1}} = 45\text{ MHz}$, $f_{\text{IN2}} = 50\text{ MHz}$ | 90 | | | 90 | | | dBFS |
| | | $f_{\text{IN1}} = 185\text{ MHz}$, $f_{\text{IN2}} = 190\text{ MHz}$ | 86 | | | 86 | | | |
| DNL | Differential nonlinearity | $f_{\text{IN}} = 70\text{ MHz}$ | ± 0.3 | | | ± 0.3 | | | LSBs |
| INL | Integrated nonlinearity | $f_{\text{IN}} = 70\text{ MHz}$ | ± 1.5 | | | ± 1.5 | | | LSBs |

7.9 AC Performance: ADC32J44

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and -1-dBFS differential input, unless otherwise noted.

| PARAMETER | | TEST CONDITIONS | ADC32J44 ($f_S = 125 \text{ MSPS}$) | | | | | | UNIT |
|-----------------------------------|--|-----------------------------------|---------------------------------------|-------|-----|------------|-----|-----|---------|
| | | | DITHER ON | | | DITHER OFF | | | |
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| DYNAMIC AC CHARACTERISTICS | | | | | | | | | |
| SNR | Signal-to-noise ratio | $f_{\text{IN}} = 10 \text{ MHz}$ | 72.6 | | | 72.8 | | | dBFS |
| | | $f_{\text{IN}} = 70 \text{ MHz}$ | 70.8 | 72.3 | | 72.5 | | | |
| | | $f_{\text{IN}} = 100 \text{ MHz}$ | 72.1 | | | 72.3 | | | |
| | | $f_{\text{IN}} = 170 \text{ MHz}$ | 70.1 | | | 71.7 | | | |
| | | $f_{\text{IN}} = 230 \text{ MHz}$ | 70.0 | | | 70.8 | | | |
| NSD | Noise spectral density (averaged across Nyquist zone) | $f_{\text{IN}} = 10 \text{ MHz}$ | 150.6 | | | 150.8 | | | dBFS/Hz |
| | | $f_{\text{IN}} = 70 \text{ MHz}$ | -148.8 | 150.3 | | 150.5 | | | |
| | | $f_{\text{IN}} = 100 \text{ MHz}$ | 150.1 | | | 150.3 | | | |
| | | $f_{\text{IN}} = 170 \text{ MHz}$ | 148.1 | | | 149.7 | | | |
| | | $f_{\text{IN}} = 230 \text{ MHz}$ | 148.0 | | | 148.8 | | | |
| SINAD | Signal-to-noise and distortion ratio | $f_{\text{IN}} = 10 \text{ MHz}$ | 72.5 | | | 72.7 | | | dBFS |
| | | $f_{\text{IN}} = 70 \text{ MHz}$ | 68.6 | 72.2 | | 72.4 | | | |
| | | $f_{\text{IN}} = 100 \text{ MHz}$ | 72.0 | | | 72.2 | | | |
| | | $f_{\text{IN}} = 170 \text{ MHz}$ | 70.7 | | | 71.4 | | | |
| | | $f_{\text{IN}} = 230 \text{ MHz}$ | 69.5 | | | 70.2 | | | |
| ENOB | Effective number of bits | $f_{\text{IN}} = 10 \text{ MHz}$ | 11.8 | | | 11.8 | | | Bits |
| | | $f_{\text{IN}} = 70 \text{ MHz}$ | 11.1 | 11.7 | | 11.7 | | | |
| | | $f_{\text{IN}} = 100 \text{ MHz}$ | 11.7 | | | 11.7 | | | |
| | | $f_{\text{IN}} = 170 \text{ MHz}$ | 11.4 | | | 11.6 | | | |
| | | $f_{\text{IN}} = 230 \text{ MHz}$ | 11.2 | | | 11.4 | | | |
| SFDR | Spurious-free dynamic range | $f_{\text{IN}} = 10 \text{ MHz}$ | 94 | | | 92 | | | dBc |
| | | $f_{\text{IN}} = 70 \text{ MHz}$ | 81 | 93 | | 91 | | | |
| | | $f_{\text{IN}} = 100 \text{ MHz}$ | 93 | | | 90 | | | |
| | | $f_{\text{IN}} = 170 \text{ MHz}$ | 85 | | | 84 | | | |
| | | $f_{\text{IN}} = 230 \text{ MHz}$ | 82 | | | 81 | | | |
| HD2 | Second-order harmonic distortion | $f_{\text{IN}} = 10 \text{ MHz}$ | 95 | | | 92 | | | dBc |
| | | $f_{\text{IN}} = 70 \text{ MHz}$ | 81 | 94 | | 94 | | | |
| | | $f_{\text{IN}} = 100 \text{ MHz}$ | 93 | | | 91 | | | |
| | | $f_{\text{IN}} = 170 \text{ MHz}$ | 85 | | | 84 | | | |
| | | $f_{\text{IN}} = 230 \text{ MHz}$ | 82 | | | 81 | | | |
| HD3 | Third-order harmonic distortion | $f_{\text{IN}} = 10 \text{ MHz}$ | 96 | | | 92 | | | dBc |
| | | $f_{\text{IN}} = 70 \text{ MHz}$ | 82 | 93 | | 90 | | | |
| | | $f_{\text{IN}} = 100 \text{ MHz}$ | 93 | | | 90 | | | |
| | | $f_{\text{IN}} = 170 \text{ MHz}$ | 88 | | | 88 | | | |
| | | $f_{\text{IN}} = 230 \text{ MHz}$ | 91 | | | 93 | | | |
| Non HD2, HD3 | Spurious-free dynamic range (excluding HD2, HD3) | $f_{\text{IN}} = 10 \text{ MHz}$ | 99 | | | 96 | | | dBc |
| | | $f_{\text{IN}} = 70 \text{ MHz}$ | 87 | 99 | | 96 | | | |
| | | $f_{\text{IN}} = 100 \text{ MHz}$ | 98 | | | 96 | | | |
| | | $f_{\text{IN}} = 170 \text{ MHz}$ | 98 | | | 95 | | | |
| | | $f_{\text{IN}} = 230 \text{ MHz}$ | 96 | | | 91 | | | |

AC Performance: ADC32J44 (continued)

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, and -1-dBFS differential input, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | ADC32J44 ($f_s = 125\text{ MSPS}$) | | | | | | UNIT | |
|-----------|--|--|-----------|-----|------------|-----------|-----|------|------|
| | | DITHER ON | | | DITHER OFF | | | | |
| | | MIN | TYP | MAX | MIN | TYP | MAX | | |
| THD | Total harmonic distortion | $f_{\text{IN}} = 10\text{ MHz}$ | 91 | | | 87 | | | dBc |
| | | $f_{\text{IN}} = 70\text{ MHz}$ | 78 | 90 | | 87 | | | |
| | | $f_{\text{IN}} = 100\text{ MHz}$ | 90 | | | 87 | | | |
| | | $f_{\text{IN}} = 170\text{ MHz}$ | 83 | | | 82 | | | |
| | | $f_{\text{IN}} = 230\text{ MHz}$ | 80 | | | 79 | | | |
| IMD3 | Two-tone, third-order intermodulation distortion | $f_{\text{IN1}} = 45\text{ MHz}$, $f_{\text{IN2}} = 50\text{ MHz}$ | 91 | | | 91 | | | dBFS |
| | | $f_{\text{IN1}} = 185\text{ MHz}$, $f_{\text{IN2}} = 190\text{ MHz}$ | 86 | | | 86 | | | |
| DNL | Differential nonlinearity | $f_{\text{IN}} = 70\text{ MHz}$ | ± 0.3 | | | ± 0.3 | | | LSBs |
| INL | Integrated nonlinearity | $f_{\text{IN}} = 70\text{ MHz}$ | ± 1.5 | | | ± 1.5 | | | LSBs |

7.10 AC Performance: ADC32J43

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input, unless otherwise noted.

| PARAMETER | | TEST CONDITIONS | ADC32J43 ($f_S = 80$ MSPS) | | | | | | UNIT |
|-----------------------------------|--|---------------------------|-----------------------------|-------|-----|------------|-----|-----|---------|
| | | | DITHER ON | | | DITHER OFF | | | |
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| DYNAMIC AC CHARACTERISTICS | | | | | | | | | |
| SNR | Signal-to-noise ratio | $f_{\text{IN}} = 10$ MHz | 72.3 | | | 72.6 | | | dBFS |
| | | $f_{\text{IN}} = 70$ MHz | 70.8 | 72.2 | | 72.4 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 72.0 | | | 72.2 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 71.4 | | | 71.8 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 70.6 | | | 71.0 | | | |
| NSD | Noise spectral density (averaged across Nyquist zone) | $f_{\text{IN}} = 10$ MHz | 148.4 | | | 148.7 | | | dBFS/Hz |
| | | $f_{\text{IN}} = 70$ MHz | –146.8 | 148.2 | | 148.4 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 148.0 | | | 148.2 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 147.4 | | | 147.8 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 146.6 | | | 147.0 | | | |
| SINAD | Signal-to-noise and distortion ratio | $f_{\text{IN}} = 10$ MHz | 72.3 | | | 72.5 | | | dBFS |
| | | $f_{\text{IN}} = 70$ MHz | 68.6 | 72.2 | | 72.2 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 71.9 | | | 72.0 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 71.0 | | | 71.4 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 69.9 | | | 70.2 | | | |
| ENOB | Effective number of bits | $f_{\text{IN}} = 10$ MHz | 11.7 | | | 11.8 | | | Bits |
| | | $f_{\text{IN}} = 70$ MHz | 11.1 | 11.7 | | 11.7 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 11.6 | | | 11.7 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 11.5 | | | 11.6 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 11.3 | | | 11.4 | | | |
| SFDR | Spurious-free dynamic range | $f_{\text{IN}} = 10$ MHz | 96 | | | 91 | | | dBc |
| | | $f_{\text{IN}} = 70$ MHz | 82 | 95 | | 90 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 91 | | | 88 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 85 | | | 84 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 81 | | | 80 | | | |
| HD2 | Second-order harmonic distortion | $f_{\text{IN}} = 10$ MHz | 96 | | | 95 | | | dBc |
| | | $f_{\text{IN}} = 70$ MHz | 81 | 98 | | 96 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 93 | | | 91 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 85 | | | 84 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 81 | | | 80 | | | |
| HD3 | Third-order harmonic distortion | $f_{\text{IN}} = 10$ MHz | 95 | | | 93 | | | dBc |
| | | $f_{\text{IN}} = 70$ MHz | 83 | 92 | | 92 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 91 | | | 88 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 92 | | | 91 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 83 | | | 83 | | | |
| Non HD2, HD3 | Spurious-free dynamic range (excluding HD2, HD3) | $f_{\text{IN}} = 10$ MHz | 99 | | | 93 | | | dBc |
| | | $f_{\text{IN}} = 70$ MHz | 87 | 99 | | 93 | | | |
| | | $f_{\text{IN}} = 100$ MHz | 97 | | | 92 | | | |
| | | $f_{\text{IN}} = 170$ MHz | 97 | | | 93 | | | |
| | | $f_{\text{IN}} = 230$ MHz | 95 | | | 92 | | | |

AC Performance: ADC32J43 (continued)

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $\text{AVDD} = \text{DVDD} = 1.8\text{ V}$, and -1-dBFS differential input, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | ADC32J43 ($f_s = 80\text{ MSPS}$) | | | | | | UNIT | |
|-----------|--|--|-----------|-----|------------|-----------|-----|------|------|
| | | DITHER ON | | | DITHER OFF | | | | |
| | | MIN | TYP | MAX | MIN | TYP | MAX | | |
| THD | Total harmonic distortion | $f_{\text{IN}} = 10\text{ MHz}$ | 93 | | | 87 | | | dBc |
| | | $f_{\text{IN}} = 70\text{ MHz}$ | 78 | 93 | | 87 | | | |
| | | $f_{\text{IN}} = 100\text{ MHz}$ | 87 | | | 85 | | | |
| | | $f_{\text{IN}} = 170\text{ MHz}$ | 83 | | | 82 | | | |
| | | $f_{\text{IN}} = 230\text{ MHz}$ | 79 | | | 77 | | | |
| IMD3 | Two-tone, third-order intermodulation distortion | $f_{\text{IN1}} = 45\text{ MHz}$, $f_{\text{IN2}} = 50\text{ MHz}$ | 90 | | | 90 | | | dBFS |
| | | $f_{\text{IN1}} = 185\text{ MHz}$, $f_{\text{IN2}} = 190\text{ MHz}$ | 89 | | | 89 | | | |
| DNL | Differential nonlinearity | $f_{\text{IN}} = 70\text{ MHz}$ | ± 0.3 | | | ± 0.3 | | | LSBs |
| INL | Integrated nonlinearity | $f_{\text{IN}} = 70\text{ MHz}$ | ± 1.5 | | | ± 1.5 | | | LSBs |

7.11 AC Performance: ADC32J42

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, AVDD = DVDD = 1.8 V, and –1-dBFS differential input, unless otherwise noted.

| PARAMETER | | TEST CONDITIONS | ADC32J42 ($f_S = 50$ MSPS) | | | | | | UNIT |
|-----------------------------------|--|---------------------------|-----------------------------|-------|-----|------------|-----|---------|------|
| | | | DITHER ON | | | DITHER OFF | | | |
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| DYNAMIC AC CHARACTERISTICS | | | | | | | | | |
| SNR | Signal-to-noise ratio | $f_{\text{IN}} = 10$ MHz | 71.3 | 72.2 | | 72.5 | | dBFS | |
| | | $f_{\text{IN}} = 70$ MHz | | 71.8 | | 72.1 | | | |
| | | $f_{\text{IN}} = 100$ MHz | | 71.8 | | 72.0 | | | |
| | | $f_{\text{IN}} = 170$ MHz | | 71.1 | | 71.5 | | | |
| | | $f_{\text{IN}} = 230$ MHz | | 69.1 | | 69.4 | | | |
| NSD | Noise spectral density (averaged across Nyquist zone) | $f_{\text{IN}} = 10$ MHz | | 146.1 | | 146.5 | | dBFS/Hz | |
| | | $f_{\text{IN}} = 70$ MHz | | 145.8 | | 146.1 | | | |
| | | $f_{\text{IN}} = 100$ MHz | | 145.8 | | 146.0 | | | |
| | | $f_{\text{IN}} = 170$ MHz | | 145.1 | | 145.5 | | | |
| | | $f_{\text{IN}} = 230$ MHz | | 143.1 | | 143.4 | | | |
| SINAD | Signal-to-noise and distortion ratio | $f_{\text{IN}} = 10$ MHz | 69.1 | 72.1 | | 72.3 | | dBFS | |
| | | $f_{\text{IN}} = 70$ MHz | | 71.8 | | 71.9 | | | |
| | | $f_{\text{IN}} = 100$ MHz | | 71.7 | | 71.8 | | | |
| | | $f_{\text{IN}} = 170$ MHz | | 70.8 | | 71.1 | | | |
| | | $f_{\text{IN}} = 230$ MHz | | 68.4 | | 68.7 | | | |
| ENOB | Effective number of bits | $f_{\text{IN}} = 10$ MHz | 11.2 | 11.7 | | 11.7 | | Bits | |
| | | $f_{\text{IN}} = 70$ MHz | | 11.6 | | 11.7 | | | |
| | | $f_{\text{IN}} = 100$ MHz | | 11.6 | | 11.6 | | | |
| | | $f_{\text{IN}} = 170$ MHz | | 11.5 | | 11.5 | | | |
| | | $f_{\text{IN}} = 230$ MHz | | 11.1 | | 11.1 | | | |
| SFDR | Spurious-free dynamic range | $f_{\text{IN}} = 10$ MHz | 84.5 | 95 | | 93 | | dBc | |
| | | $f_{\text{IN}} = 70$ MHz | | 95 | | 90 | | | |
| | | $f_{\text{IN}} = 100$ MHz | | 91 | | 89 | | | |
| | | $f_{\text{IN}} = 170$ MHz | | 85 | | 84 | | | |
| | | $f_{\text{IN}} = 230$ MHz | | 81 | | 80 | | | |
| HD2 | Second-order harmonic distortion | $f_{\text{IN}} = 10$ MHz | 84.5 | 95 | | 94 | | dBc | |
| | | $f_{\text{IN}} = 70$ MHz | | 97 | | 96 | | | |
| | | $f_{\text{IN}} = 100$ MHz | | 92 | | 92 | | | |
| | | $f_{\text{IN}} = 170$ MHz | | 85 | | 84 | | | |
| | | $f_{\text{IN}} = 230$ MHz | | 81 | | 80 | | | |
| HD3 | Third-order harmonic distortion | $f_{\text{IN}} = 10$ MHz | 84.5 | 102 | | 93 | | dBc | |
| | | $f_{\text{IN}} = 70$ MHz | | 95 | | 90 | | | |
| | | $f_{\text{IN}} = 100$ MHz | | 91 | | 89 | | | |
| | | $f_{\text{IN}} = 170$ MHz | | 88 | | 88 | | | |
| | | $f_{\text{IN}} = 230$ MHz | | 82 | | 83 | | | |
| Non HD2, HD3 | Spurious-free dynamic range (excluding HD2, HD3) | $f_{\text{IN}} = 10$ MHz | 87 | 98 | | 91 | | dBc | |
| | | $f_{\text{IN}} = 70$ MHz | | 94 | | 92 | | | |
| | | $f_{\text{IN}} = 100$ MHz | | 91 | | 91 | | | |
| | | $f_{\text{IN}} = 170$ MHz | | 96 | | 92 | | | |
| | | $f_{\text{IN}} = 230$ MHz | | 93 | | 91 | | | |

AC Performance: ADC32J42 (continued)

Typical values are over the operating free-air temperature range, at $T_A = 25^\circ\text{C}$, full temperature range is $T_{\text{MIN}} = -40^\circ\text{C}$ to $T_{\text{MAX}} = 85^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $\text{AVDD} = \text{DVDD} = 1.8\text{ V}$, and -1-dBFS differential input, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | ADC32J42 ($f_s = 50\text{ MSPS}$) | | | | | | UNIT |
|--|---|-------------------------------------|-----------|-----|------------|-----------|-----|------|
| | | DITHER ON | | | DITHER OFF | | | |
| | | MIN | TYP | MAX | MIN | TYP | MAX | |
| THD Total harmonic distortion | $f_{\text{IN}} = 10\text{ MHz}$ | 79.5 | 92 | | | 90 | | dBc |
| | $f_{\text{IN}} = 70\text{ MHz}$ | | 91 | | | 87 | | |
| | $f_{\text{IN}} = 100\text{ MHz}$ | | 88 | | | 85 | | |
| | $f_{\text{IN}} = 170\text{ MHz}$ | | 83 | | | 82 | | |
| | $f_{\text{IN}} = 230\text{ MHz}$ | | 78 | | | 78 | | |
| IMD3 Two-tone, third-order intermodulation distortion | $f_{\text{IN1}} = 45\text{ MHz},$ $f_{\text{IN2}} = 50\text{ MHz}$ | | 90 | | | 90 | | dBFS |
| | $f_{\text{IN1}} = 185\text{ MHz},$ $f_{\text{IN2}} = 190\text{ MHz}$ | | 86 | | | 86 | | |
| DNL Differential nonlinearity | $f_{\text{IN}} = 70\text{ MHz}$ | | ± 0.3 | | | ± 0.3 | | LSBs |
| INL Integrated nonlinearity | $f_{\text{IN}} = 70\text{ MHz}$ | | ± 1.5 | | | ± 1.5 | | LSBs |

7.12 Digital Characteristics

The dc specifications refer to the condition where the digital outputs are not switching, but are permanently at a valid logic level 0 or 1. AVDD = DVDD = 1.8 V and –1-dBFS differential input, unless otherwise noted.

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|--|------------|------------|-----|------|
| DIGITAL INPUTS (RESET, SCLK, SEN, SDATA, PDN)⁽¹⁾ | | | | | | |
| V _{IH} | High-level input voltage | All digital inputs support 1.8-V and 3.3-V logic levels | 1.2 | | | V |
| V _{IL} | Low-level input voltage | All digital inputs support 1.8-V and 3.3-V logic levels | | | 0.4 | V |
| I _{IH} | High-level input current | SEN | | 0 | | μA |
| | | RESET, SCLK, SDATA, PDN | | 10 | | μA |
| I _{IL} | Low-level input current | SEN | | 10 | | μA |
| | | RESET, SCLK, SDATA, PDN | | 0 | | μA |
| DIGITAL INPUTS (SYNCP~, SYNCM~, SYSREFP, SYSREFM) | | | | | | |
| V _{IH} | High-level input voltage | | | 1.3 | | V |
| V _{IL} | Low-level input voltage | | | 0.5 | | V |
| V _(CM,DIG) | Common-mode voltage for SYNCP~ and SYSREF | | | 0.95 | | V |
| DIGITAL OUTPUTS (SDOUT, OVRA, OVRB) | | | | | | |
| V _{OH} | High-level output voltage | | DVDD – 0.1 | DVDD | | V |
| V _{OL} | Low-level output voltage | | | | 0.1 | V |
| DIGITAL OUTPUTS (JESD204B Interface: DxP, DxM)⁽²⁾ | | | | | | |
| V _{OH} | High-level output voltage | | | AVDD | | V |
| V _{OL} | Low-level output voltage | | | AVDD – 0.4 | | V |
| V _{OD} | Output differential voltage | | | 0.4 | | V |
| V _{OC} | Output common-mode voltage | | | AVDD – 0.2 | | V |
| | Transmitter short-circuit current | Transmitter pins shorted to any voltage between –0.25 V and 1.45 V | –100 | | 100 | mA |
| Z _{os} | Single-ended output impedance | | | 50 | | Ω |
| | Output capacitance | Output capacitance inside the device, from either output to ground | | 2 | | pF |

(1) The RESET, SCLK, SDATA, and PDN pins have a 150-kΩ (typical) internal pulldown resistor to ground, and the SEN pin has a 150-kΩ (typical) pullup resistor to AVDD.

(2) 50-Ω, single-ended external termination to 1.8 V.

7.13 Timing Requirements

Typical values are at 25°C, AVDD = DVDD = 1.8 V, and –1-dBFS differential input, unless otherwise noted. Minimum and maximum values are across the full temperature range: T_{MIN} = –40°C to T_{MAX} = 85°C. See [Figure 143](#).

| | | MIN | TYP | MAX | UNITS |
|---|--|------|------|------|--------------------|
| SAMPLE TIMING REQUIREMENTS | | | | | |
| Aperture delay | | 0.85 | 1.25 | 1.65 | ns |
| Aperture delay matching | Between four channels on the same device | | | | ps |
| | Between two devices at the same temperature and supply voltage | | | | ps |
| Aperture jitter | | | | | f _S rms |
| Wake-up time | Time to valid data after coming out of STANDBY mode | | | | μs |
| | Time to valid data after coming out of global power-down | | | | μs |
| t _{SU_SYNC-} | Setup time for SYNC- referenced to input clock rising edge | | | | ns |
| t _{H_SYNC-} | Hold time for SYNC- referenced to input clock rising edge | | | | ps |
| t _{SU_SYSREF} | Setup time for SYSREF referenced to input clock rising edge | | | | ns |
| t _{H_SYSREF} | Hold time for SYSREF referenced to input clock rising edge | | | | ps |
| CML OUTPUT TIMING REQUIREMENTS | | | | | |
| Unit interval | | | | | ps |
| Serial output data rate | | | | | Gbps |
| Total jitter: 3.125 Gbps (20X mode, f _S = 156.25 MSPS) | | | | | p-pUI |
| t _R , t _F | Data rise time, data fall time: rise and fall times measured from 20% to 80%, differential output waveform, 600 Mbps ≤ bit rate ≤ 3.125 Gbps | | | | ps |

Table 1. Latency in Different Modes⁽¹⁾⁽²⁾

| MODE | PARAMETER | LATENCY (N Cycles) | TYPICAL DATA DELAY (t _D , ns) |
|------|---|--------------------|--|
| 20X | ADC latency | 17 | 0.29 × t _S + 3 |
| | Normal OVR latency | 9 | 0.5 × t _S + 2 |
| | Fast OVR latency | 7 | 0.5 × t _S + 2 |
| | From SYNC- falling edge to CGS phase ⁽³⁾ | 15 | 0.3 × t _S + 4 |
| | From SYNC- rising edge to ILA sequence ⁽⁴⁾ | 17 | 0.3 × t _S + 4 |
| 40X | ADC latency | 16 | 0.85 × t _S + 3.9 |
| | Normal OVR latency | 9 | 0.5 × t _S + 2 |
| | Fast OVR latency | 7 | 0.5 × t _S + 2 |
| | From SYNC- falling edge to CGS phase ⁽³⁾ | 14 | 0.9 × t _S + 4 |
| | From SYNC- rising edge to ILA sequence ⁽⁴⁾ | 12 | 0.9 × t _S + 4 |

- (1) Overall latency = latency + t_D.
- (2) t_S is the time period of the ADC conversion clock.
- (3) Latency is specified for subclass 2. In subclass 0, the SYNC- falling edge to CGS phase latency is 16 clock cycles in 10X mode and 15 clock cycles in 20X mode.
- (4) Latency is specified for subclass 2. In subclass 0, the SYNC- rising edge to ILA sequence latency is 11 clock cycles in 10X mode and 11 clock cycles in 20X mode.

7.14 Typical Characteristics: ADC32J45

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 160 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, dither enabled, and special modes written, unless otherwise noted.

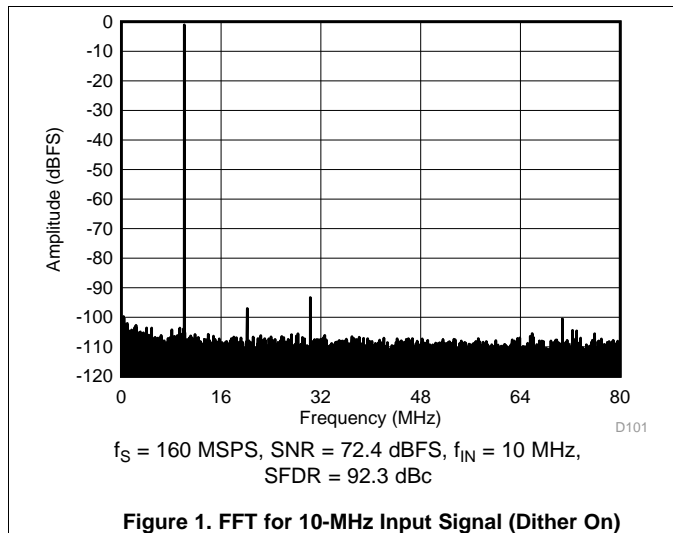


Figure 1. FFT for 10-MHz Input Signal (Dither On)

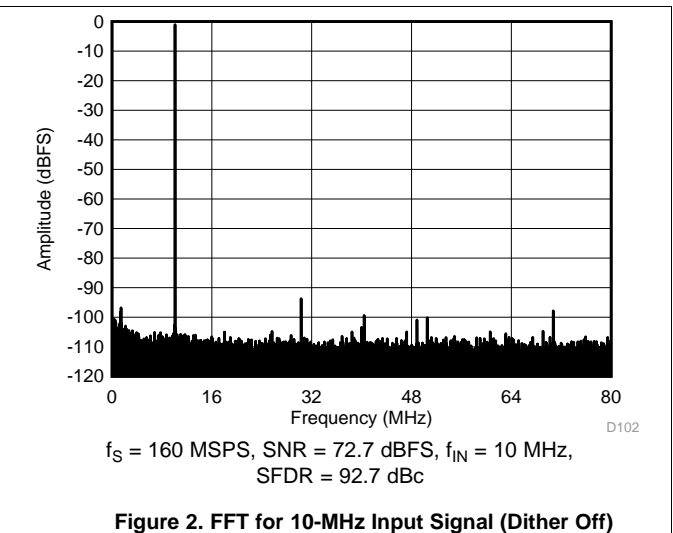


Figure 2. FFT for 10-MHz Input Signal (Dither Off)

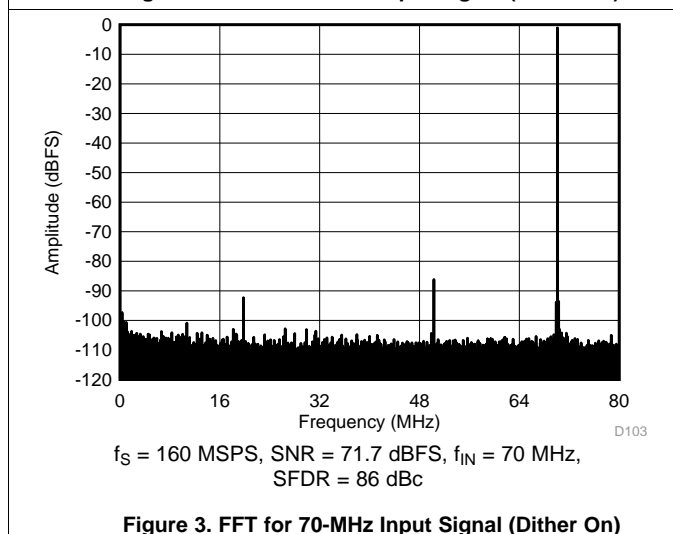


Figure 3. FFT for 70-MHz Input Signal (Dither On)

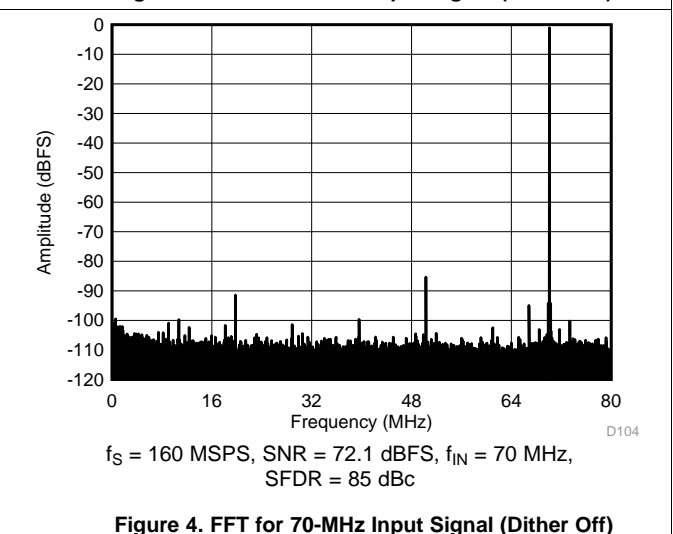


Figure 4. FFT for 70-MHz Input Signal (Dither Off)

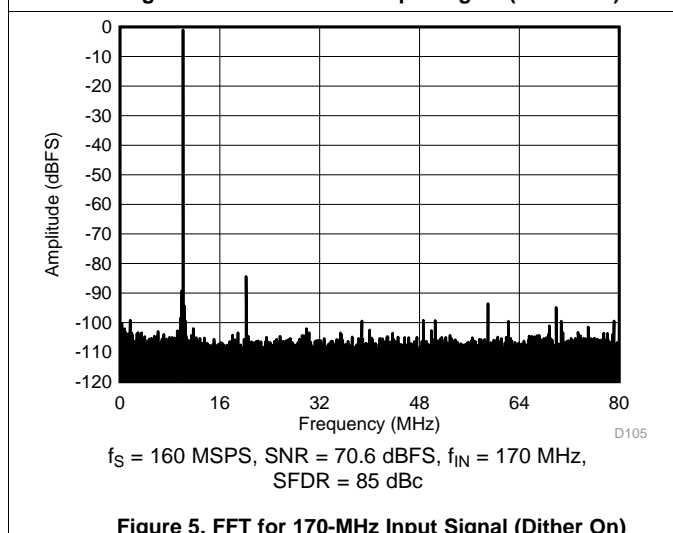


Figure 5. FFT for 170-MHz Input Signal (Dither On)

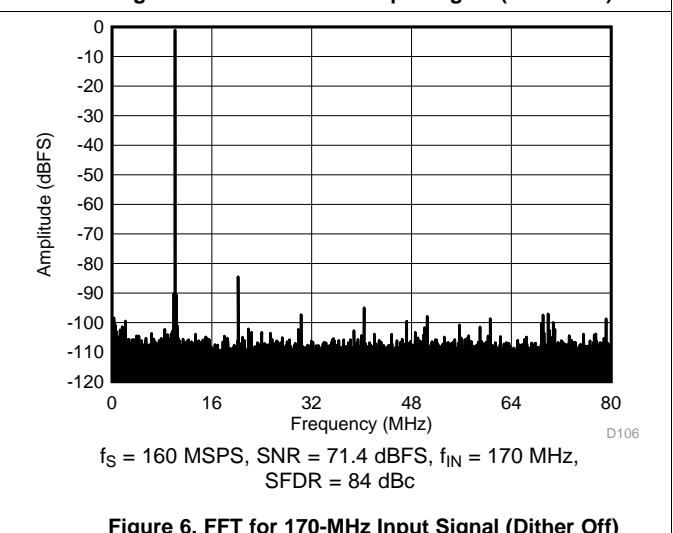


Figure 6. FFT for 170-MHz Input Signal (Dither Off)

Typical Characteristics: ADC32J45 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 160 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, dither enabled, and special modes written, unless otherwise noted.

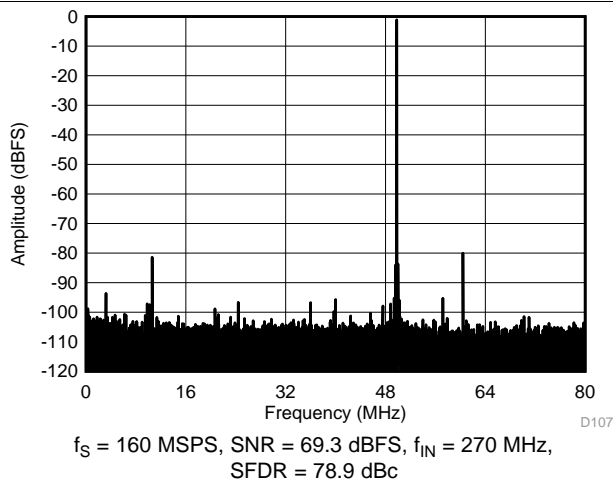


Figure 7. FFT for 270-MHz Input Signal (Dither On)

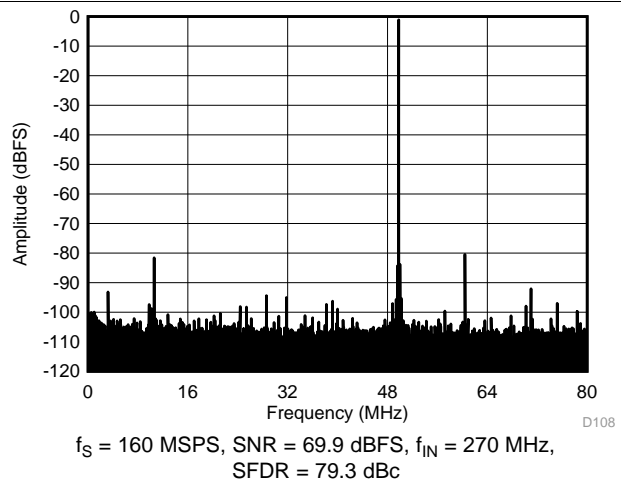


Figure 8. FFT for 270-MHz Input Signal (Dither Off)

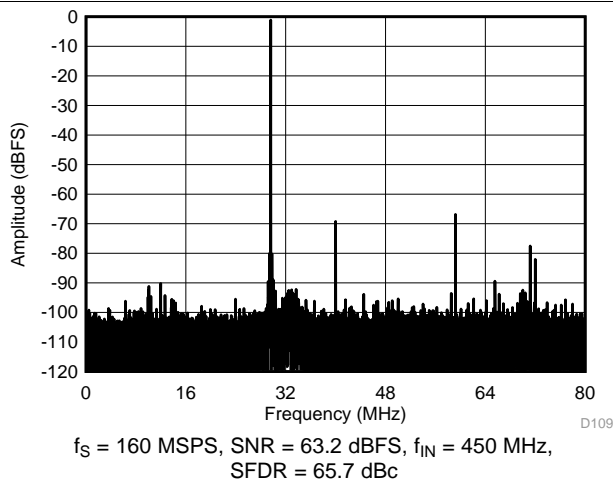


Figure 9. FFT for 450-MHz Input Signal (Dither On)

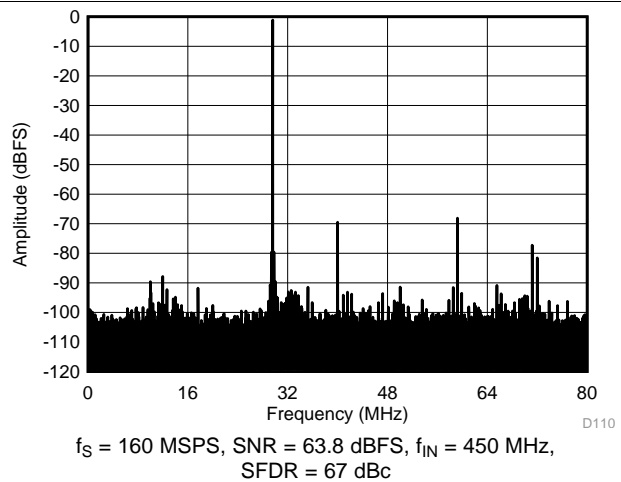
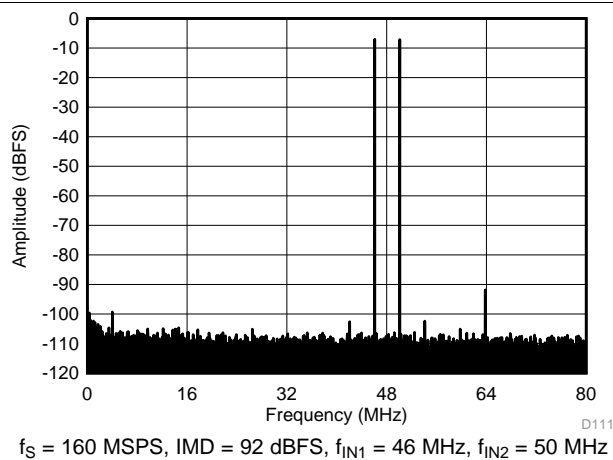
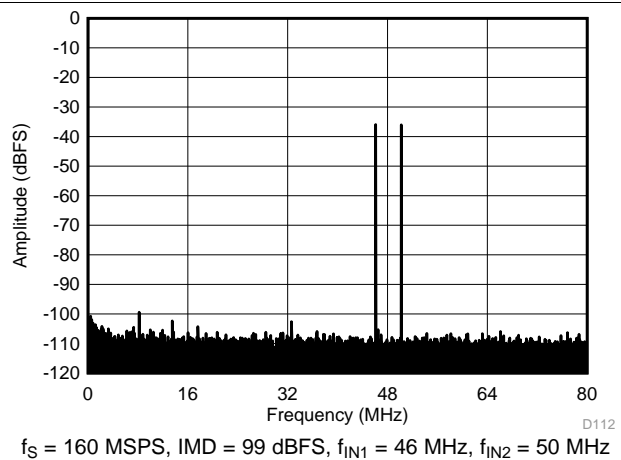


Figure 10. FFT for 450-MHz Input Signal (Dither Off)



**Figure 11. FFT for Two-Tone Input Signal
(-7 dBFS at 46 MHz and 50 MHz)**



**Figure 12. FFT for Two-Tone Input Signal
(-36 dBFS at 46 MHz and 50 MHz)**

Typical Characteristics: ADC32J45 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 160 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, dither enabled, and special modes written, unless otherwise noted.

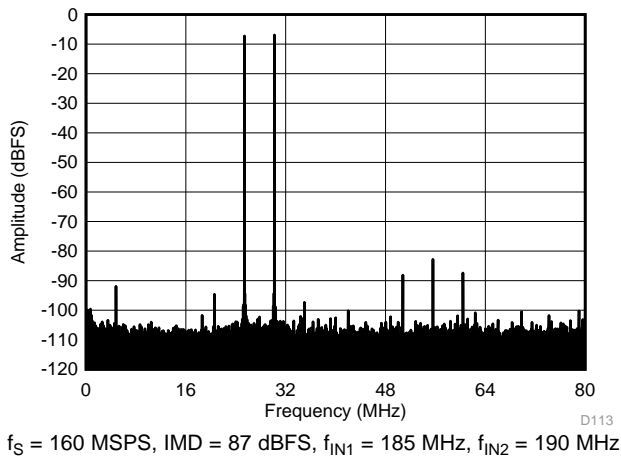


Figure 13. FFT for Two-Tone Input Signal (-7 dBFS at 185 MHz and 190 MHz)

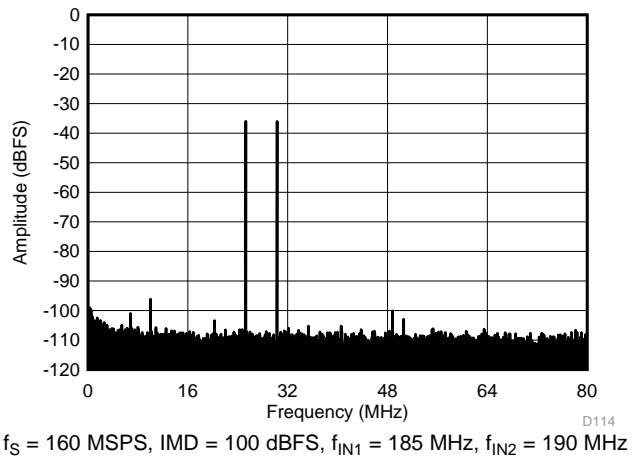


Figure 14. FFT for Two-Tone Input Signal (-36 dBFS at 185 MHz and 190 MHz)

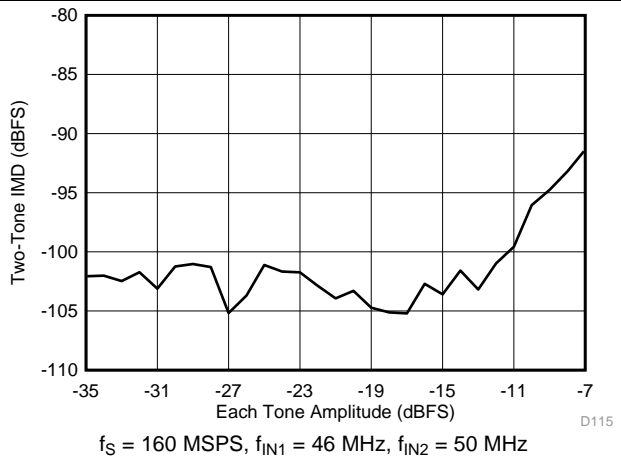


Figure 15. Intermodulation Distortion vs Input Amplitude (46 MHz and 50 MHz)

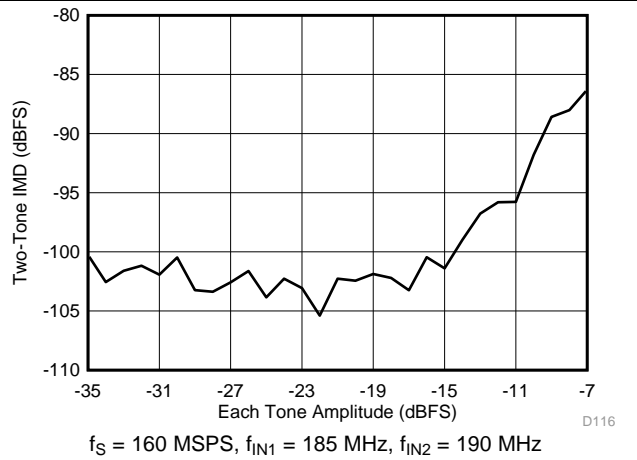


Figure 16. Intermodulation Distortion vs Input Amplitude (185 MHz and 190 MHz)

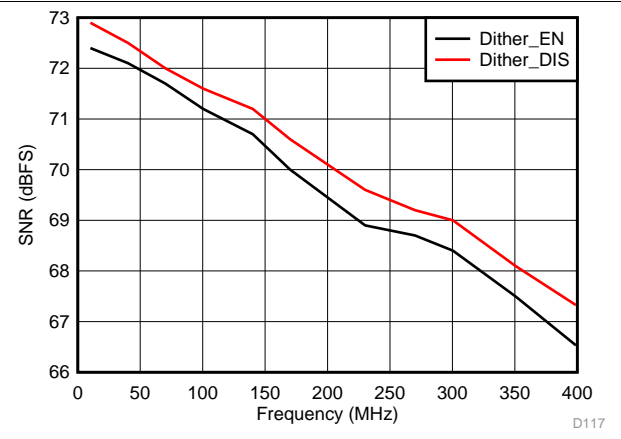


Figure 17. Signal-to-Noise Ratio vs Input Frequency

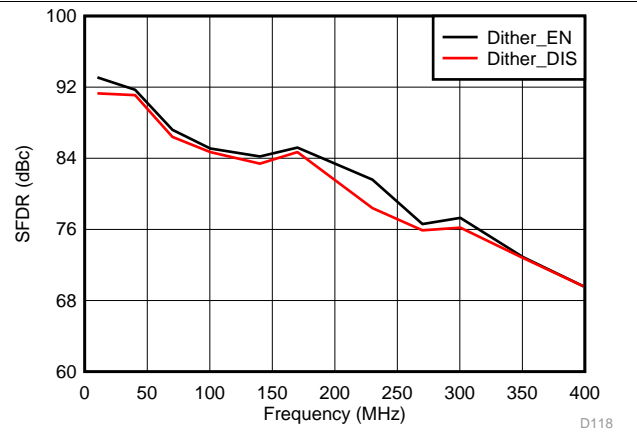


Figure 18. Spurious-Free Dynamic Range vs Input Frequency

Typical Characteristics: ADC32J45 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 160 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, dither enabled, and special modes written, unless otherwise noted.

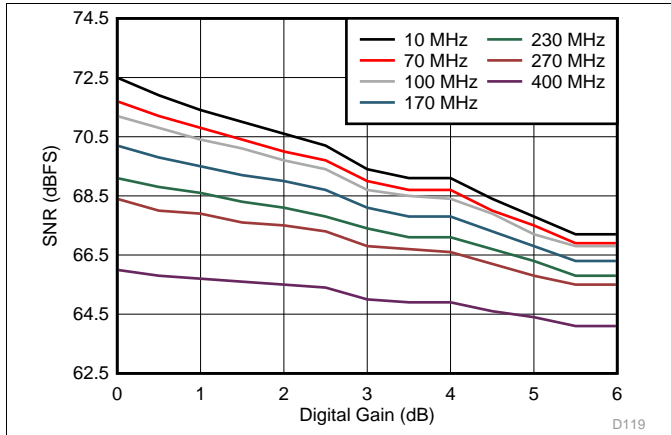


Figure 19. Signal-to-Noise Ratio vs Digital Gain and Input Frequency

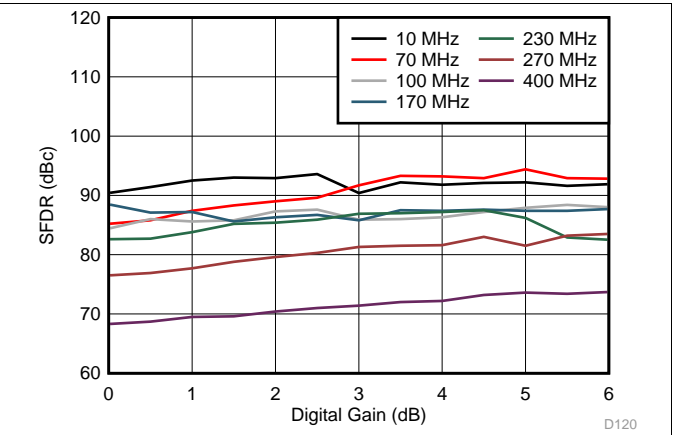


Figure 20. Spurious-Free Dynamic Range vs Digital Gain and Input Frequency

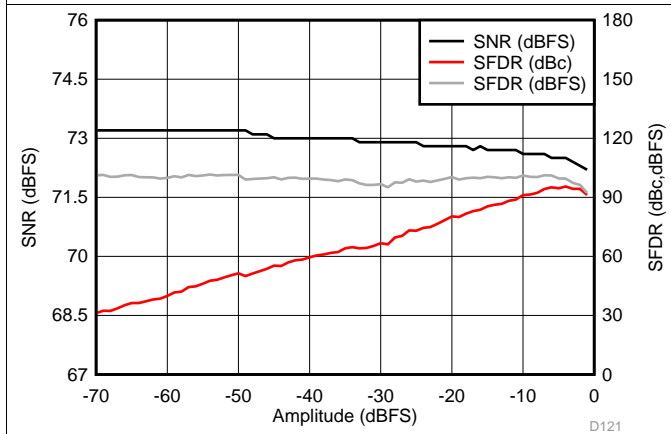


Figure 21. Performance vs Input Amplitude (30 MHz)

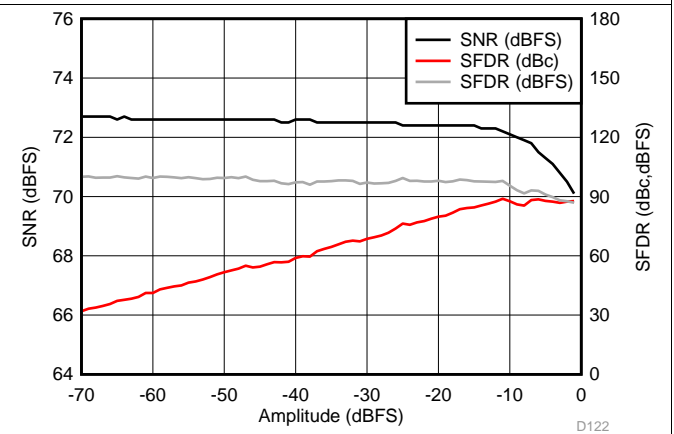


Figure 22. Performance vs Input Amplitude (170 MHz)

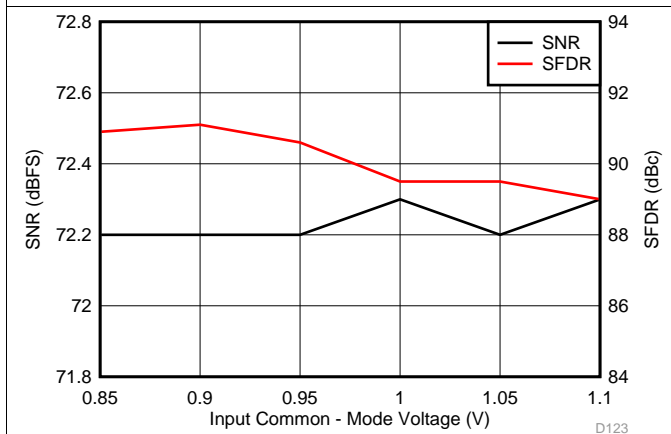


Figure 23. Performance vs Input Common-Mode Voltage (30 MHz)

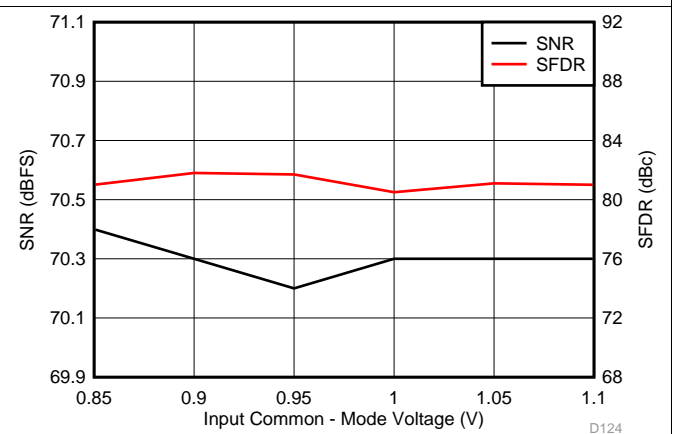


Figure 24. Performance vs Input Common-Mode Voltage (170 MHz)

Typical Characteristics: ADC32J45 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 160 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, dither enabled, and special modes written, unless otherwise noted.

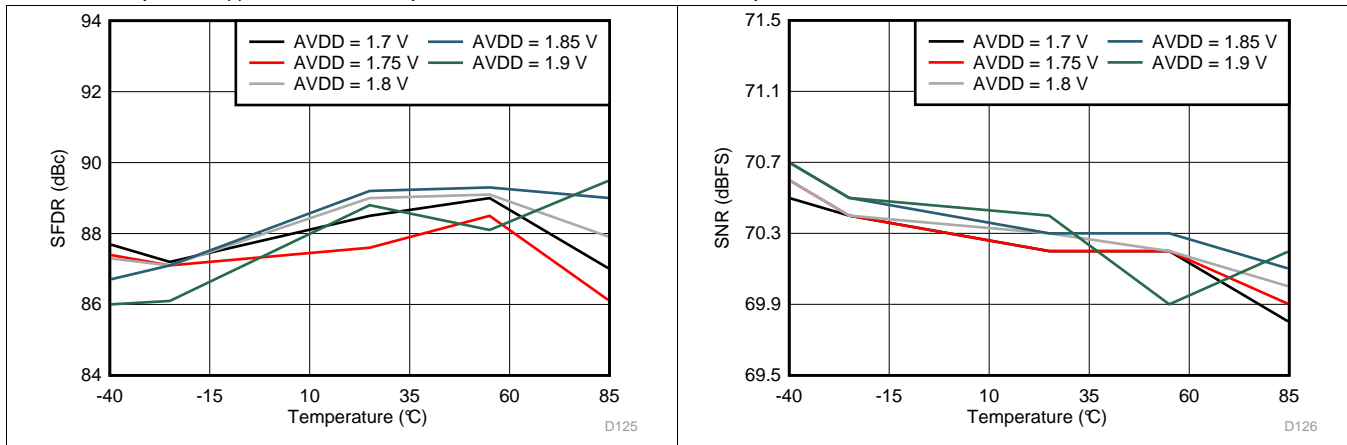


Figure 25. Spurious-Free Dynamic Range vs AVDD Supply and Temperature

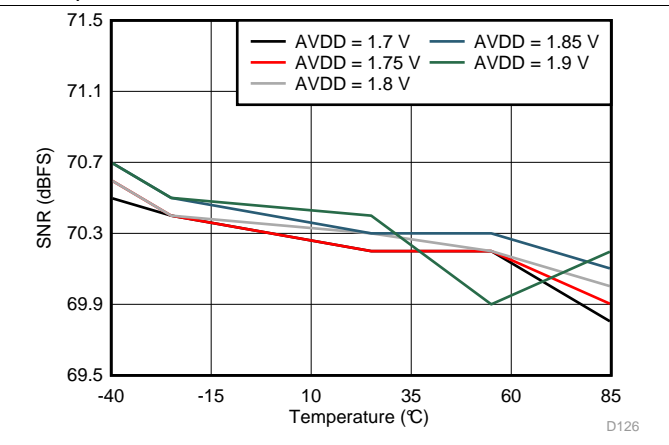


Figure 26. Signal-to-Noise Ratio vs AVDD Supply and Temperature

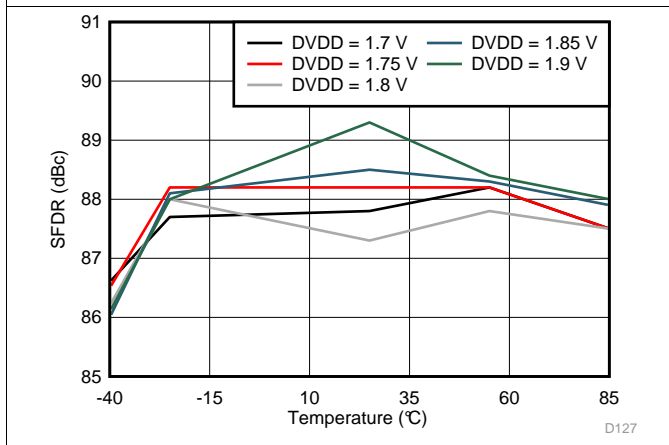


Figure 27. Spurious-Free Dynamic Range vs DVDD Supply and Temperature

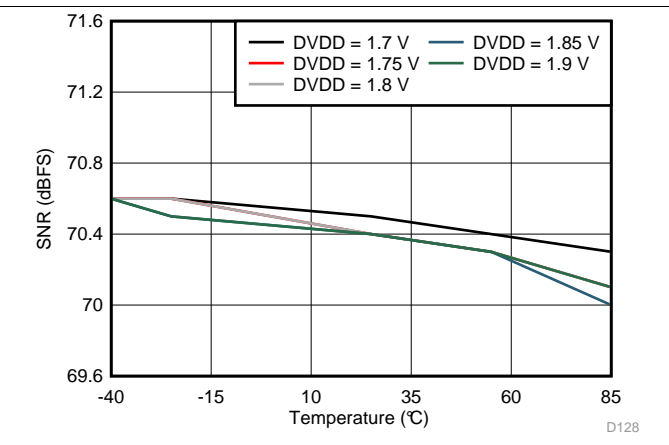


Figure 28. Signal-to-Noise Ratio vs DVDD Supply and Temperature

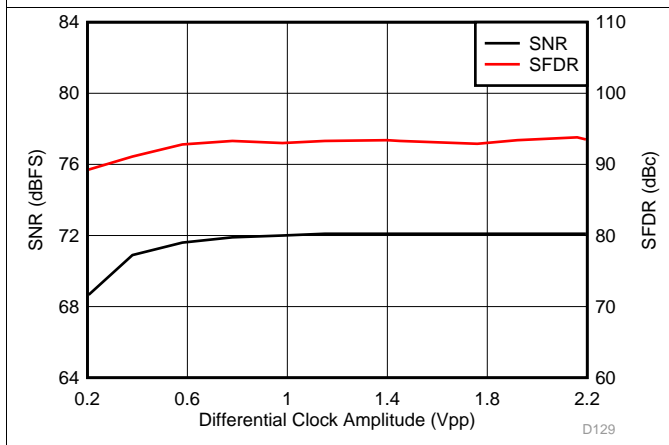


Figure 29. Performance vs Clock Amplitude (40 MHz)

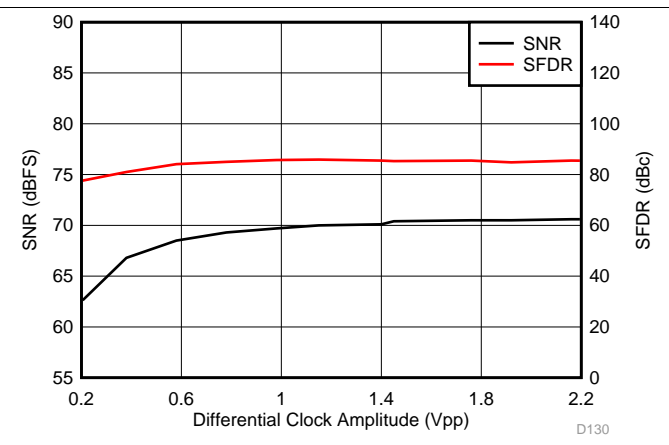


Figure 30. Performance vs Clock Amplitude (150 MHz)

Typical Characteristics: ADC32J45 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 160 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, 32k-point FFT, dither enabled, and special modes written, unless otherwise noted.

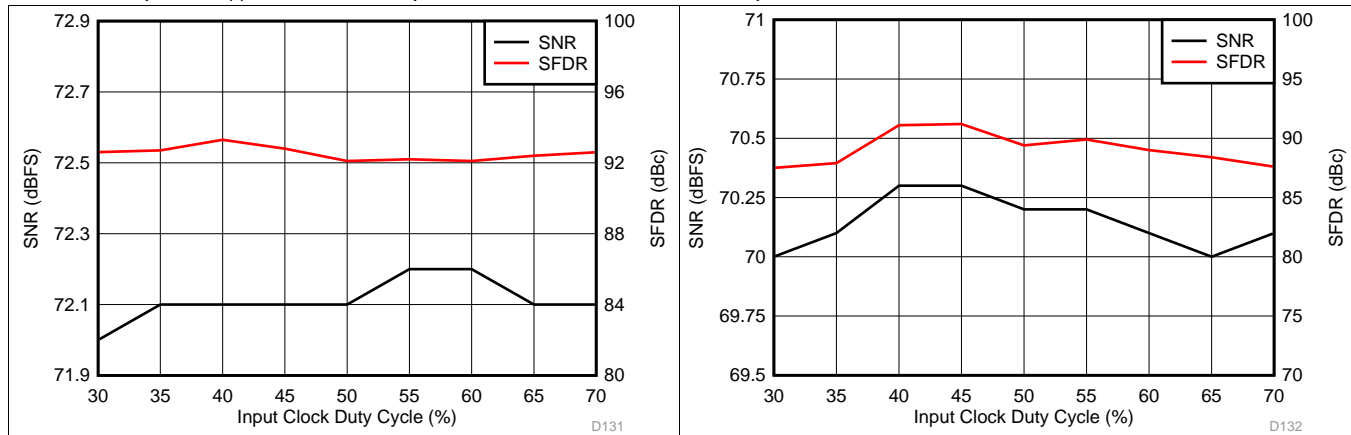


Figure 31. Performance vs Clock Duty Cycle (40 MHz)

Figure 32. Performance vs Clock Duty Cycle (150 MHz)

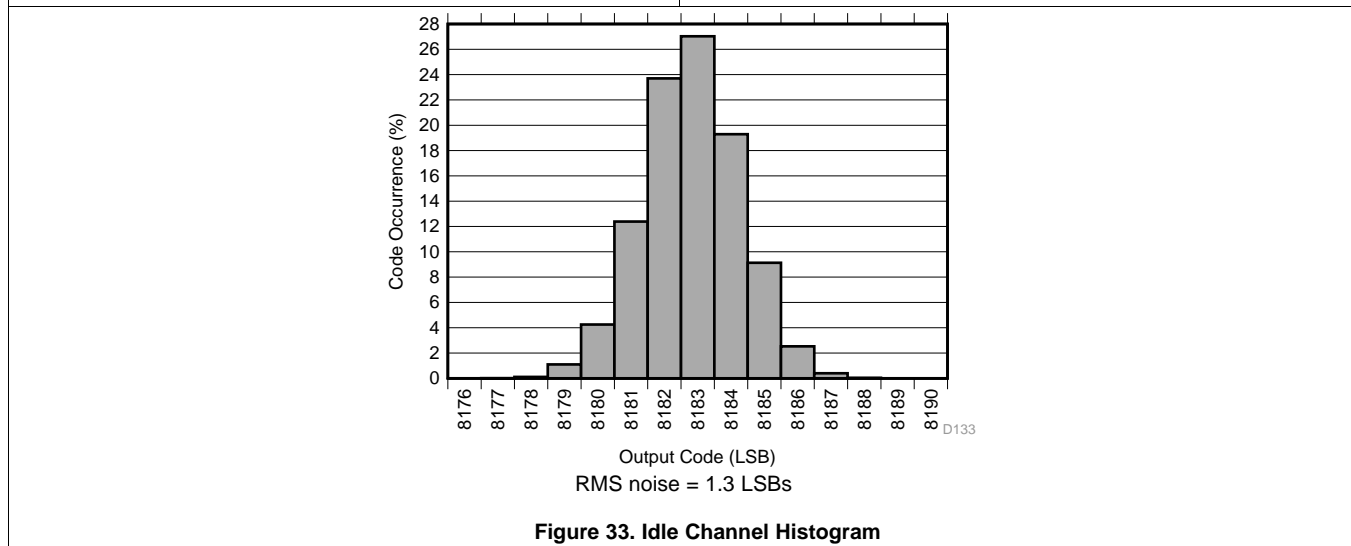


Figure 33. Idle Channel Histogram

7.15 Typical Characteristics: ADC32J44

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

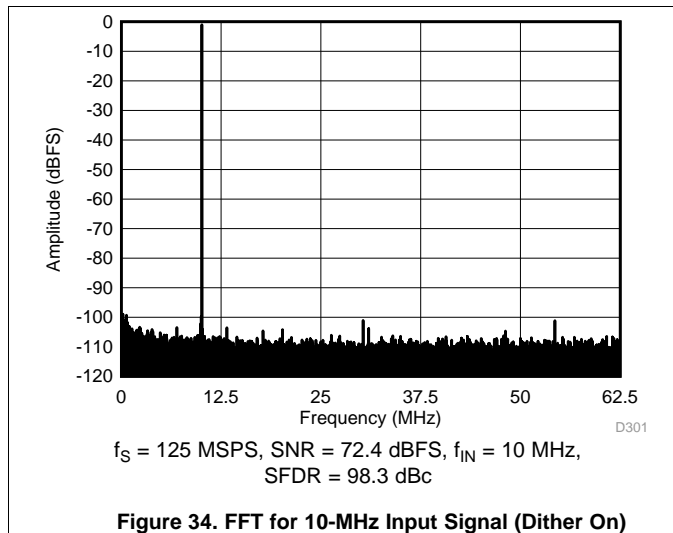


Figure 34. FFT for 10-MHz Input Signal (Dither On)

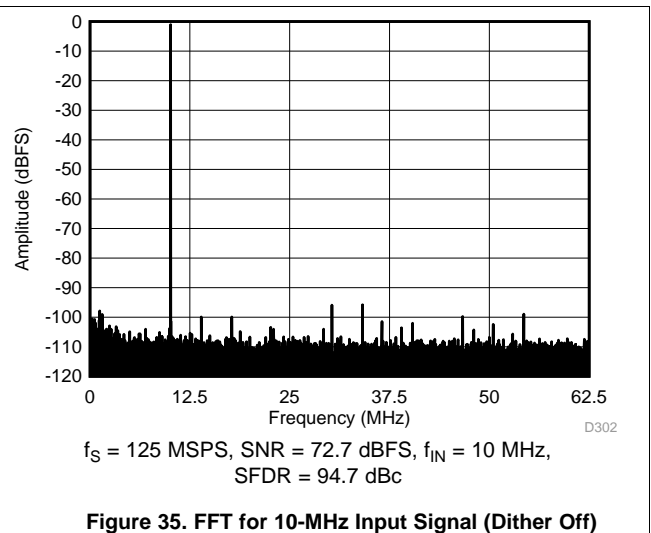


Figure 35. FFT for 10-MHz Input Signal (Dither Off)

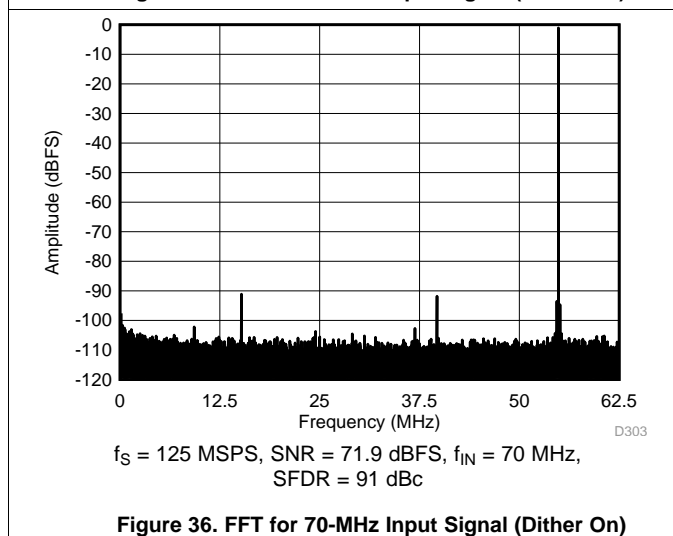


Figure 36. FFT for 70-MHz Input Signal (Dither On)

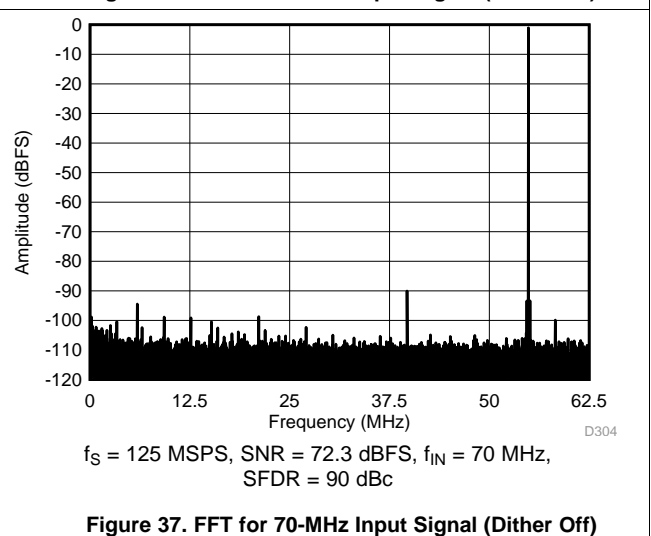


Figure 37. FFT for 70-MHz Input Signal (Dither Off)

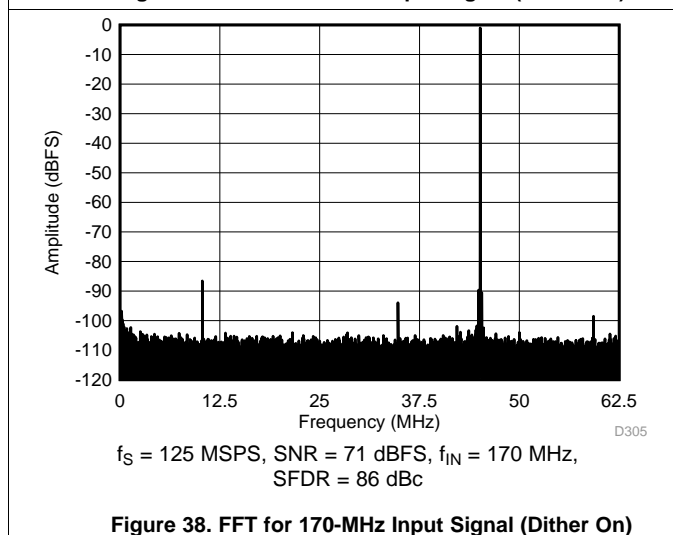


Figure 38. FFT for 170-MHz Input Signal (Dither On)

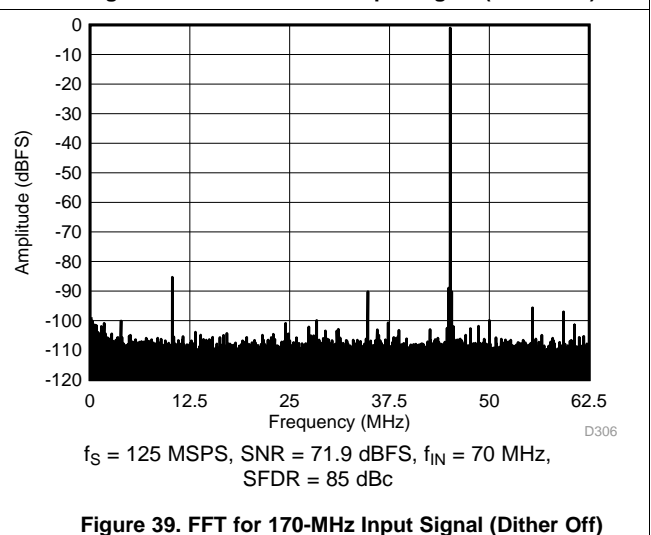


Figure 39. FFT for 170-MHz Input Signal (Dither Off)

Typical Characteristics: ADC32J44 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

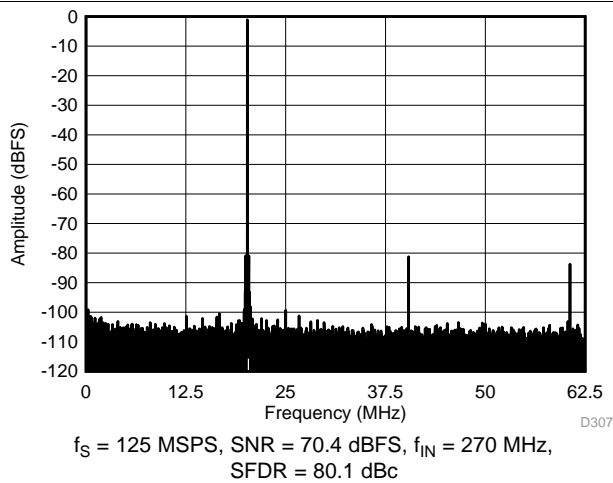


Figure 40. FFT for 270-MHz Input Signal (Dither On)

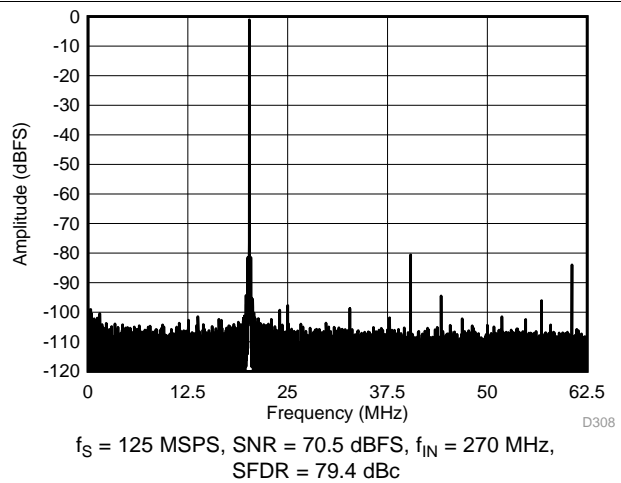


Figure 41. FFT for 270-MHz Input Signal (Dither Off)

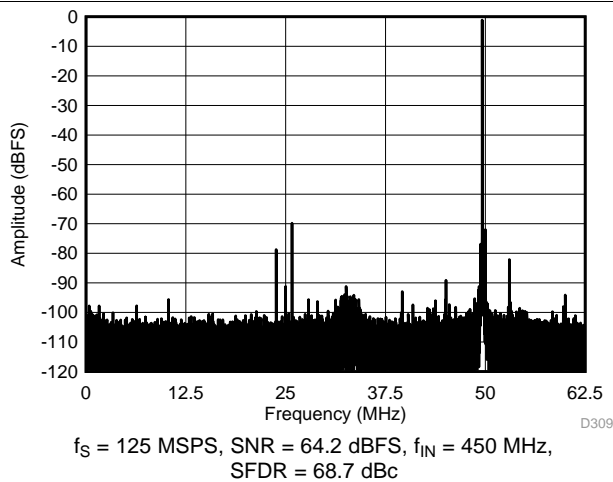


Figure 42. FFT for 450-MHz Input Signal (Dither On)

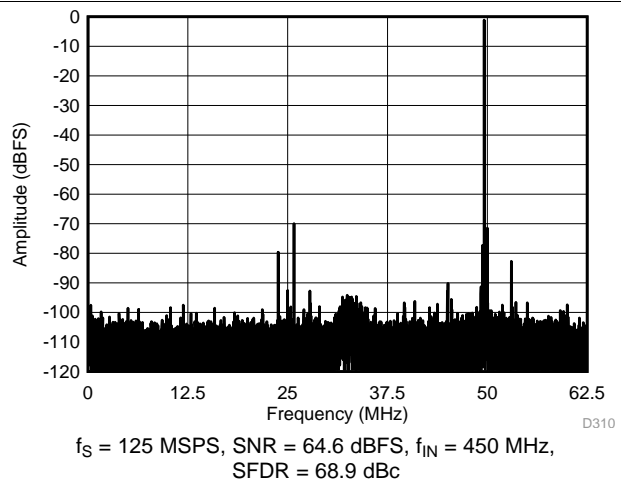
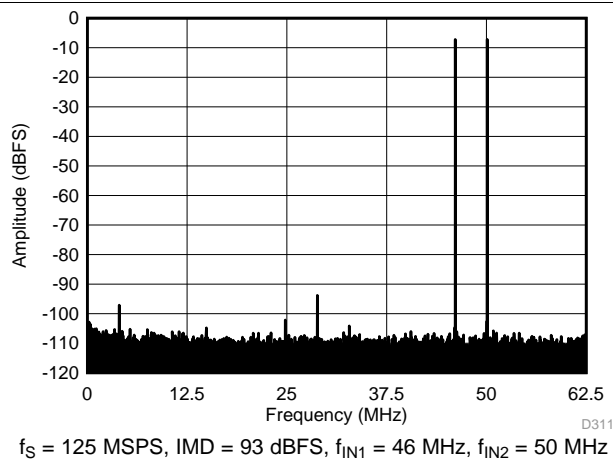
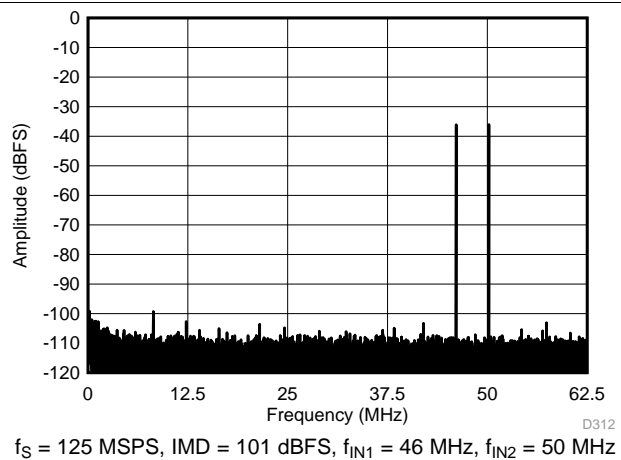


Figure 43. FFT for 450-MHz Input Signal (Dither Off)



**Figure 44. FFT for Two-Tone Input Signal
(-7 dBFS at 46 MHz and 50 MHz)**



**Figure 45. FFT for Two-Tone Input Signal
(-36 dBFS at 46 MHz and 50 MHz)**

Typical Characteristics: ADC32J44 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

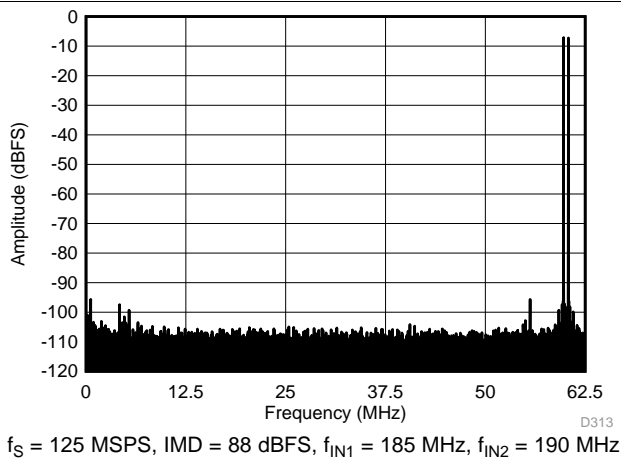


Figure 46. FFT for Two-Tone Input Signal (-7 dBFS at 185 MHz and 190 MHz)

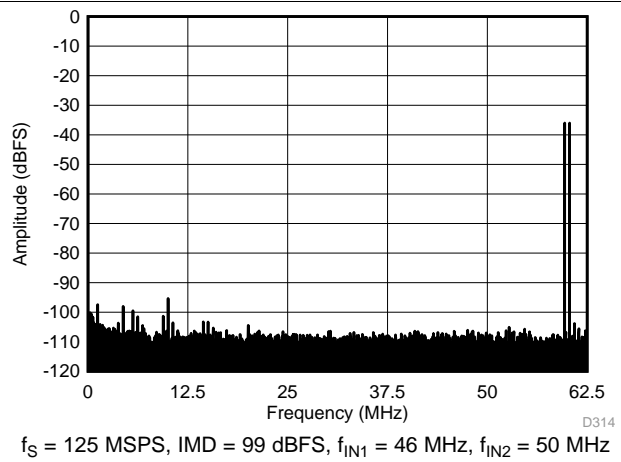


Figure 47. FFT for Two-Tone Input Signal (-36 dBFS at 185 MHz and 190 MHz)

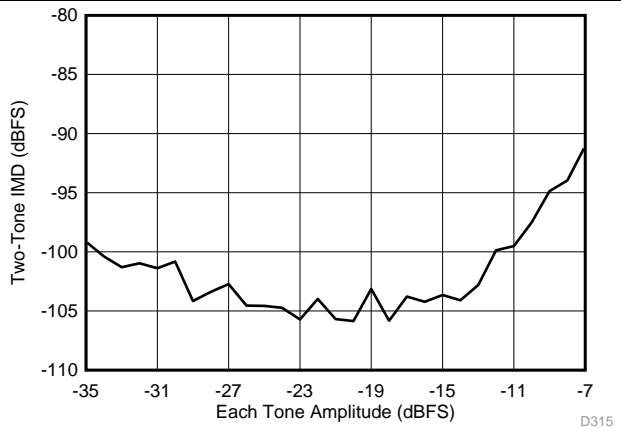


Figure 48. Intermodulation Distortion vs Input Amplitude (46 MHz and 50 MHz)

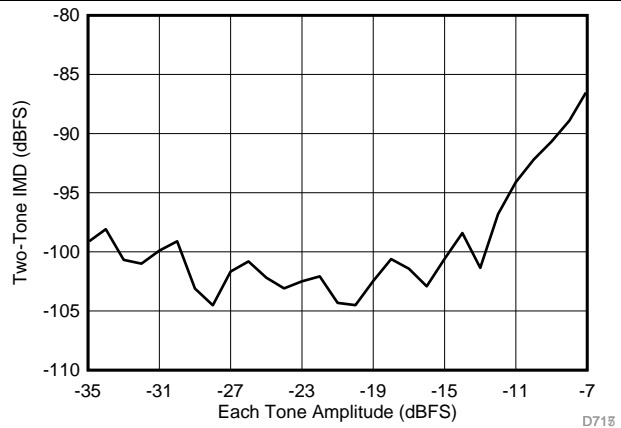


Figure 49. Intermodulation Distortion vs Input Amplitude (185 MHz and 190 MHz)

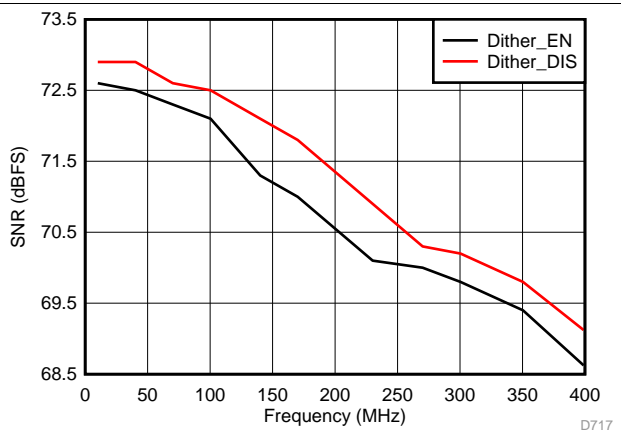


Figure 50. Signal-to-Noise Ratio vs Input Frequency

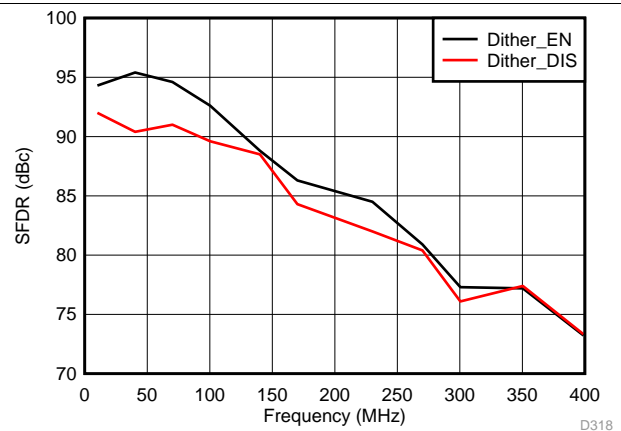


Figure 51. Spurious-Free Dynamic Range vs Input Frequency

Typical Characteristics: ADC32J44 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AV_{DD} = DV_{DD} = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

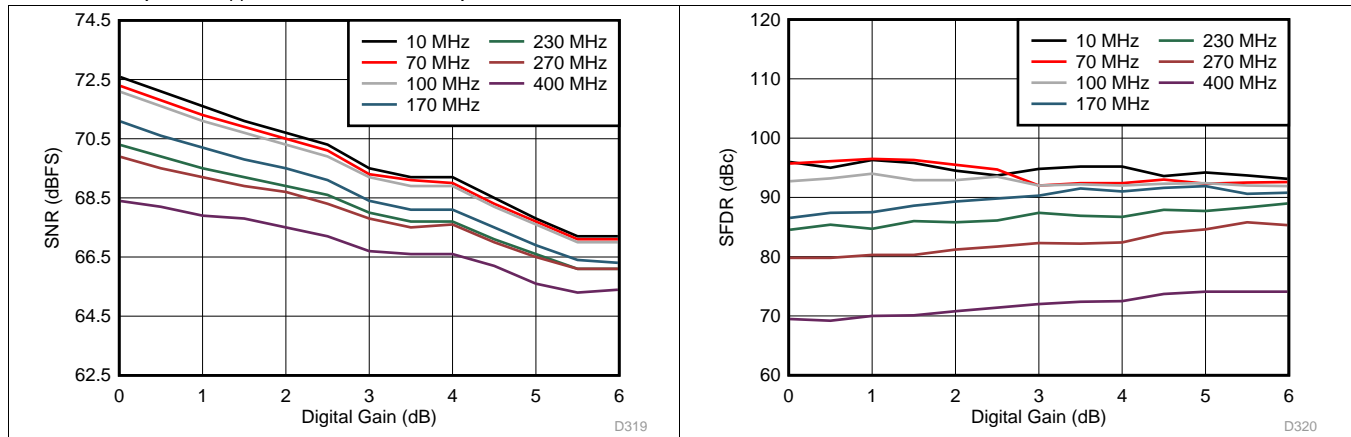


Figure 52. Signal-to-Noise Ratio vs Digital Gain and Input Frequency

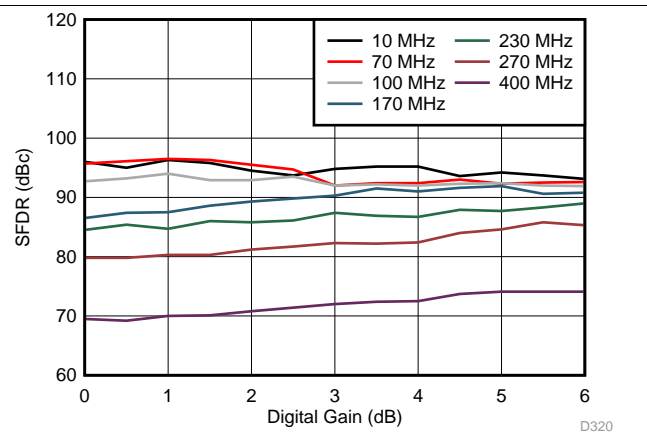


Figure 53. Spurious-Free Dynamic Range vs Digital Gain and Input Frequency

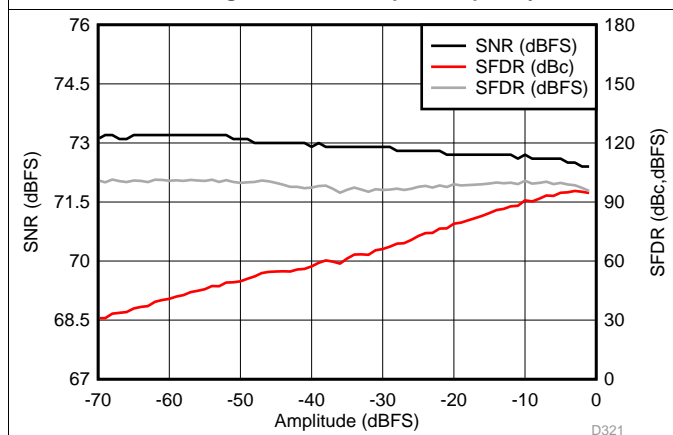


Figure 54. Performance vs Input Amplitude (30 MHz)

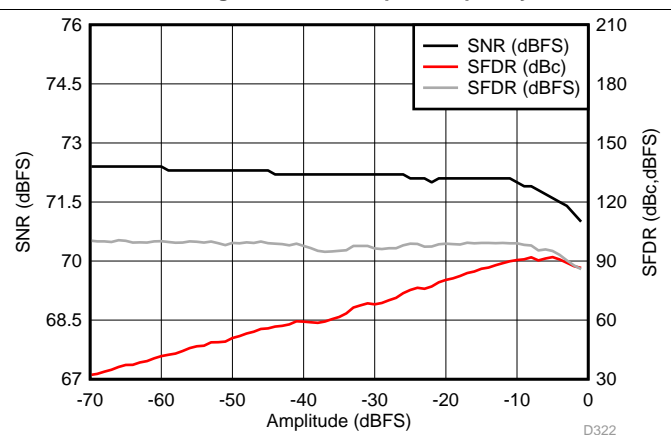


Figure 55. Performance vs Input Amplitude (170 MHz)

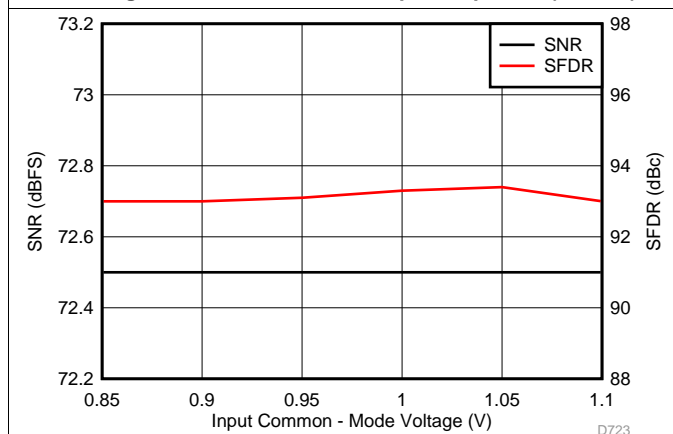


Figure 56. Performance vs Input Common-Mode Voltage (30 MHz)

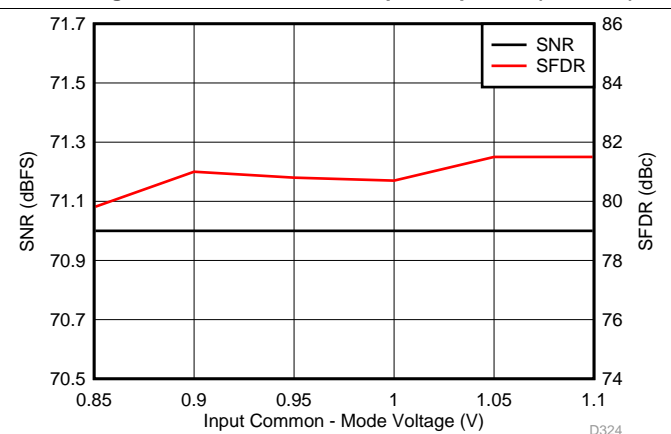


Figure 57. Performance vs Input Common-Mode Voltage (170 MHz)

Typical Characteristics: ADC32J44 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, 2-V_{PP} full-scale, and 32k-point FFT, unless otherwise noted.

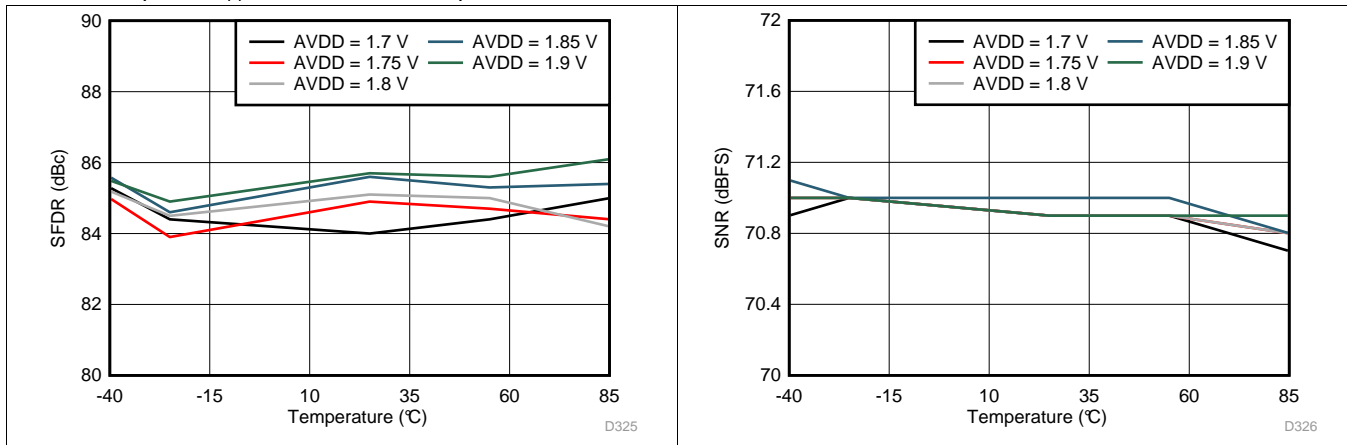


Figure 58. Spurious-Free Dynamic Range vs AVDD Supply and Temperature

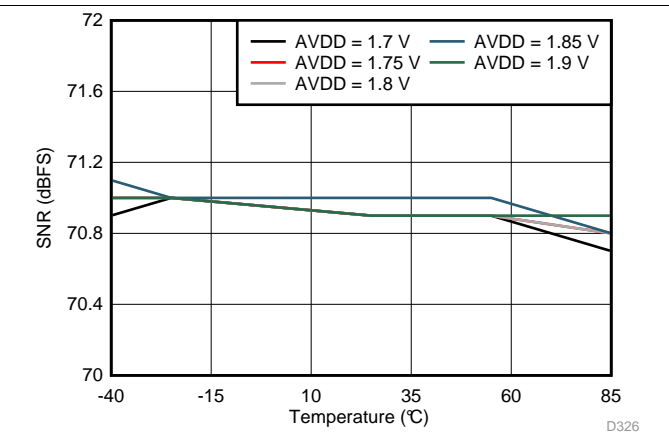


Figure 59. Signal-to-Noise Ratio vs AVDD Supply and Temperature

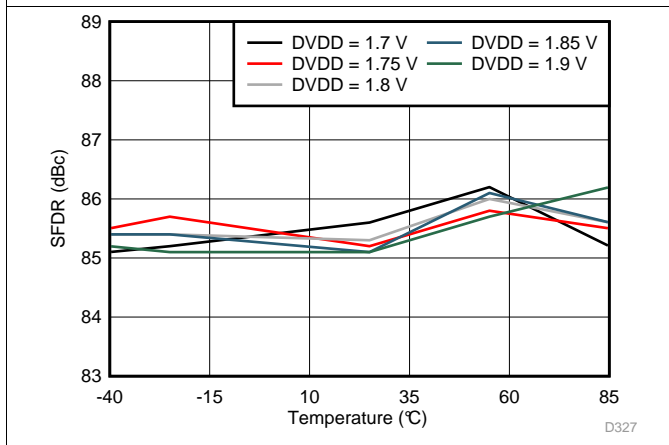


Figure 60. Spurious-Free Dynamic Range vs DVDD Supply and Temperature

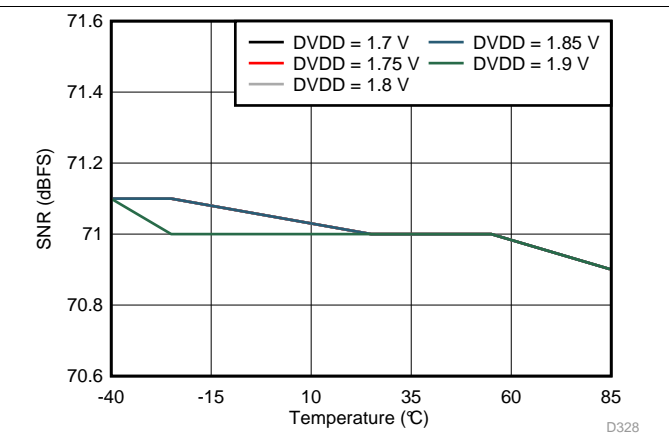


Figure 61. Signal-to-Noise Ratio vs DVDD Supply and Temperature

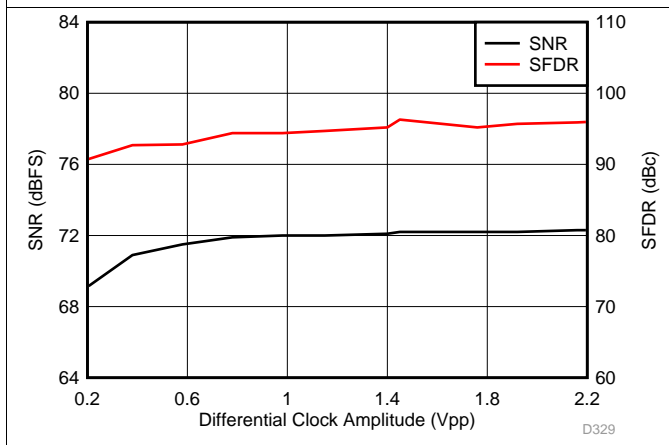


Figure 62. Performance vs Clock Amplitude (40 MHz)

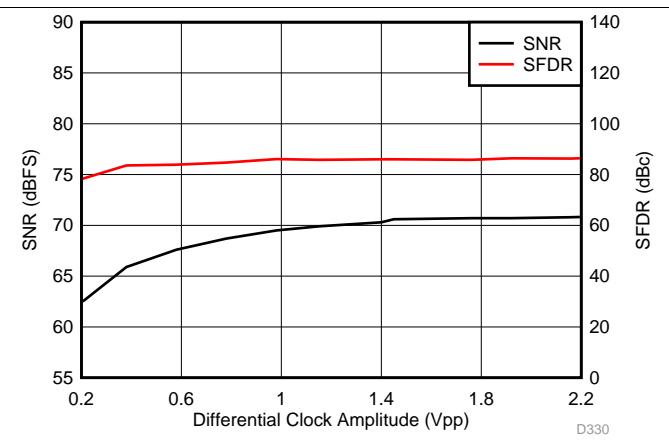


Figure 63. Performance vs Clock Amplitude (150 MHz)

Typical Characteristics: ADC32J44 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 125 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

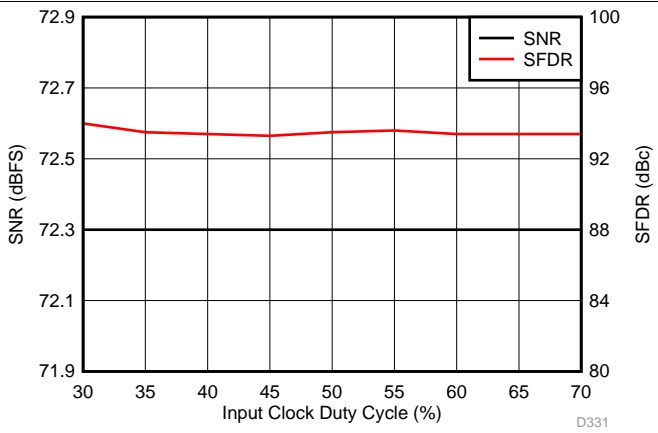


Figure 64. Performance vs Clock Duty Cycle (40 MHz)

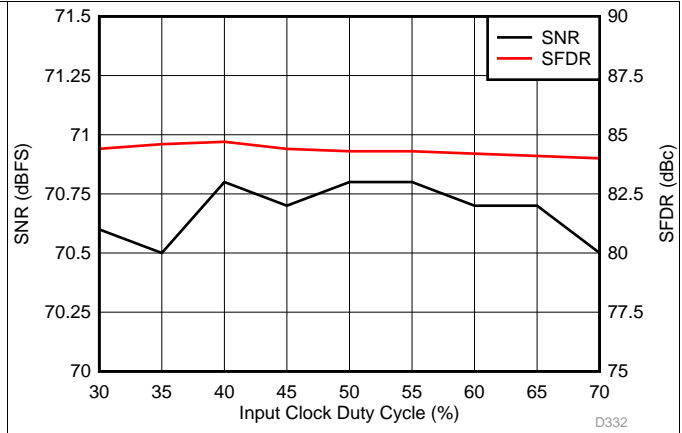


Figure 65. Performance vs Clock Duty Cycle (150 MHz)

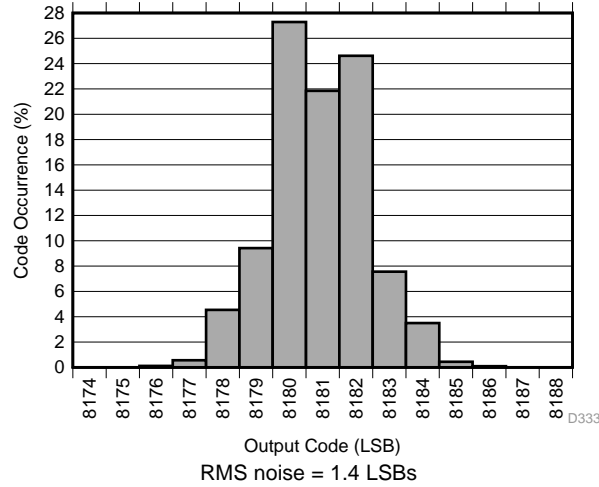
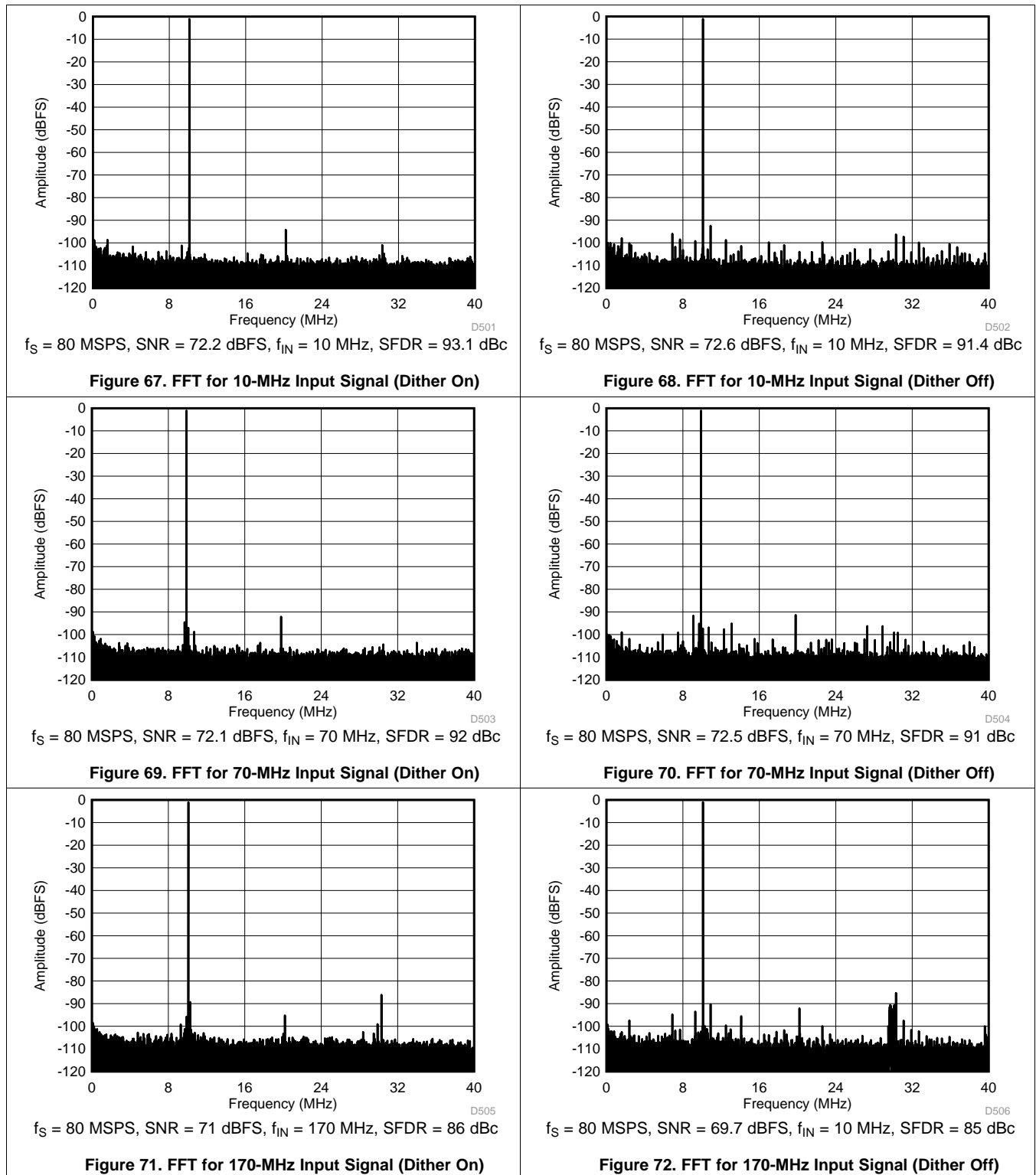


Figure 66. Idle Channel Histogram

7.16 Typical Characteristics: ADC32J43

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $AV_{DD} = DV_{DD} = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.



Typical Characteristics: ADC32J43 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

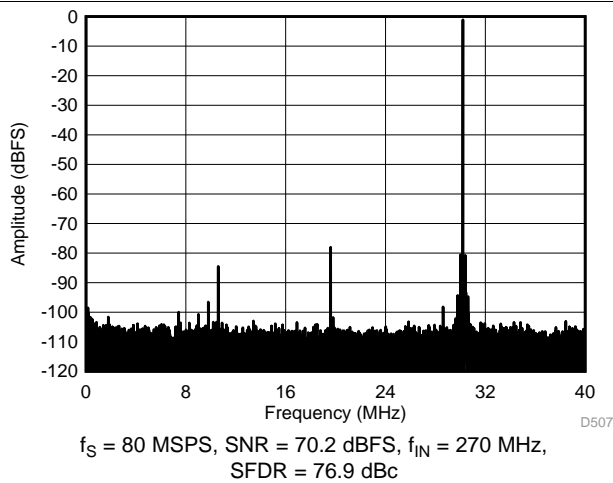


Figure 73. FFT for 270-MHz Input Signal (Dither On)

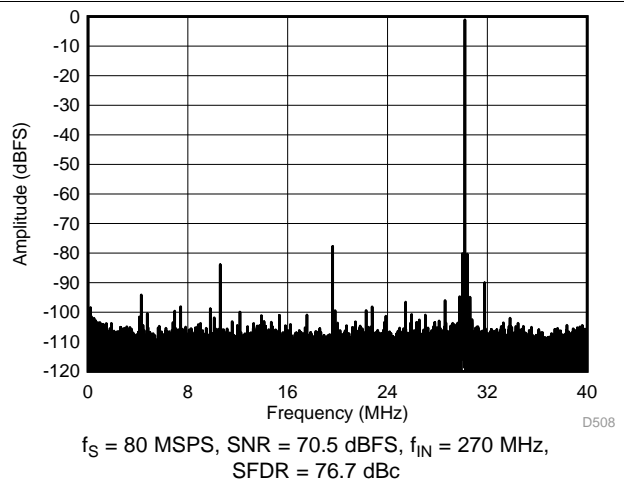


Figure 74. FFT for 270-MHz Input Signal (Dither Off)

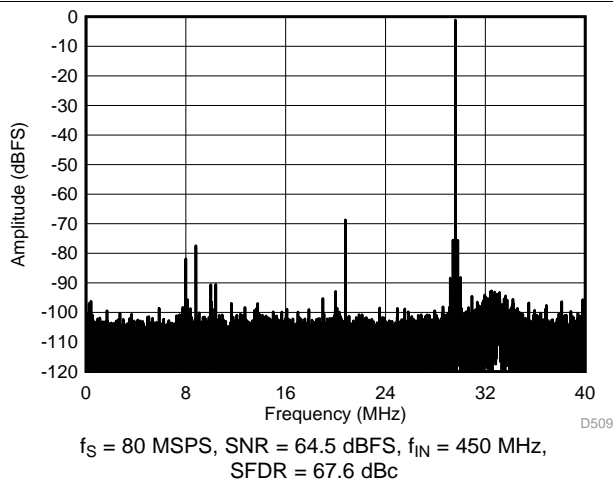


Figure 75. FFT for 450-MHz Input Signal (Dither On)

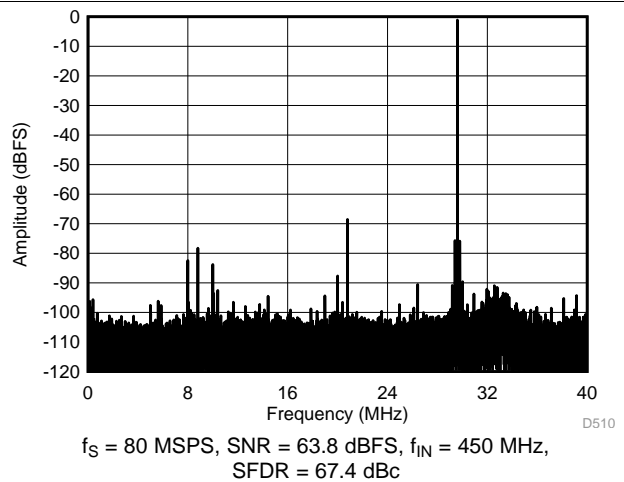
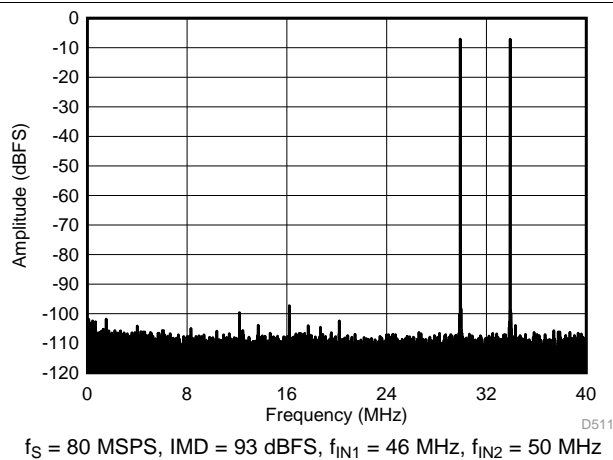
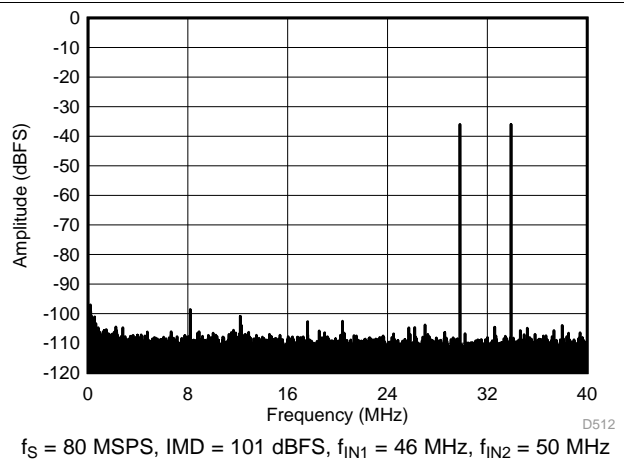


Figure 76. FFT for 450-MHz Input Signal (Dither Off)



**Figure 77. FFT for Two-Tone Input Signal
(-7 dBFS at 46 MHz and 50 MHz)**



**Figure 78. FFT for Two-Tone Input Signal
(-36 dBFS at 46 MHz and 50 MHz)**

Typical Characteristics: ADC32J43 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $AV_{DD} = DV_{DD} = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

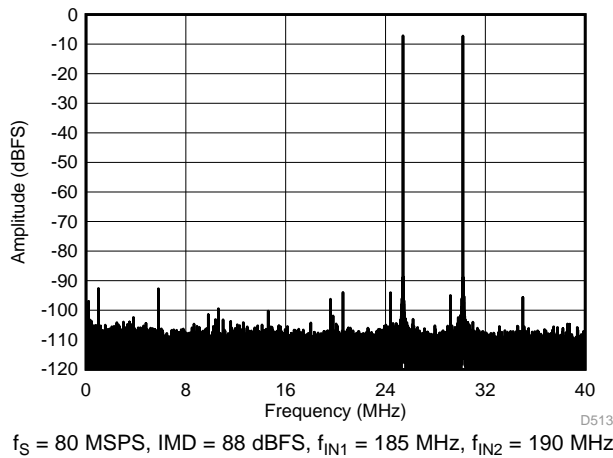


Figure 79. FFT for Two-Tone Input Signal (-7 dBFS at 185 MHz and 190 MHz)

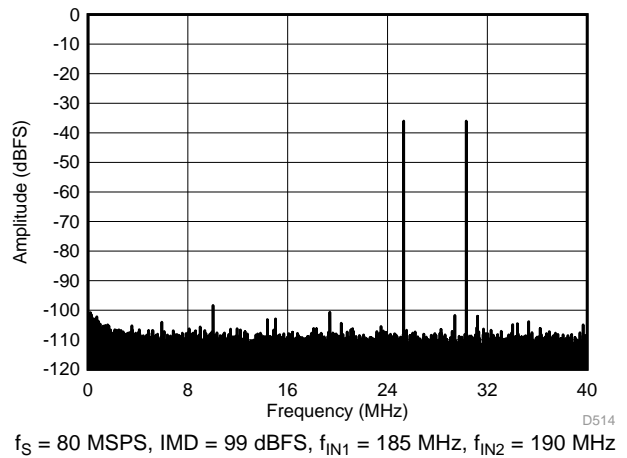


Figure 80. FFT for Two-Tone Input Signal (-36 dBFS at 185 MHz and 190 MHz)

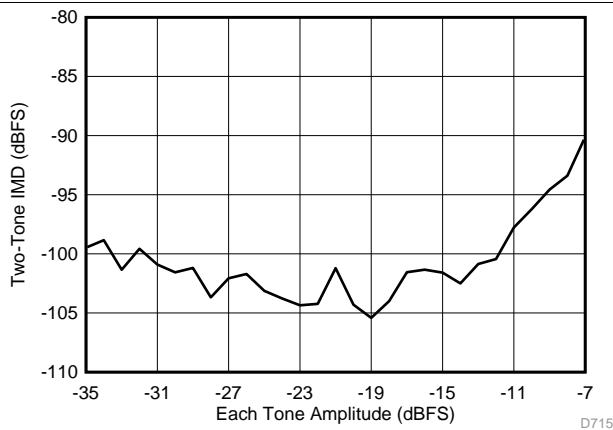


Figure 81. Intermodulation Distortion vs Input Amplitude (46 MHz and 50 MHz)

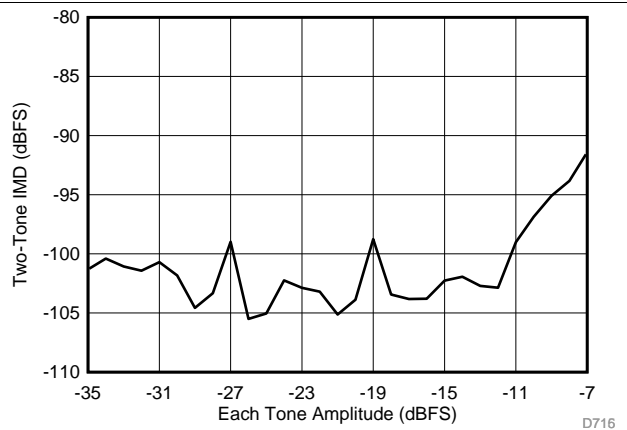


Figure 82. Intermodulation Distortion vs Input Amplitude (185 MHz and 190 MHz)

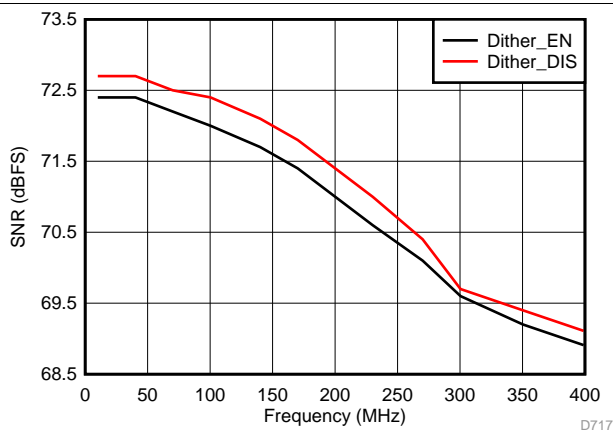


Figure 83. Signal-to-Noise Ratio vs Input Frequency

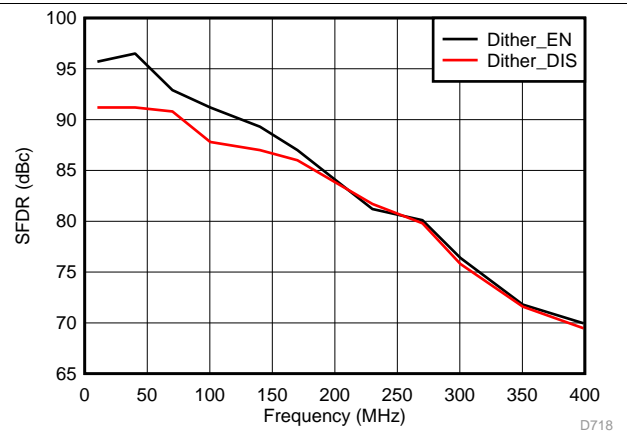


Figure 84. Spurious-Free Dynamic Range vs Input Frequency

Typical Characteristics: ADC32J43 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $AV_{DD} = DV_{DD} = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

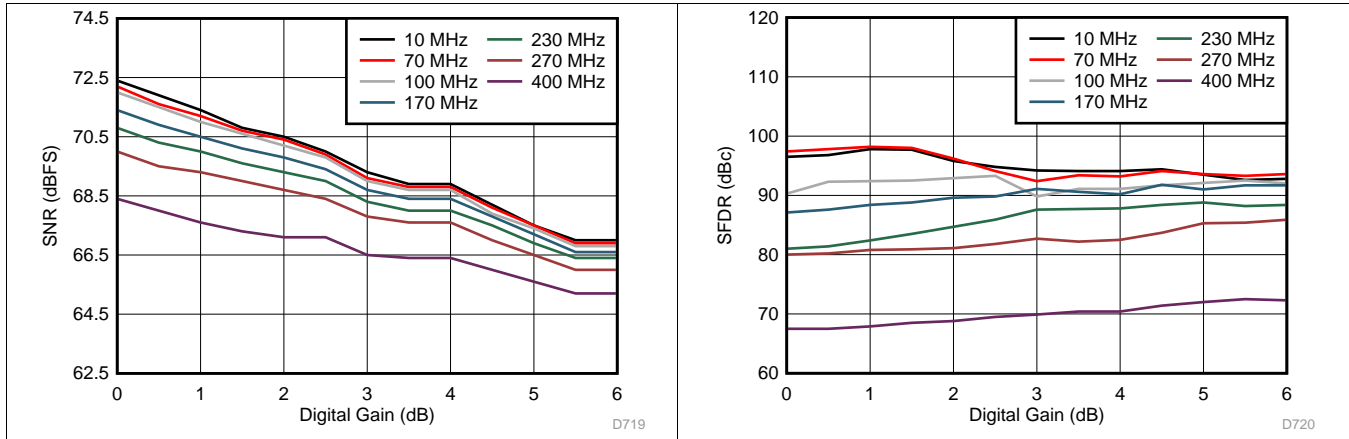


Figure 85. Signal-to-Noise Ratio vs Digital Gain and Input Frequency

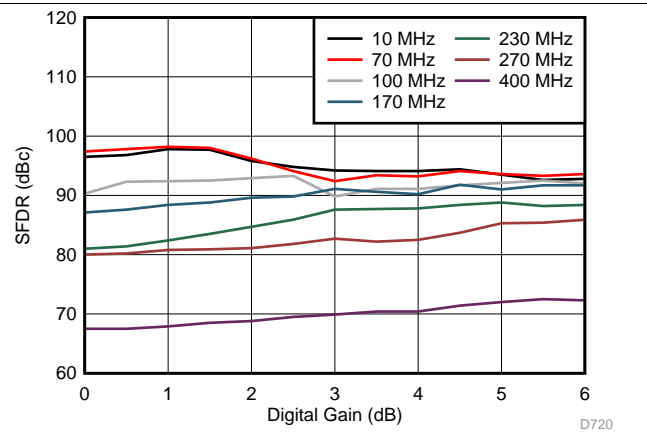


Figure 86. Spurious-Free Dynamic Range vs Digital Gain and Input Frequency

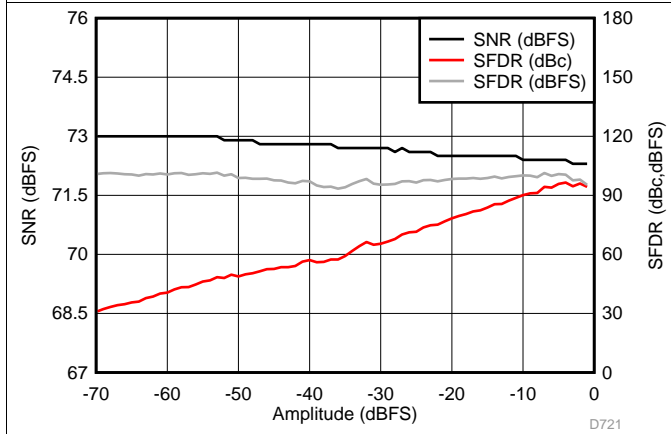


Figure 87. Performance vs Input Amplitude (30 MHz)

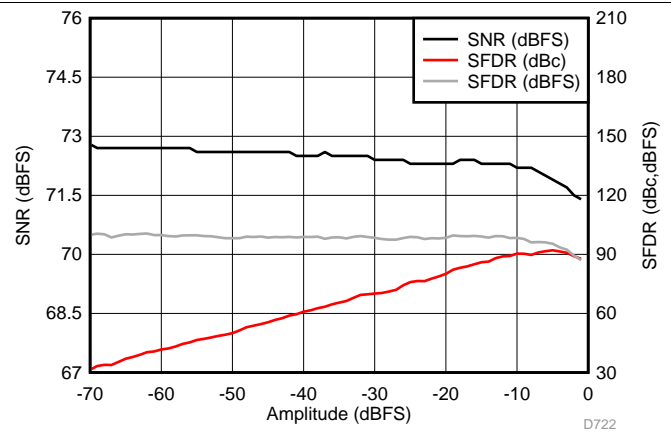


Figure 88. Performance vs Input Amplitude (170 MHz)

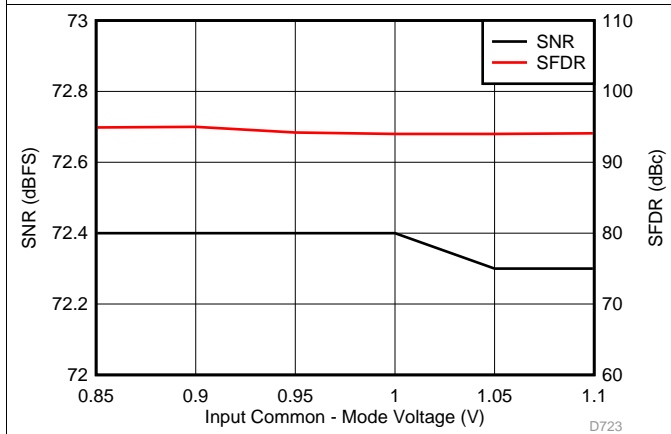


Figure 89. Performance vs Input Common-Mode Voltage (30 MHz)

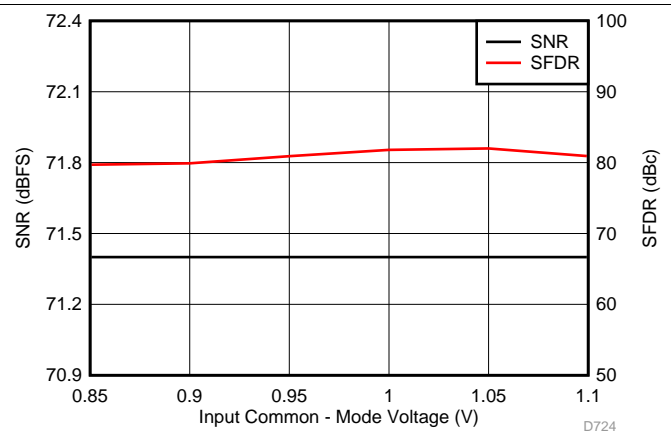
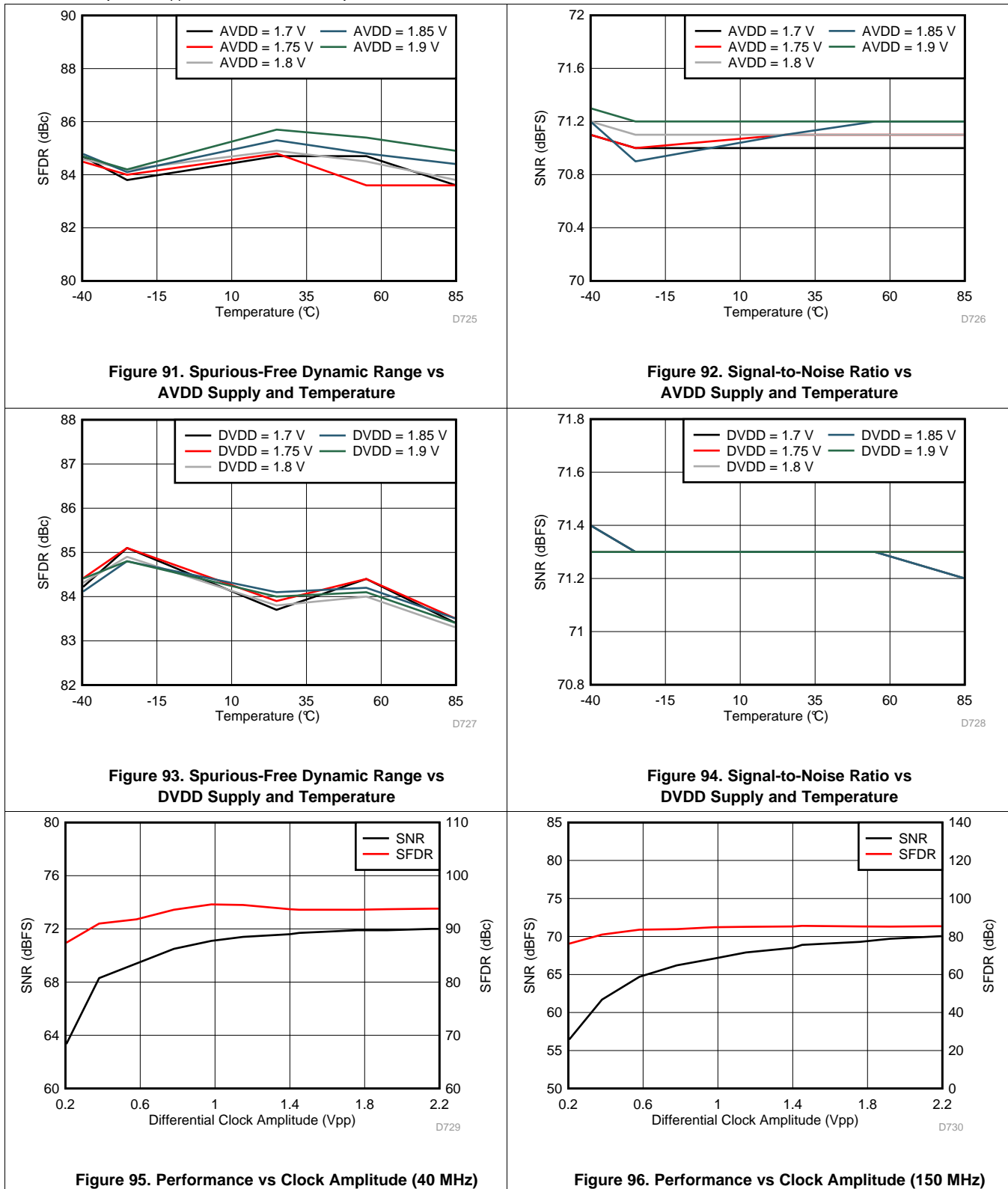


Figure 90. Performance vs Input Common-Mode Voltage (170 MHz)

Typical Characteristics: ADC32J43 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, AVDD = DVDD = 1.8 V, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.



Typical Characteristics: ADC32J43 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 80 MSPS, 50% clock duty cycle, $AV_{DD} = DV_{DD} = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

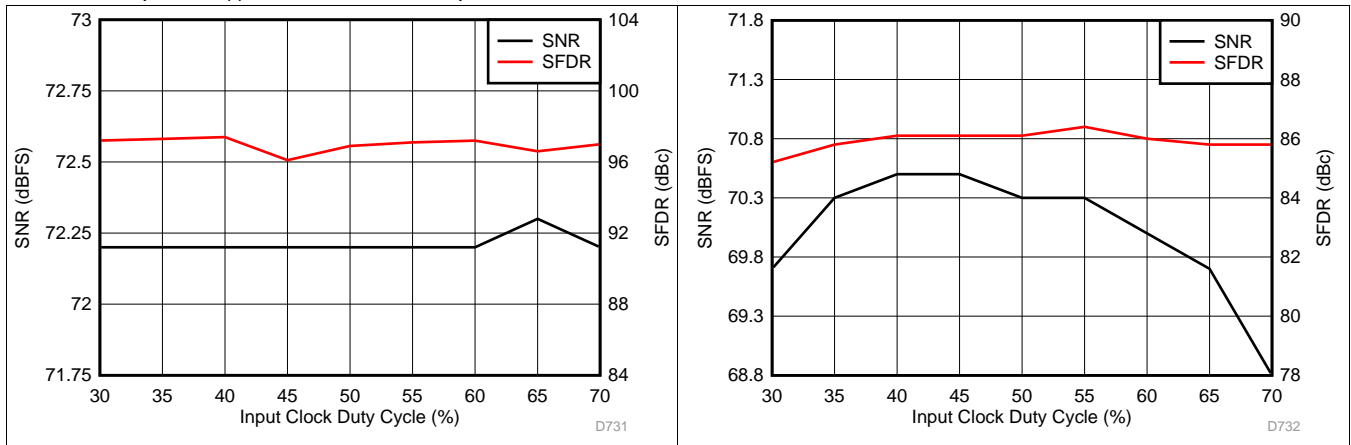


Figure 97. Performance vs Clock Duty Cycle (40 MHz)

Figure 98. Performance vs Clock Duty Cycle (150 MHz)

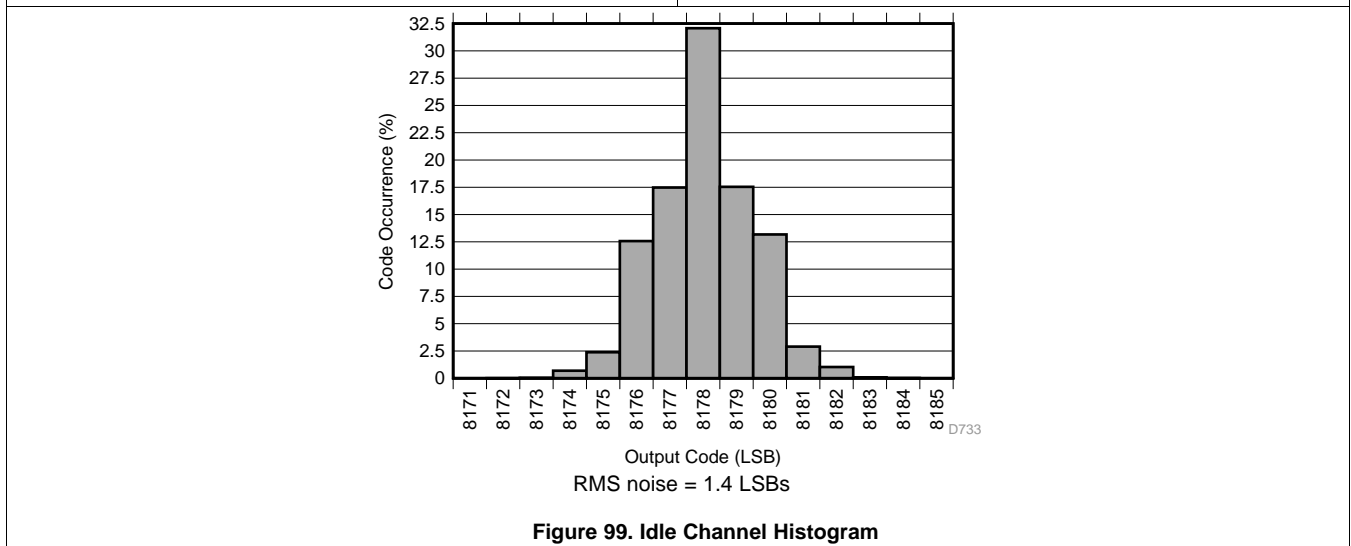
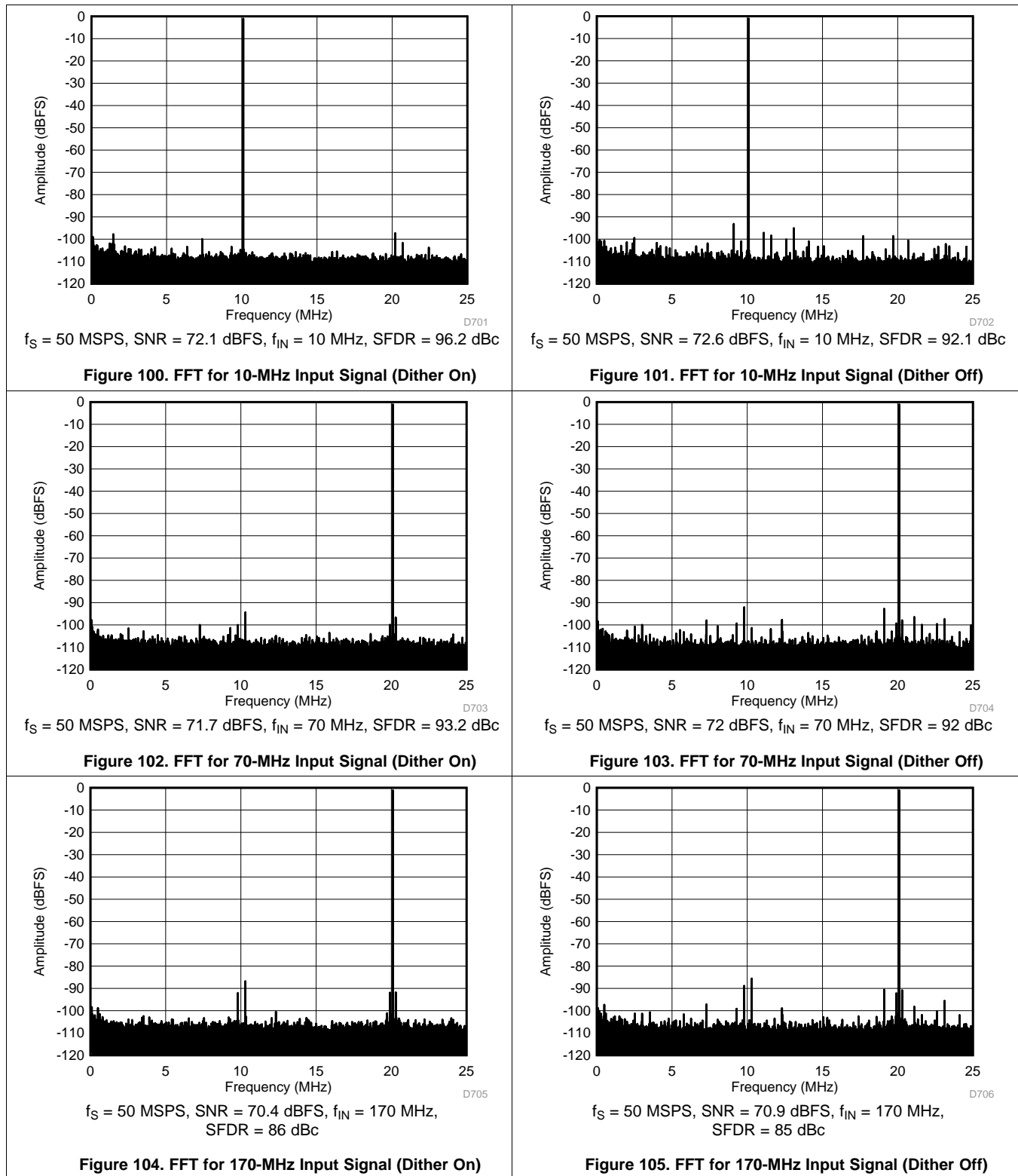


Figure 99. Idle Channel Histogram

7.17 Typical Characteristics: ADC32J42

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.



Typical Characteristics: ADC32J42 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $AV_{DD} = DV_{DD} = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

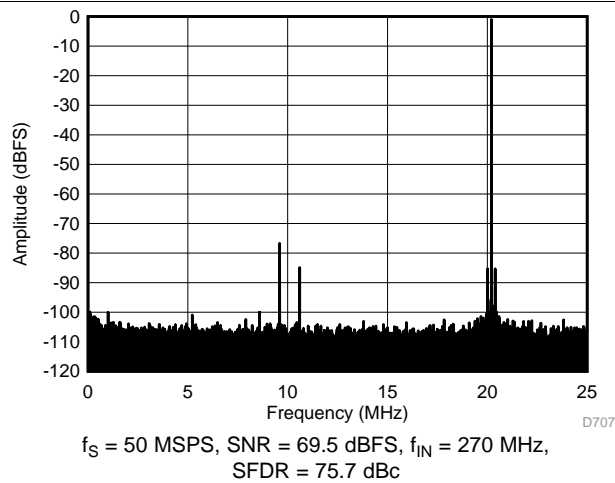


Figure 106. FFT for 270-MHz Input Signal (Dither On)

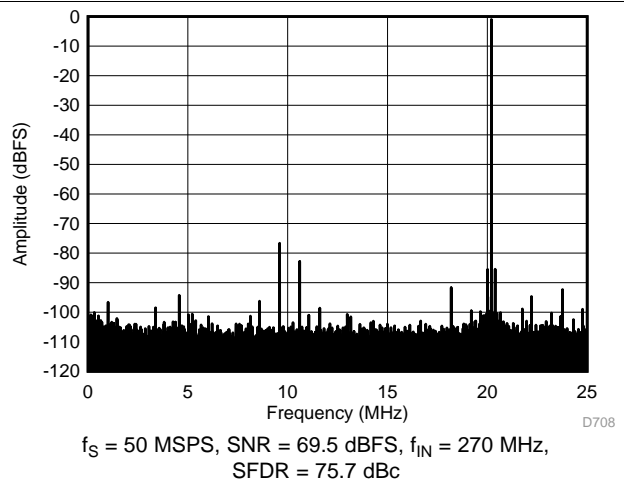


Figure 107. FFT for 270-MHz Input Signal (Dither Off)

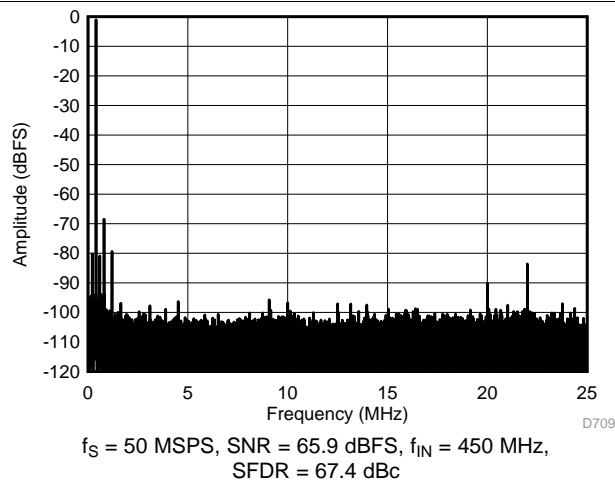


Figure 108. FFT for 450-MHz Input Signal (Dither On)

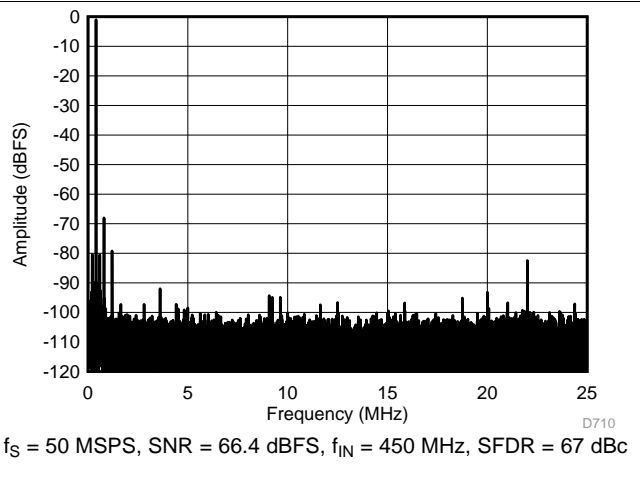
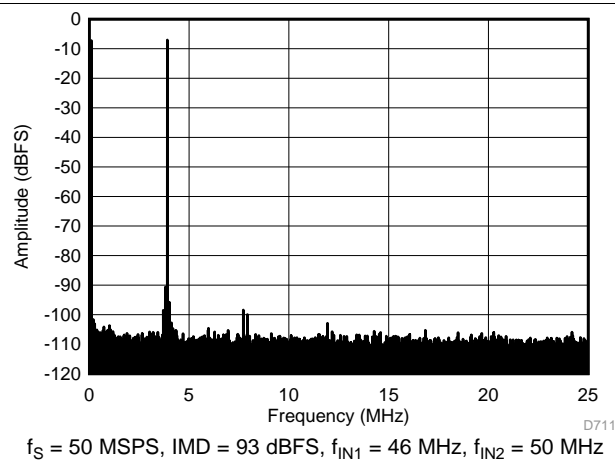
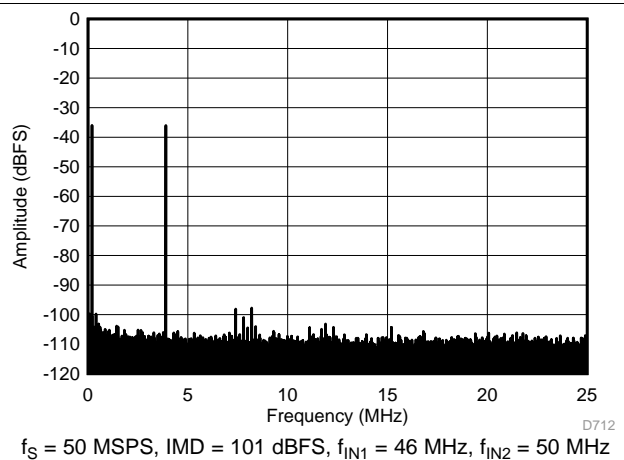


Figure 109. FFT for 450-MHz Input Signal (Dither Off)



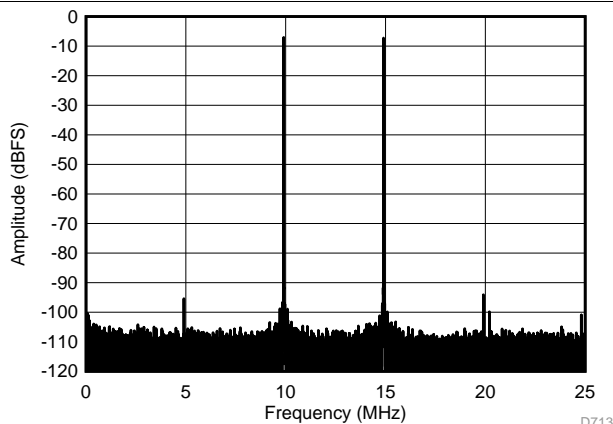
**Figure 110. FFT for Two-Tone Input Signal
(-7 dBFS at 46 MHz and 50 MHz)**



**Figure 111. FFT for Two-Tone Input Signal
(-36 dBFS at 46 MHz and 50 MHz)**

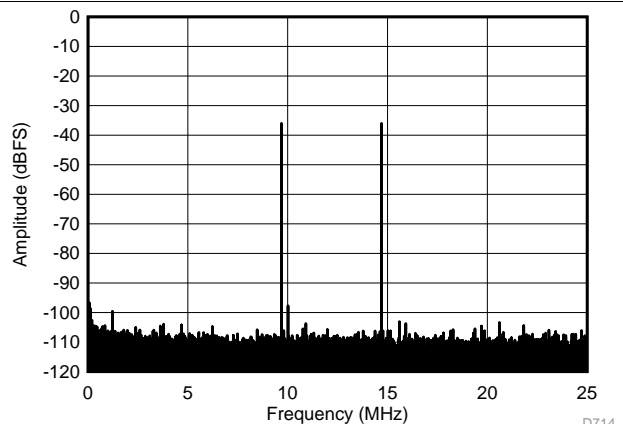
Typical Characteristics: ADC32J42 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $AV_{DD} = DV_{DD} = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.



$f_S = 50\text{ MSPS}$, $\text{IMD} = 86\text{ dBFS}$, $f_{IN1} = 185\text{ MHz}$, $f_{IN2} = 190\text{ MHz}$

Figure 112. FFT for Two-Tone Input Signal (-7 dBFS at 185 MHz and 190 MHz)



$f_S = 50\text{ MSPS}$, $\text{IMD} = 99\text{ dBFS}$, $f_{IN1} = 185\text{ MHz}$, $f_{IN2} = 190\text{ MHz}$

Figure 113. FFT for Two-Tone Input Signal (-36 dBFS at 185 MHz and 190 MHz)

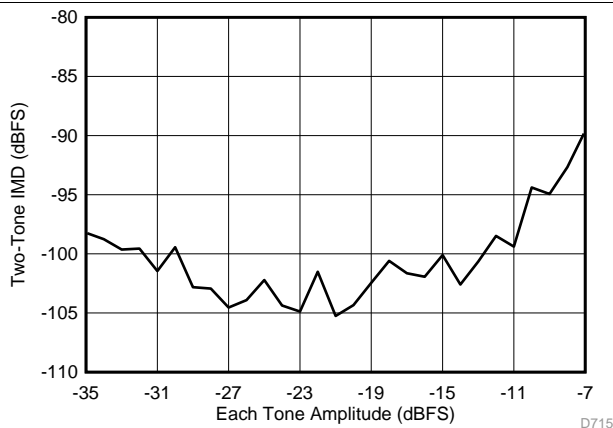


Figure 114. Intermodulation Distortion vs Input Amplitude (46 MHz and 50 MHz)

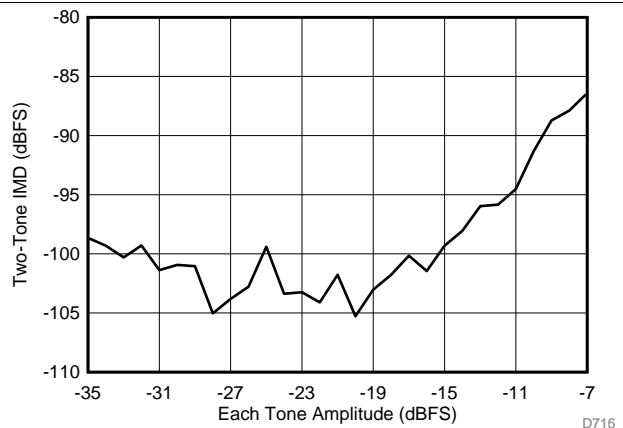


Figure 115. Intermodulation Distortion vs Input Amplitude (185 MHz and 190 MHz)

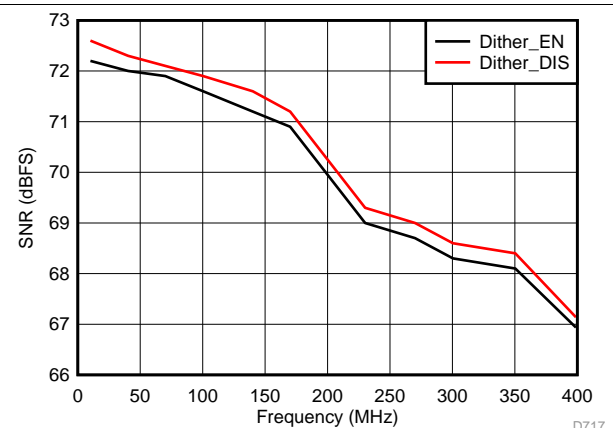


Figure 116. Signal-to-Noise Ratio vs Input Frequency

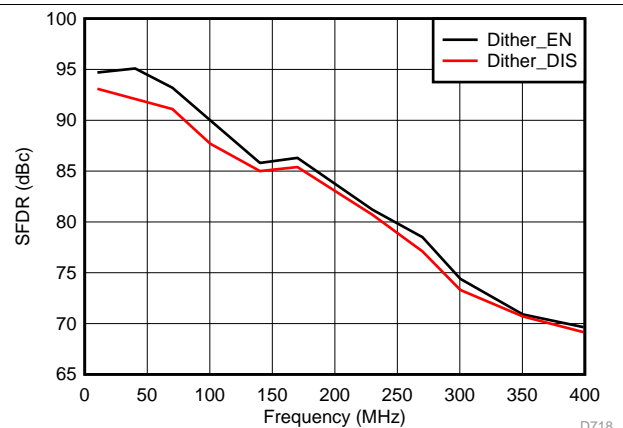


Figure 117. Spurious-Free Dynamic Range vs Input Frequency

Typical Characteristics: ADC32J42 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2 \cdot V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

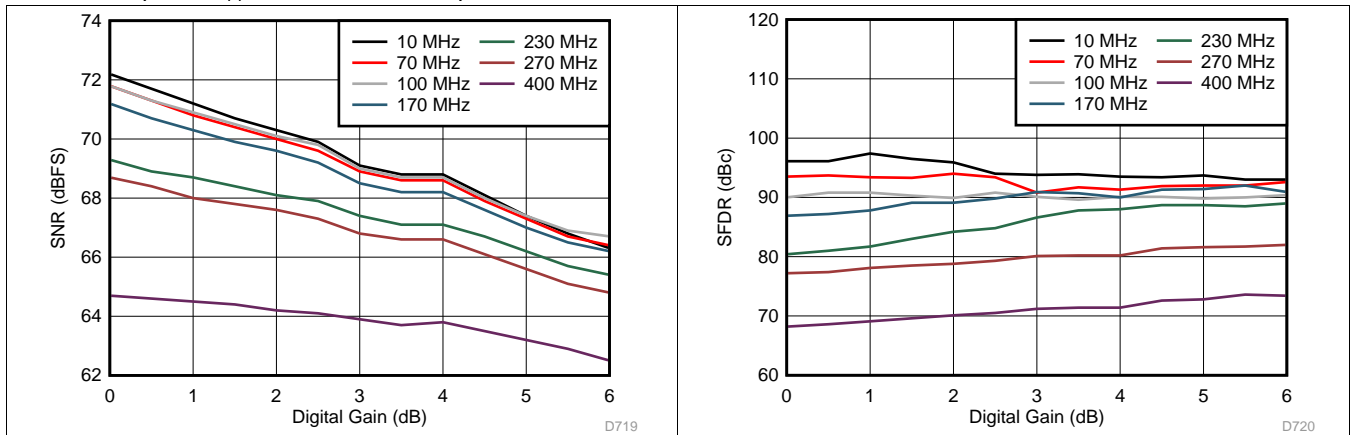


Figure 118. Signal-to-Noise Ratio vs Digital Gain and Input Frequency

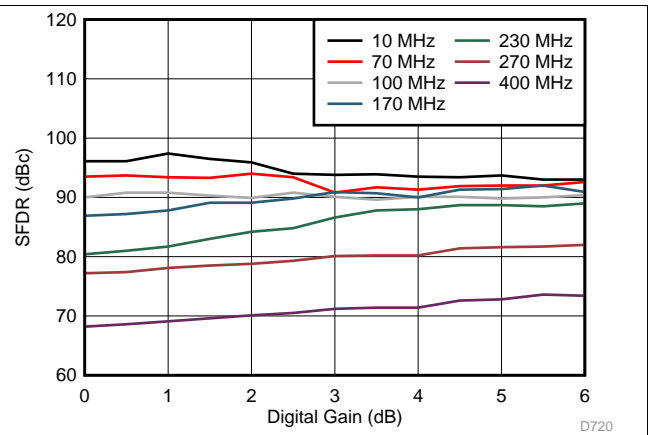


Figure 119. Spurious-Free Dynamic Range vs Digital Gain and Input Frequency

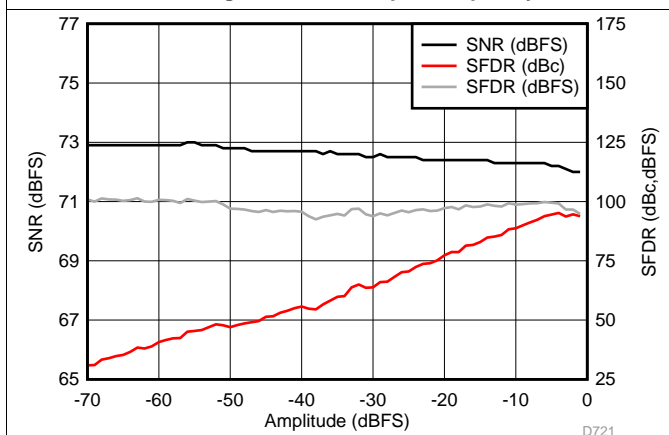


Figure 120. Performance vs Input Amplitude (30 MHz)

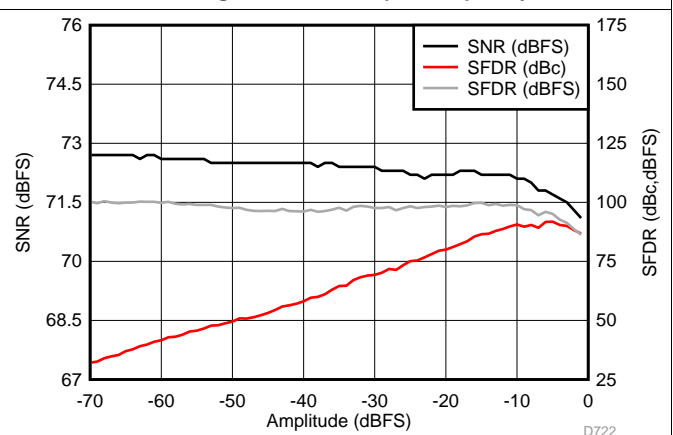


Figure 121. Performance vs Input Amplitude (170 MHz)

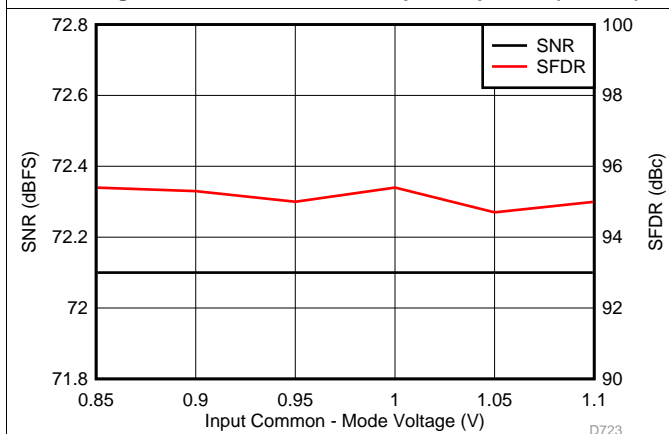


Figure 122. Performance vs Input Common-Mode Voltage (30 MHz)

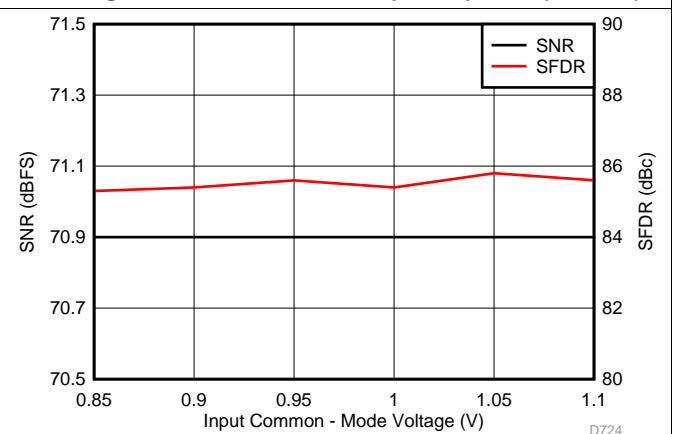


Figure 123. Performance vs Input Common-Mode Voltage (170 MHz)

Typical Characteristics: ADC32J42 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, AVDD = DVDD = 1.8 V, -1-dBFS differential input, $2\text{-}V_{pp}$ full-scale, and 32k-point FFT, unless otherwise noted.

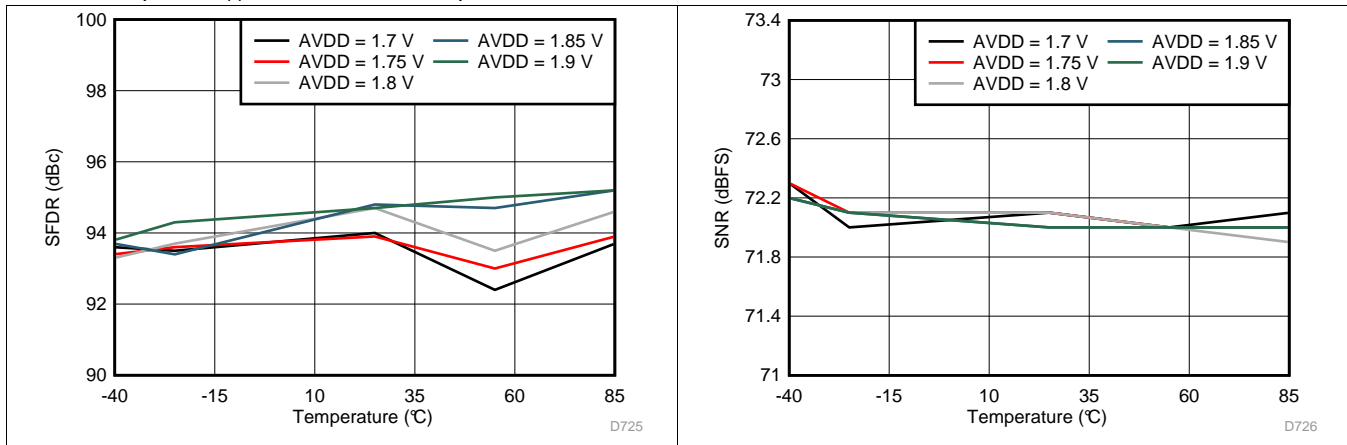


Figure 124. Spurious-Free Dynamic Range vs AVDD Supply and Temperature

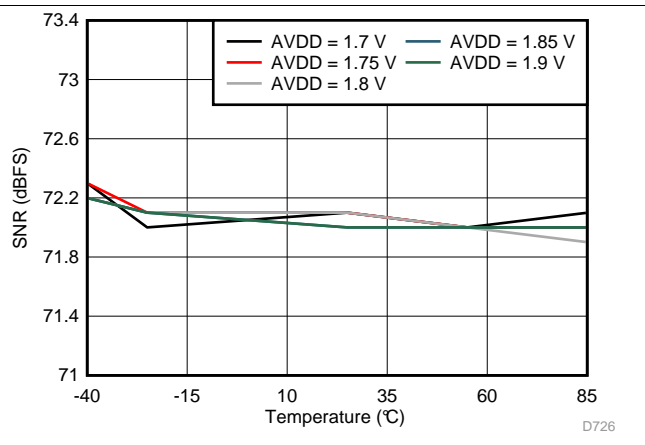


Figure 125. Signal-to-Noise Ratio vs AVDD Supply and Temperature

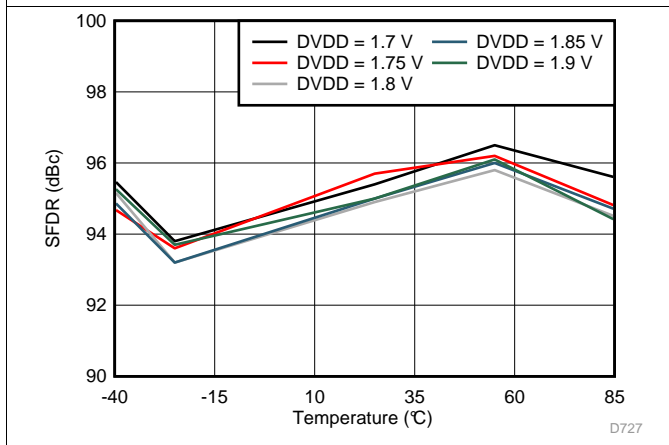


Figure 126. Spurious-Free Dynamic Range vs DVDD Supply and Temperature

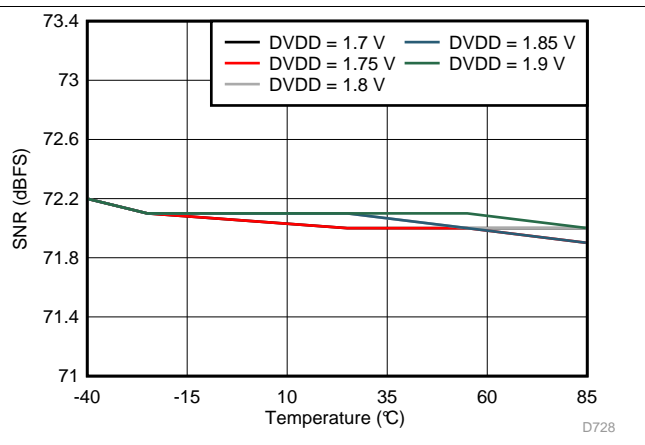


Figure 127. Signal-to-Noise Ratio vs DVDD Supply and Temperature

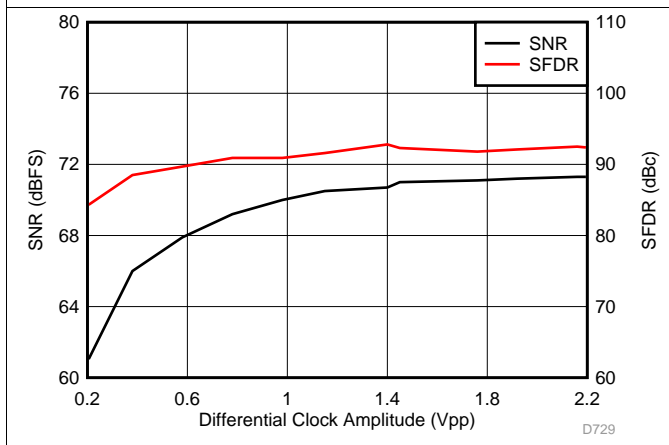


Figure 128. Performance vs Clock Amplitude (40 MHz)

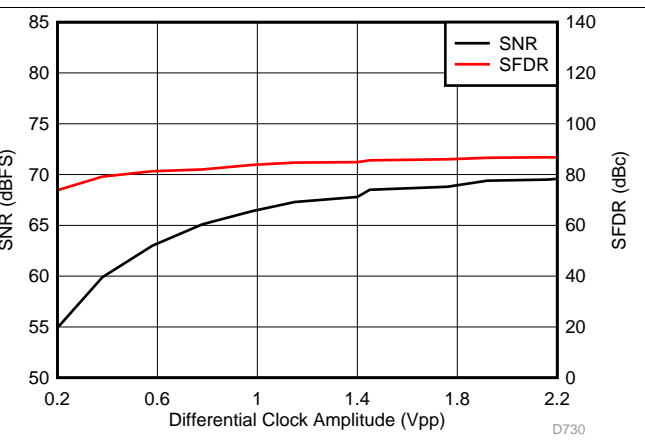


Figure 129. Performance vs Clock Amplitude (150 MHz)

Typical Characteristics: ADC32J42 (continued)

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 50 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1-dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.

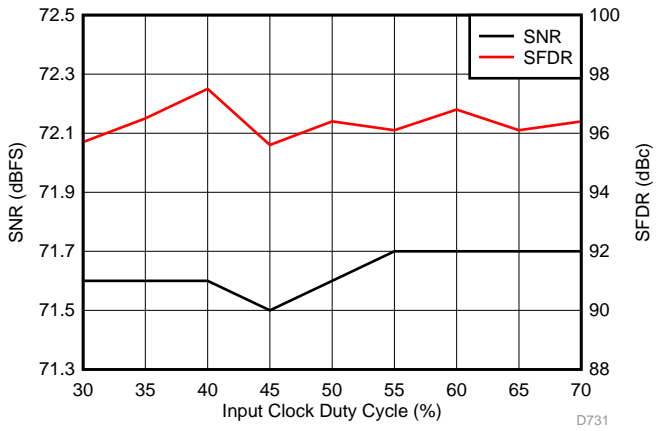


Figure 130. Performance vs Clock Duty Cycle (40 MHz)

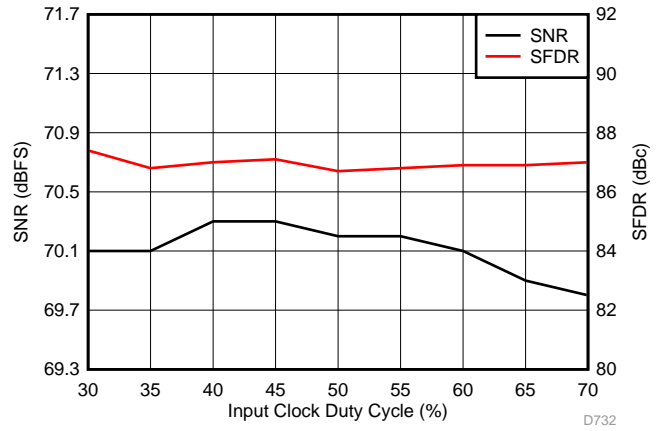


Figure 131. Performance vs Clock Duty Cycle (150 MHz)

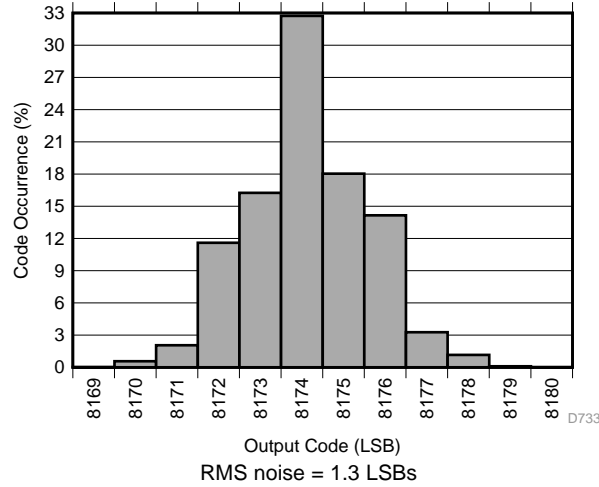
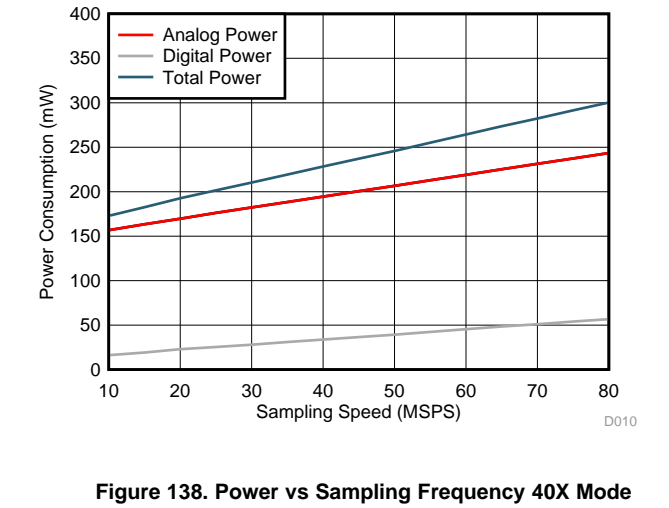
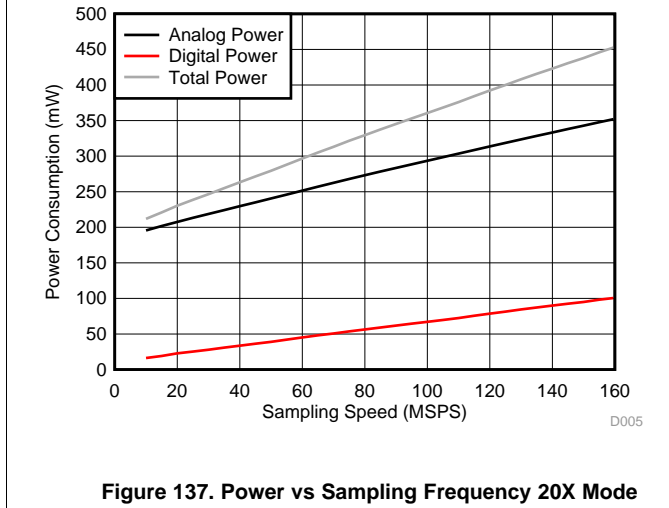
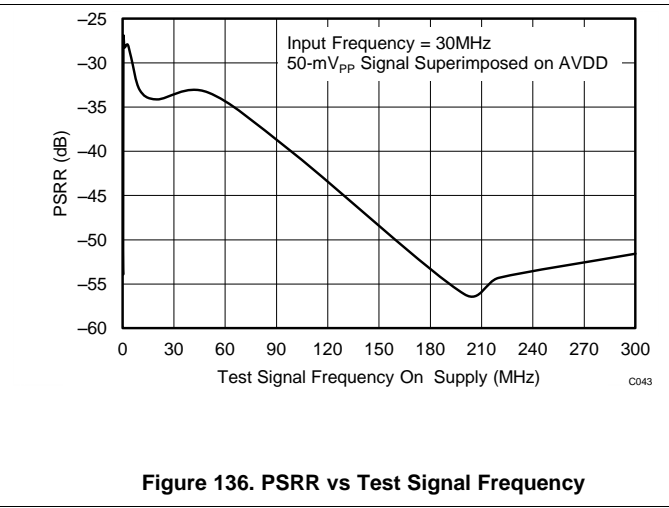
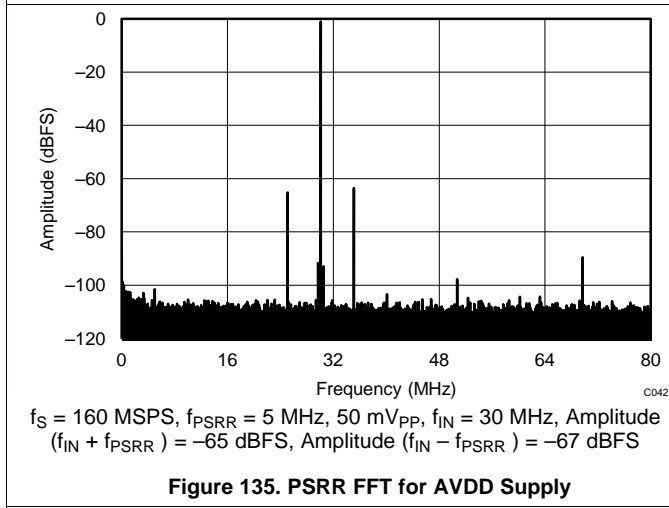
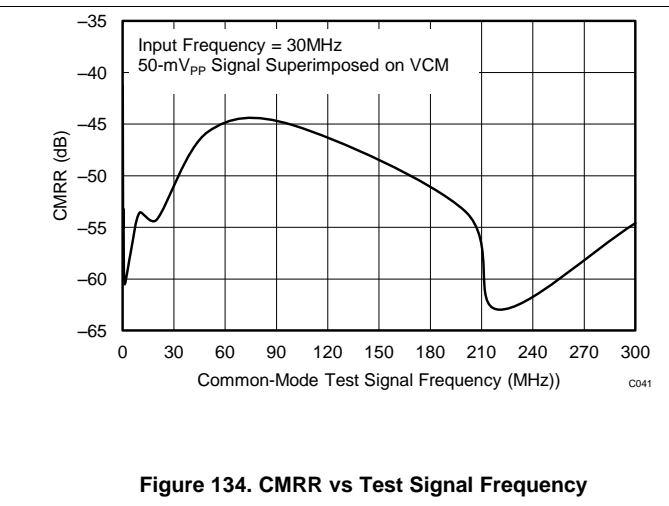
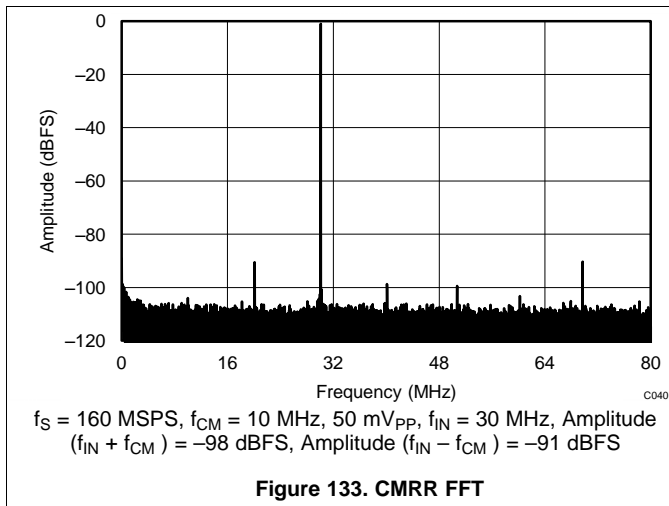


Figure 132. Idle Channel Histogram

7.18 Typical Characteristics: Common Plots

Typical values are at $T_A = 25^\circ\text{C}$, ADC sampling rate = 160 MSPS, 50% clock duty cycle, $AVDD = DVDD = 1.8\text{ V}$, -1 dBFS differential input, $2\text{-}V_{PP}$ full-scale, and 32k-point FFT, unless otherwise noted.



7.19 Typical Characteristics: Contour Plots

Typical values are at $T_A = 25^\circ\text{C}$, 50% clock duty cycle, $AV_{DD} = DV_{DD} = 1.8\text{ V}$, -1-dBFS differential input, 2-V_{PP} full-scale, and 32k-point FFT, unless otherwise noted.

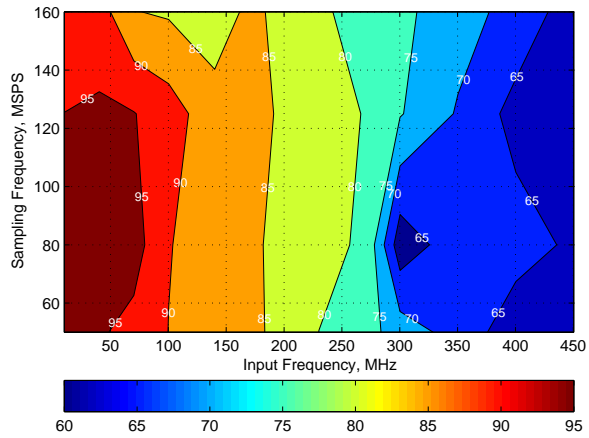


Figure 139. Spurious-Free Dynamic Range (SFDR) for 0-dB Gain

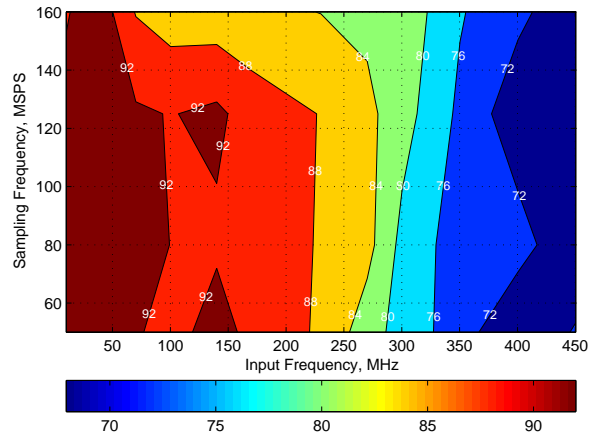


Figure 140. Spurious-Free Dynamic Range (SFDR) for 6-dB Gain

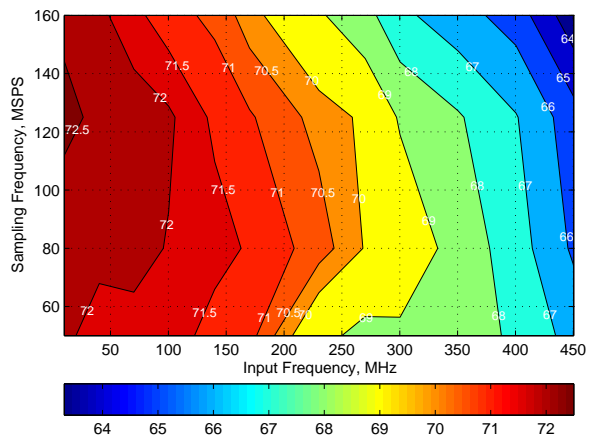


Figure 141. Signal-to-Noise Ratio (SNR) for 0-dB Gain

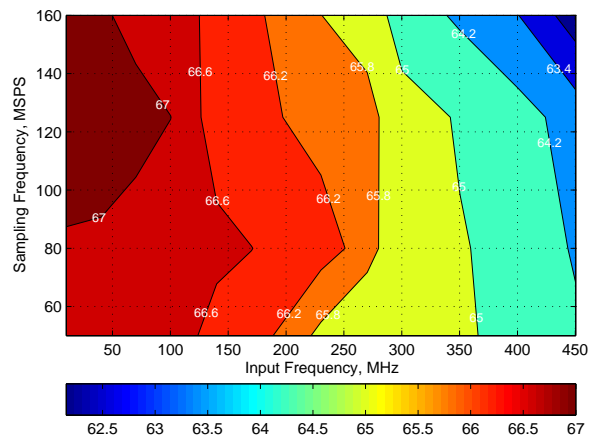
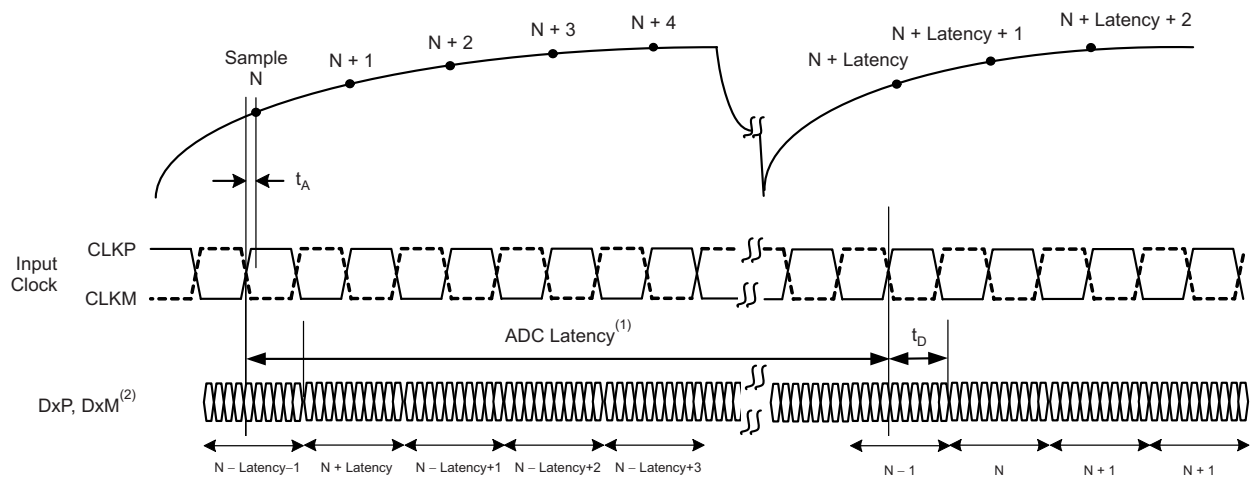


Figure 142. Signal-to-Noise Ratio (SNR) for 6-dB Gain

8 Parameter Measurement Information

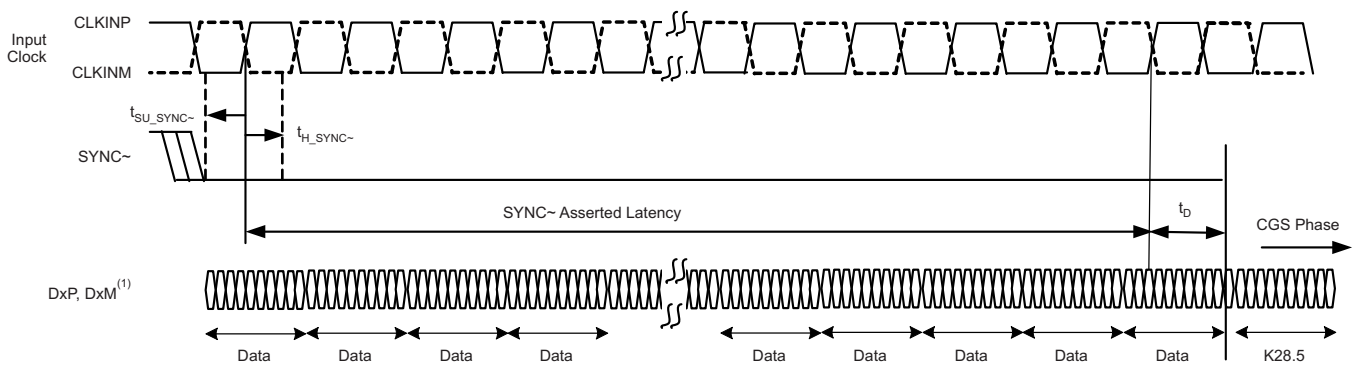
8.1 Timing Diagrams



(1) Overall latency = ADC latency + t_D .

(2) $x = A$ for channel A and B for channel B.

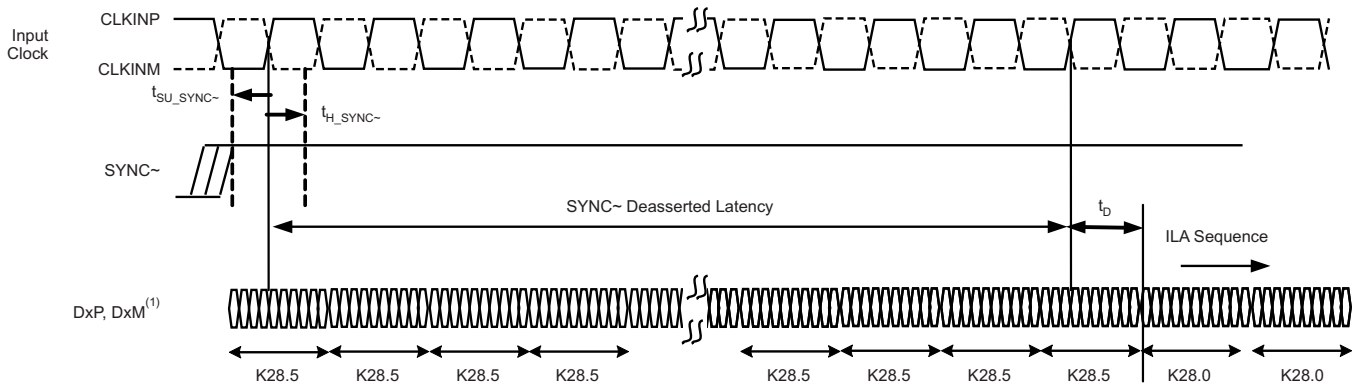
Figure 143. ADC Latency



(1) $x = A$ for channel A and B for channel B.

Figure 144. SYNC~ Latency in CGS Phase

Timing Diagrams (continued)



(1) x = A for channel A and B for channel B.

Figure 145. SYNC~ Latency in ILAS Phase

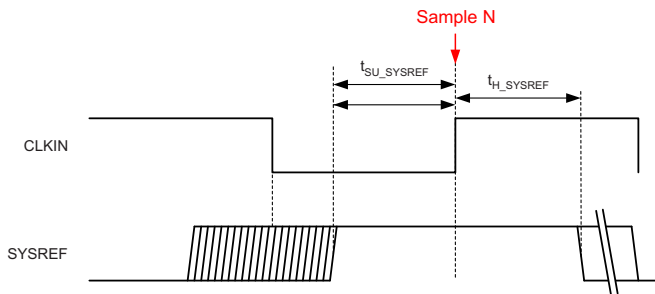


Figure 146. SYSREF Timing (Subclass 1)

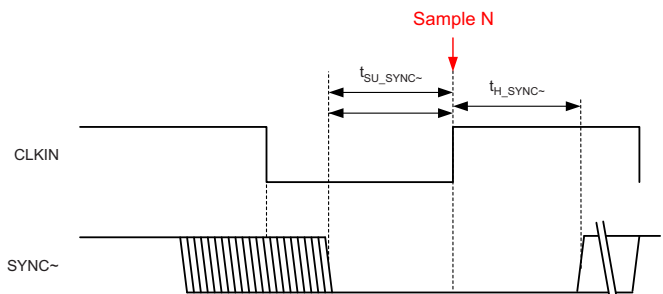


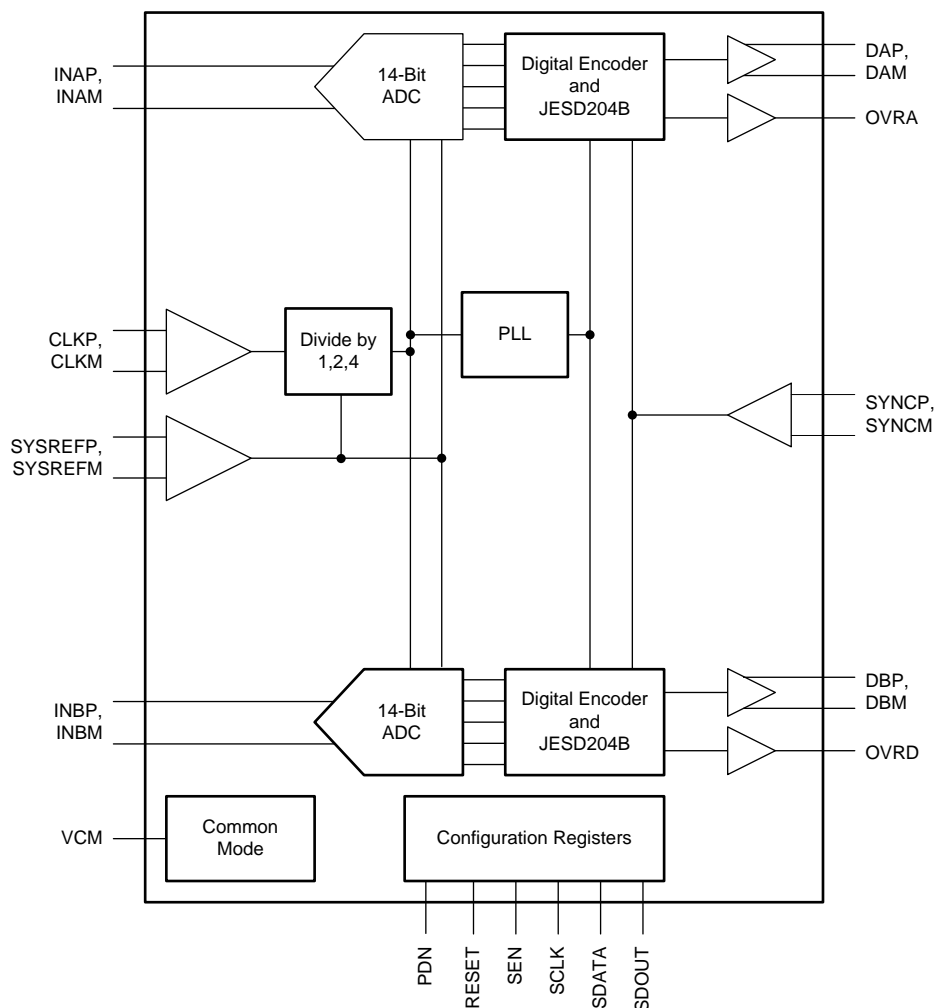
Figure 147. SYNC~ Timing (Subclass 2)

9 Detailed Description

9.1 Overview

The ADC32J4x are a high-linearity, ultra-low power, dual-channel, 14-bit, 50-MSPS to 160-MSPS, analog-to-digital converter (ADC) family. The devices are designed specifically to support demanding, high input frequency signals with large dynamic range requirements. A clock input divider allows more flexibility for system clock architecture design and the SYSREF input enables complete system synchronization. The ADC32J4x family supports JESD204B interface in order to reduce the number of interface lines, thus allowing for high system integration density. The JESD204B interface is a serial interface, where the data of each ADC are serialized and output over only one differential pair. An internal phase-locked loop (PLL) multiplies the incoming ADC sampling clock by 20 to derive the bit clock, which is used to serialize the 14-bit data from each channel. The ADC32J4x devices support subclass 0, 1, and 2 with interface data rates up to 3.2 Gbps.

9.2 Functional Block Diagram



9.3 Feature Description

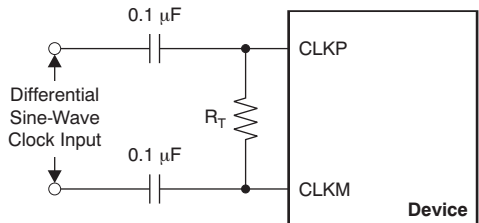
9.3.1 Analog Inputs

The ADC32J4x analog signal inputs are designed to be driven differentially. Each input pin (INP, INM) must swing symmetrically between $(V_{CM} + 0.5\text{ V})$ and $(V_{CM} - 0.5\text{ V})$, resulting in a $2 \cdot V_{PP}$ (default) differential input swing. The input sampling circuit has a 3-dB bandwidth that extends up to 450 MHz (50- Ω source driving a 50- Ω termination between INP and INM).

Feature Description (continued)

9.3.2 Clock Input

The device clock inputs can be driven differentially (sine, LVPECL, or LVDS) or single-ended (LVCMOS), with little or no difference in performance between them. The common-mode voltage of the clock inputs is set to 1.4 V using internal 5-kΩ resistors. The self-bias clock inputs of the ADC32J4x can be driven by the transformer-coupled, sine-wave clock source or by the ac-coupled, LVPECL and LVDS clock sources, as shown in Figure 148, Figure 149, and Figure 150. See Figure 151 for details regarding the internal clock buffer.



NOTE: R_T = termination resistor, if necessary.

Figure 148. Differential Sine-Wave Clock Driving Circuit

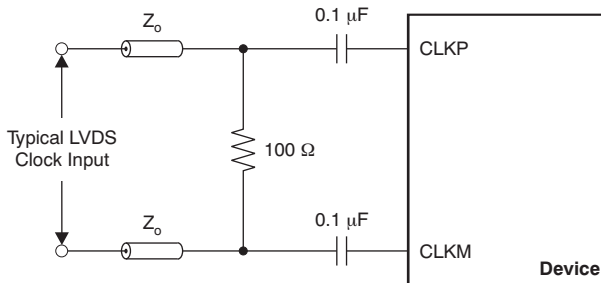


Figure 149. LVDS Clock Driving Circuit

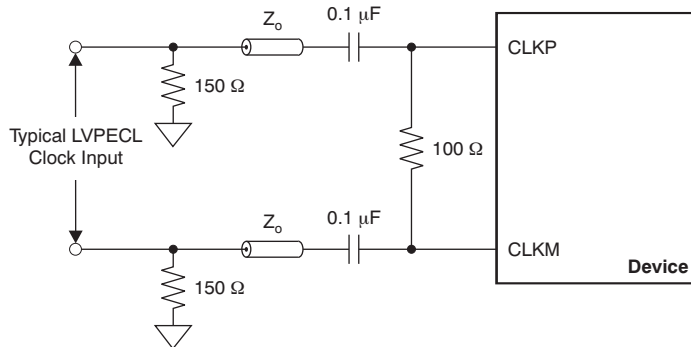
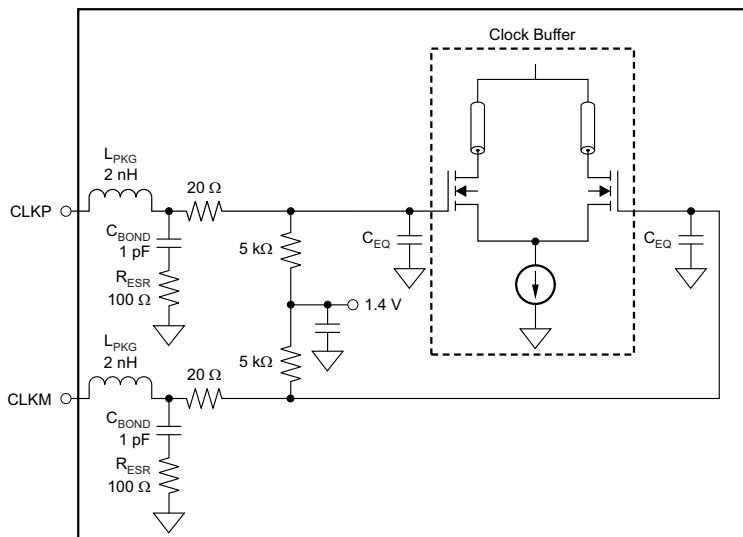


Figure 150. LVPECL Clock Driving Circuit



NOTE: C_{EQ} is 1 pF to 3 pF and is the equivalent input capacitance of the clock buffer.

Figure 151. Internal Clock Buffer

A single-ended CMOS clock can be ac-coupled to the CLKP input, with CLKM connected to ground with a 0.1-μF capacitor, as shown in Figure 152. However, the clock inputs must be driven differentially for best performance, thereby reducing susceptibility to common-mode noise. For high input frequency sampling, TI recommends using a clock source with very low jitter. Band-pass filtering of the clock source can help reduce the effects of jitter. There is no change in performance with a non-50% duty cycle clock input.

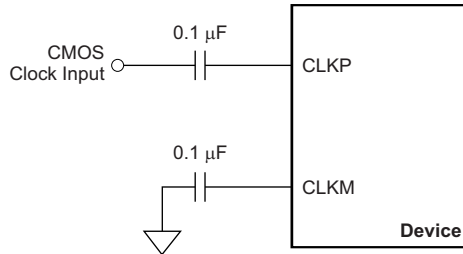


Figure 152. Single-Ended Clock Driving Circuit

9.3.2.1 SNR and Clock Jitter

The signal-to-noise ratio of the ADC is limited by three different factors: quantization noise, thermal noise, and jitter noise, as shown in Equation 1. Quantization noise is typically not noticeable in pipeline converters and is 86 dB for a 14-bit ADC. Thermal noise limits SNR at low input frequencies and the clock jitter sets SNR for higher input frequencies.

$$SNR_{ADC}[dBc] = -20 \cdot \log \sqrt{\left(10^{\frac{SNR_{Quantization\ Noise}}{20}}\right)^2 + \left(10^{\frac{SNR_{Thermal\ Noise}}{20}}\right)^2 + \left(10^{\frac{SNR_{Jitter}}{20}}\right)^2} \quad (1)$$

The SNR limitation resulting from sample clock jitter can be calculated with Equation 2:

$$SNR_{Jitter}[dBc] = -20 \cdot \log(2\pi \cdot f_{in} \cdot T_{Jitter}) \quad (2)$$

The total clock jitter (T_{Jitter}) has two components: the internal aperture jitter (200 fs for the device), is set by the noise of the clock input buffer, and the external clock. T_{Jitter} can be calculated with Equation 3:

$$T_{Jitter} = \sqrt{(T_{Jitter,Ext.Clock_Input})^2 + (T_{Aperture_ADC})^2} \quad (3)$$

External clock jitter can be minimized by using high-quality clock sources and jitter cleaners as well as band-pass filters at the clock input, although a faster clock slew rate improves ADC aperture jitter. The devices have a thermal noise of 73.5 dBFS and an internal aperture jitter of 200 fs. The SNR, depending on the amount of external jitter for different input frequencies, is shown in Figure 153.

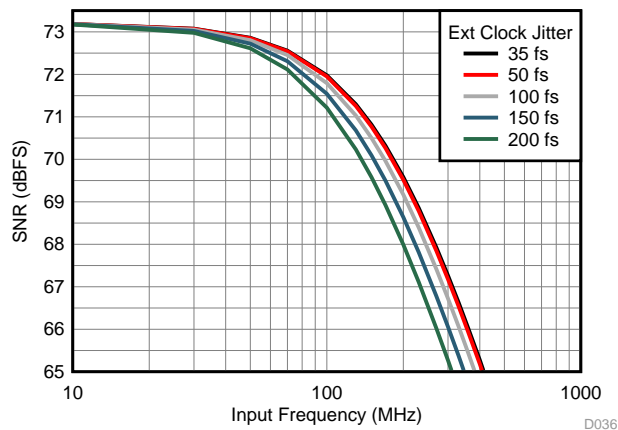


Figure 153. SNR vs Frequency and Jitter

9.3.2.2 Input Clock Divider

The devices are equipped with an internal divider on the clock input. The divider allows operation with a faster input clock, thus simplifying the system clock distribution design. The clock divider can be bypassed (divide-by-1) for operation with a 160-MHz clock; the divide-by-2 option supports a maximum input clock of 320 MHz and the divide-by-4 option supports a maximum input clock frequency of 640 MHz.

9.3.3 Power-Down Control

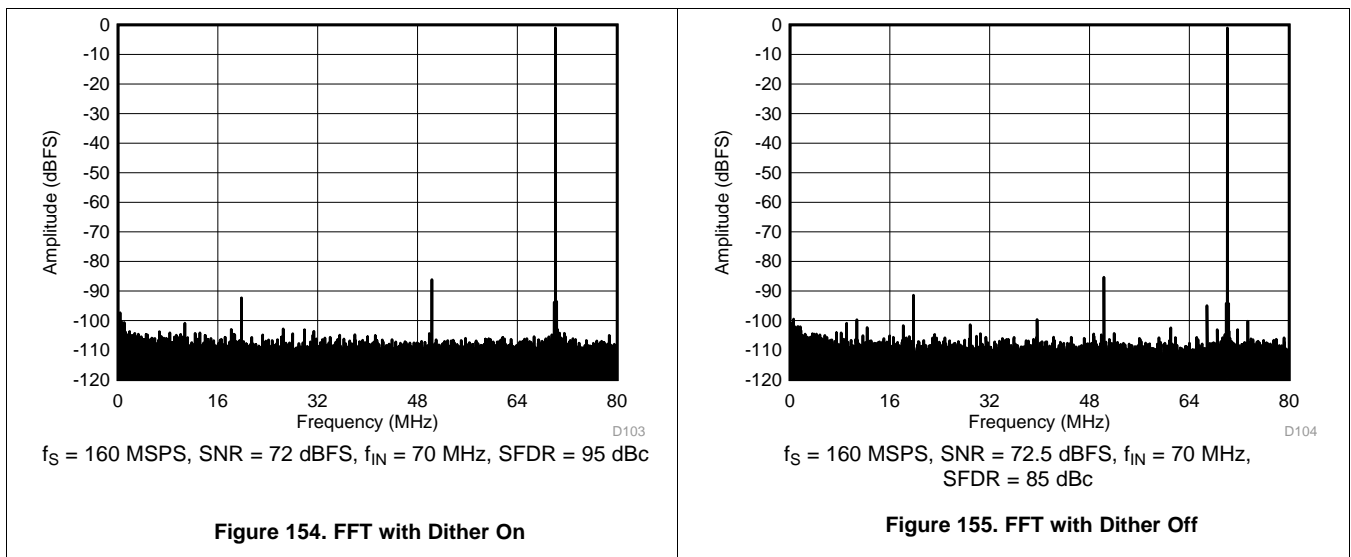
The power-down functions of the ADC32J4x can be controlled either through the parallel control pin (PDN) or through an SPI register setting (see [register 15h](#)). The PDN pin can also be configured via SPI to a global power-down or standby functionality, as shown in [Table 2](#).

Table 2. Power-Down Modes

| FUNCTION | POWER CONSUMPTION (mW) | WAKE-UP TIME (µs) |
|-------------------|------------------------|-------------------|
| Global power-down | 5 | 85 |
| Standby | 118 | 35 |

9.3.4 Internal Dither Algorithm

The ADC32J4x uses an internal dither algorithm to achieve high SFDR and a clean spectrum. However, the dither algorithm marginally degrades SNR, creating a trade-off between SNR and SFDR. If desired, the dither algorithm can be turned off by using the DIS DITH CHx registers bits. [Figure 154](#) and [Figure 155](#) show the effect of using dither algorithms.



9.3.5 JESD204B Interface

The ADC32J4x support device subclass 0, 1, and 2 with a maximum output data rate of 3.2 Gbps for each serial transmitter, as shown in [Figure 156](#). The data of each ADC are serialized by 20X using an internal PLL and then transmitted out on one differential pair each. An external SYSREF (subclass 1) or SYNC~ (subclass 2) signal is used to align all internal clock phases and the local multiframe clock to a specific sampling clock edge. This process allows synchronization of multiple devices in a system and minimizes timing and alignment uncertainty.

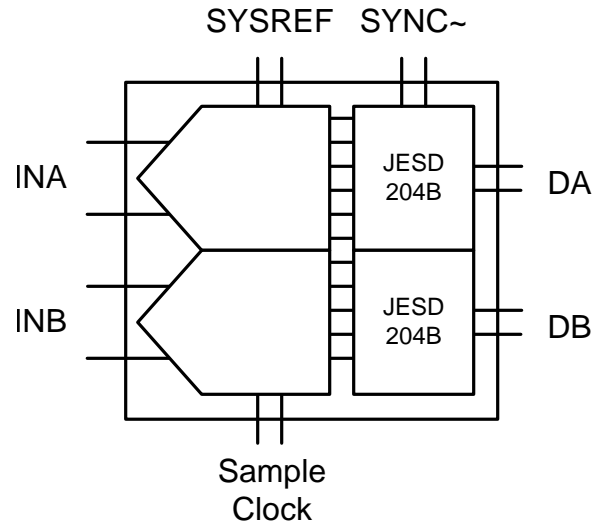


Figure 156. JESD204B Interface

The JESD204B transmitter block consists of the transport layer, the data scrambler, and the link layer, as shown in [Figure 157](#). The transport layer maps the ADC output data into the selected JESD204B frame data format and determines if the ADC output data or test patterns are transmitted. The link layer performs the 8b or 10b data encoding and the synchronization and initial lane alignment using the SYNC~ input signal. Optionally, data from the transport layer can be scrambled.

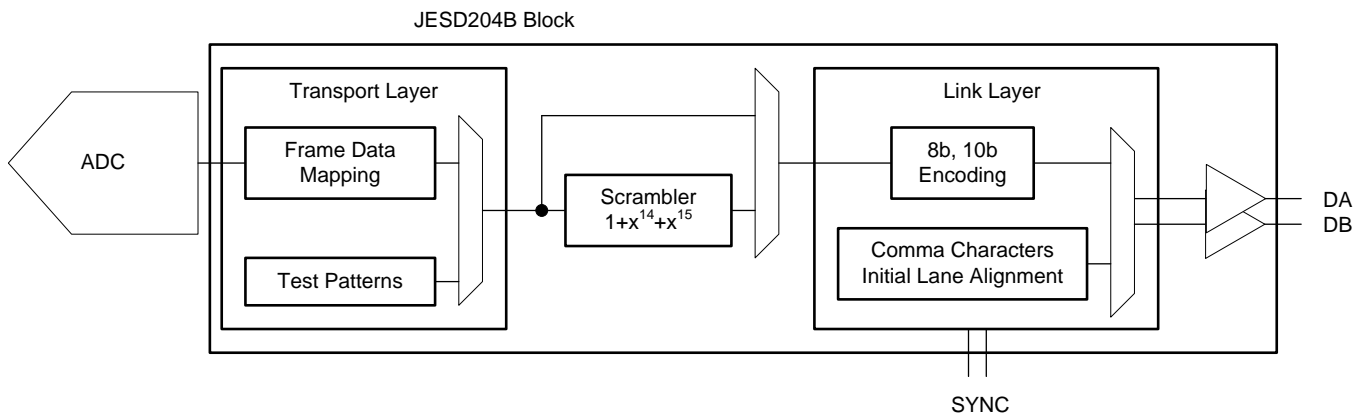


Figure 157. JESD204B Block

9.3.5.1 JESD204B Initial Lane Alignment (ILA)

The initial lane alignment process is started by the receiving device by asserting the SYNC~ signal. When a logic high is detected on the SYNC~ input pins, the ADC32J4x starts transmitting comma (K28.5) characters to establish code group synchronization. When synchronization is complete, the receiving device de-asserts the SYNC~ signal and the ADC32J4x starts the initial lane alignment sequence with the next local multiframe clock boundary. The ADC32J4x transmits four multiframes, each containing K frames (K is SPI programmable). Each multiframe contains the frame start and end symbols; the second multiframe also contains the JESD204 link configuration data.

9.3.5.2 JESD204B Test Patterns

There are three different test patterns available in the transport layer of the JESD204B interface. The ADC32J4x supports a clock output, an encoded, and a PRBS (2¹⁵ – 1) pattern. These patterns can be enabled via SPI register writes and are located in address 26h (bits 7-6).

9.3.5.3 JESD204B Frame Assembly

The JESD204B standard defines the following parameters:

- L is the number of lanes per link,
- M is the number of converters per device,
- F is the number of octets per frame clock period, and
- S is the number of samples per frame.

Table 3 lists the available JESD204B format and valid range for the ADC32J4x. The ranges are limited by the SERDES line rate and the maximum ADC sample frequency.

Table 3. LMFS Values and Interface Rate

| L | M | F | S | MINIMUM ADC SAMPLING RATE (MSPS) | MAXIMUM f _{SERDES} (Mbps) | MAXIMUM ADC SAMPLING RATE (Msps) | MAXIMUM f _{SERDES} (GSPS) | MODE |
|---|---|---|---|----------------------------------|------------------------------------|----------------------------------|------------------------------------|---------------|
| 2 | 2 | 2 | 1 | 15 | 300 | 160 | 3.2 | 20X (default) |
| 1 | 2 | 4 | 1 | 10 | 400 | 80 | 3.2 | 40X |

The detailed frame assembly for quad-channel mode is shown in Figure 158. The frame assembly configuration can be changed from 20X (default) to 40X by setting the registers listed in Table 4.

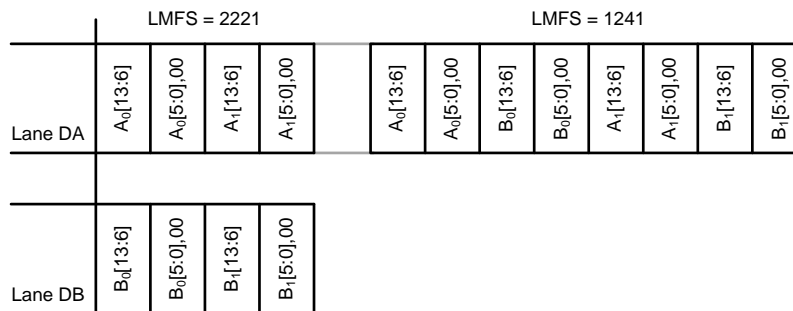


Figure 158. JESD Frame Assembly

Table 4. Configuring 40X Mode

| ADDRESS | DATA |
|---------|------|
| 2Bh | 01h |
| 30h | 11h |

9.3.5.4 Digital Outputs

The ADC32J4x JESD204B transmitter uses differential CML output drivers. The CML output current is programmable from 5 mA to 20 mA using SPI register settings. The output driver expects to drive a differential 100-Ω load impedance and the termination resistors must be placed as close to the receiver inputs as possible to avoid unwanted reflections and signal distortion. Because the JESD204B employs 8b and 10b encoding, the output data stream is dc-balanced and ac-coupling can be used to avoid the need to match up common-mode voltages between the transmitter and receivers. Connect the termination resistors to the termination voltage, as shown in Figure 159.

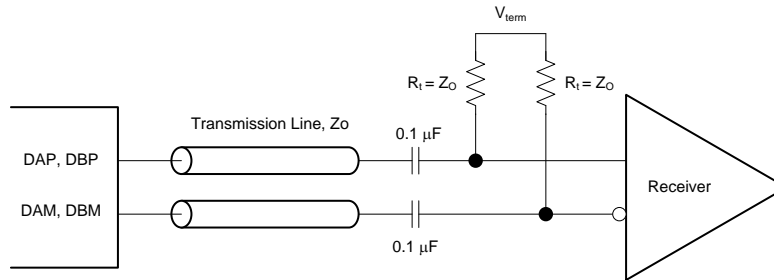
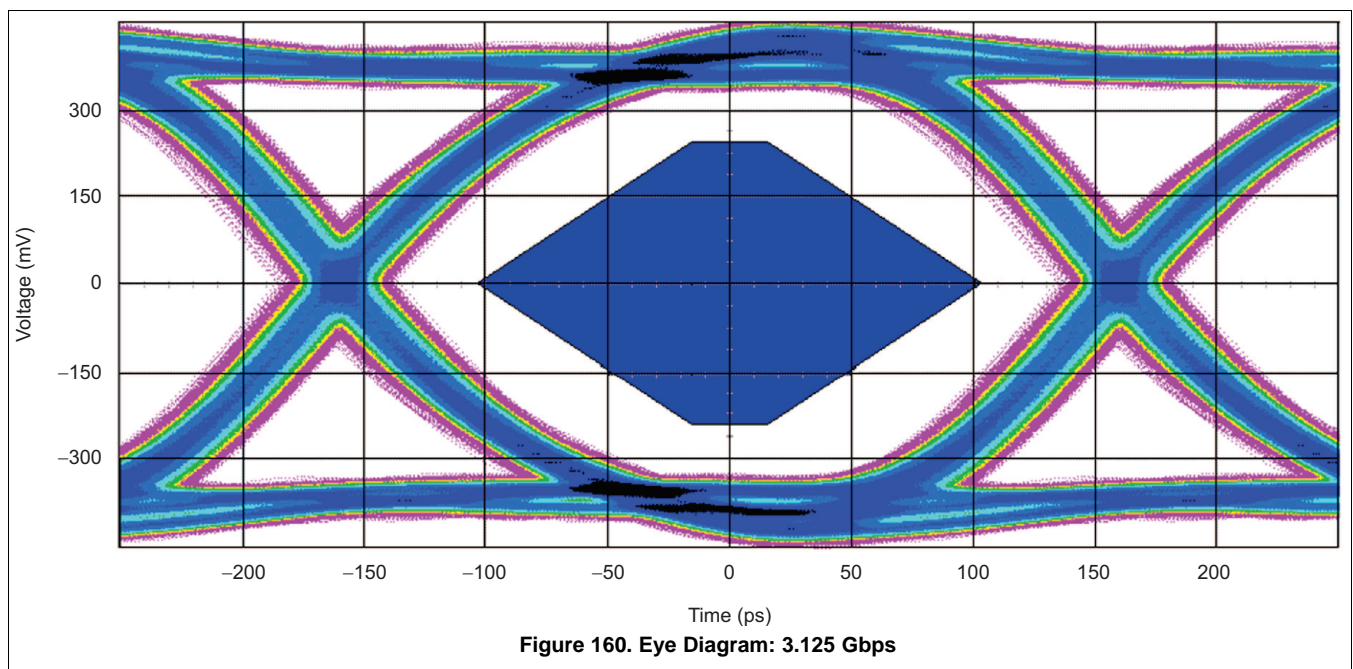


Figure 159. CML Output Connections

Figure 160 shows the data eye measurements of the device JESD204B transmitter against the JESD204B transmitter mask at 3.125 Gbps (156.25 MSPS, 20X mode), respectively.



9.4 Device Functional Modes

9.4.1 Digital Gain

The input full-scale amplitude can be selected between 1 V_{PP} to 2 V_{PP} (default is 2 V_{PP}) by choosing the appropriate digital gain setting via an SPI register write. Digital gain provides an option to trade-off SNR for SFDR performance. A larger input full-scale increases SNR performance (2 V_{PP} is recommended for maximum SNR) and a reduced input swing typically results in better SFDR performance. [Table 5](#) lists the available digital gain settings.

Table 5. Digital Gain versus Full-Scale Amplitude

| DIGITAL GAIN (dB) | MAX INPUT VOLTAGE (V_{PP}) |
|-------------------|--------------------------------|
| 0 | 2 |
| 0.5 | 1.89 |
| 1 | 1.78 |
| 1.5 | 1.68 |
| 2 | 1.59 |
| 2.5 | 1.50 |
| 3 | 1.42 |
| 3.5 | 1.34 |
| 4 | 1.26 |
| 4.5 | 1.19 |
| 5 | 1.12 |
| 5.5 | 1.06 |
| 6 | 1.00 |

9.4.2 Overrange Indication

The ADC32J4x provides two different overrange indications. The normal OVR (default) is triggered if the final 14-bit data output exceeds the maximum code value. The fast OVR is triggered if the input voltage exceeds the programmable overrange threshold and is presented after just nine clock cycles, thus enabling a quicker reaction to an overrange event. By default, the normal overrange indication is output on the OVRA, OVRB pins. The fast OVR indication can be presented on the overrange pins instead by using the SPI register map.

9.5 Programming

The ADC32J4x can be configured using a serial programming interface, as described in this section.

9.5.1 Serial Interface

The device has a set of internal registers that can be accessed by the serial interface formed by the SEN (serial interface enable), SCLK (serial interface clock), SDATA (serial interface data), and SDOUT (serial interface data output) pins. Serially shifting bits into the device is enabled when SEN is low. Serial data SDATA are latched at every SCLK rising edge when SEN is active (low). Serial data are loaded into the register at every 24th SCLK rising edge when SEN is low. When the word length exceeds a multiple of 24 bits, the excess bits are ignored. Data can be loaded in multiples of 24-bit words within a single active SEN pulse. The interface can function with SCLK frequencies from 20 MHz down to very low speeds (of a few hertz) and also with a non-50% SCLK duty cycle.

9.5.1.1 Register Initialization

After power-up, the internal registers must be initialized to their default values through a hardware reset by applying a high pulse on the RESET pin (of durations greater than 10 ns); see [Figure 161](#). If required, the serial interface registers can be cleared during operation either:

1. Through a hardware reset, or
2. By applying a software reset. When using the serial interface, set the RESET bit (D0 in register address 06h) high. This setting initializes the internal registers to the default values and then self-resets the RESET bit low. In this case, the RESET pin is kept low.

9.5.1.1.1 Serial Register Write

The device internal register can be programmed with these steps:

1. Drive the SEN pin low,
2. Set the R/W bit to 0 (bit A15 of the 16-bit address),
3. Set bit A14 in the address field to 1,
4. Initiate a serial interface cycle by specifying the address of the register (A13 to A0) whose content must be written, and
5. Write the 8-bit data that are latched in on the SCLK rising edge.

Programming (continued)

Figure 161 and Table 6 show the timing requirements for the serial register write operation.

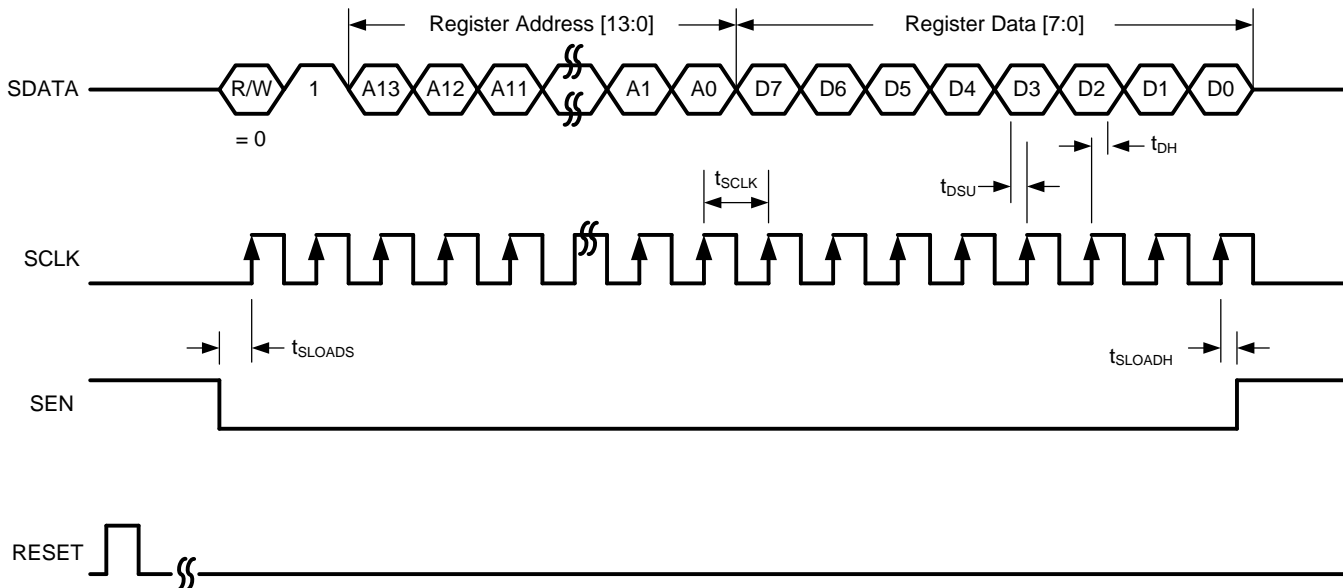


Figure 161. Serial Register Write Timing Diagram

Table 6. Serial Interface Timing⁽¹⁾

| | | MIN | TYP | MAX | UNIT |
|--------------------|--|------|-----|-----|------|
| f _{SCLK} | SCLK frequency (equal to 1 / t _{SCLK}) | > dc | | 20 | MHz |
| t _{LOADS} | SEN to SCLK setup time | 25 | | | ns |
| t _{LOADH} | SCLK to SEN hold time | 25 | | | ns |
| t _{DSU} | SDIO setup time | 25 | | | ns |
| t _{DH} | SDIO hold time | 25 | | | ns |

(1) Typical values are at 25°C, full temperature range is from T_{MIN} = -40°C to T_{MAX} = 85°C, and AVDD = DVDD = 1.8 V, unless otherwise noted.

9.5.1.1.2 Serial Register Readout

The device includes a mode where the contents of the internal registers can be read back using the SDOUT pin. This readback mode can be useful as a diagnostic check to verify the serial interface communication between the external controller and the ADC. To read the contents of serial registers, follow this procedure:

1. Drive the SEN pin low.
2. Set the R/W bit (A15) to 1. This setting disables any further writes to the registers.
3. Set bit A14 in the address field to 1.
4. Initiate a serial interface cycle specifying the address of the register (A13 to A0) whose content must be read.
5. The device outputs the contents (D7 to D0) of the selected register on the SDOUT pin.
6. The external controller can latch the contents at the SCLK rising edge.
7. To enable register writes, reset the R/W register bit to 0.

When READOUT is disabled, the SDOUT pin is in a high-impedance mode. If serial readout is not used, the SDOUT pin must float. [Figure 162](#) shows a timing diagram of the serial register read operation. Data appear on the SDOUT pin at the SCLK falling edge with an approximate delay (t_{SD_DELAY}) of 20 ns, as shown in [Figure 163](#).

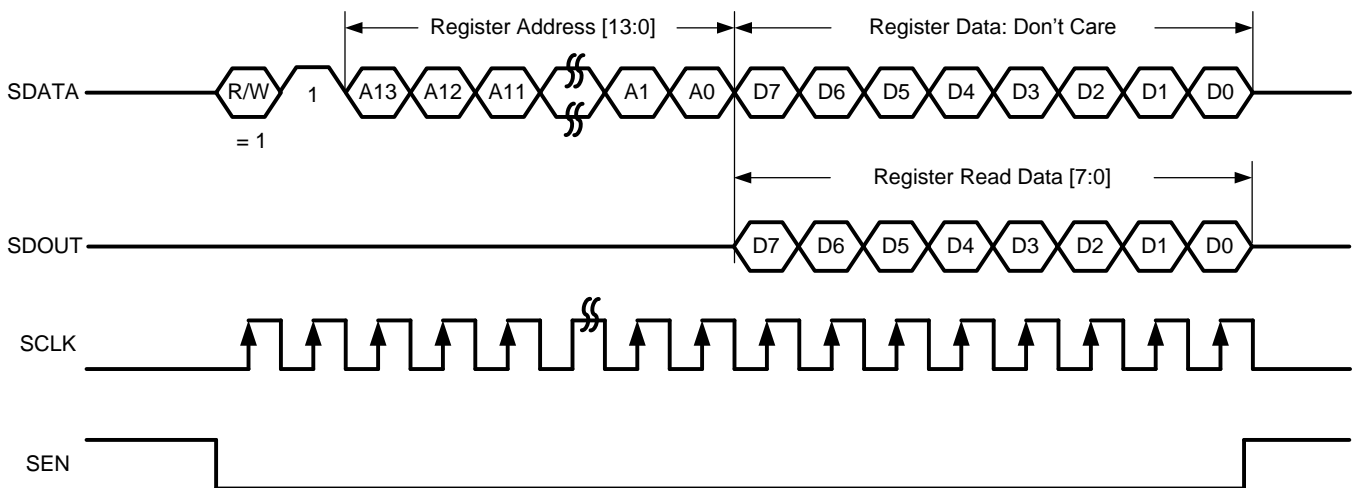


Figure 162. Serial Register Read Timing Diagram

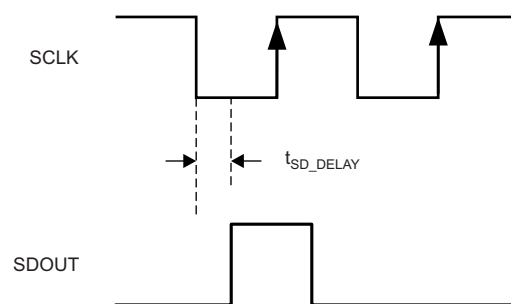


Figure 163. SDOUT Timing Diagram

9.5.2 Register Initialization

After power-up, the internal registers must be initialized to their default values through a hardware reset by applying a high pulse on the RESET pin, as shown in Figure 164 and Table 7.

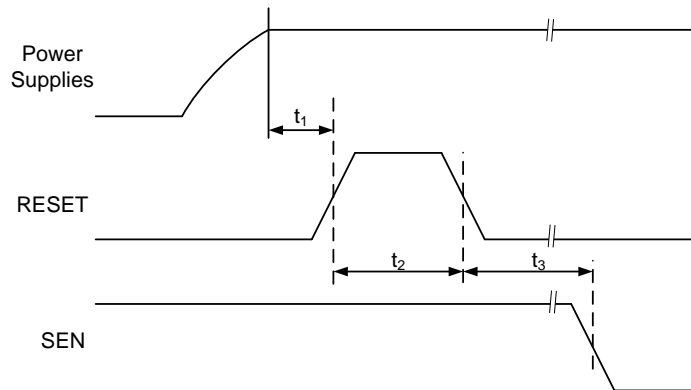


Figure 164. Initialization of Serial Registers after Power-Up

Table 7. Power-Up Timing

| | | MIN | TYP | MAX | UNIT |
|----------------|--|-----|-----|------|------|
| t ₁ | Power-on delay from power-up to an active high RESET pulse | 1 | | | ms |
| t ₂ | Reset pulse duration: active high RESET pulse duration | 10 | | 1000 | ns |
| t ₃ | Register write delay from RESET disable to SEN active | 100 | | | ns |

If required, the serial interface registers can be cleared during operation either:

1. Through hardware reset, or
2. By applying a software reset. When using the serial interface, set the RESET bit (D0 in register address 06h) high. This setting initializes the internal registers to the default values and then self-resets the RESET bit low. In this case, the RESET pin is kept low.

9.5.3 Start-Up Sequence

After power-up, the sequence described in Table 8 can be used to set up the ADC32J4x for basic operation.

Table 8. Start-Up Settings

| STEP | DESCRIPTION | REGISTER ADDRESS AND DATA |
|------|--|--|
| 1 | Provide all supply voltages. There is no required power-supply sequence for AVDD and DVDD. | — |
| 2 | Pulse a hardware reset (low to high to low) on pin 24 | — |
| 3 | Optionally, configure LMFS of the JESD204B interface to LMFS = 1241 (default is LMFS = 2221) | Address 2Bh, data 01h Address 30h, data 11h |
| 4 | Pulse SYNC~ from high to low to transmit data from K28.5 SYNC~ mode | — |

9.6 Register Maps

Table 9. Register Map Summary

| REGISTER ADDRESS | REGISTER DATA | | | | | | | |
|------------------|------------------------------|-----------------|----------------|-----------------------|--------------------|-----------------|--------------------|--------------------|
| A[13:0] (Hex) | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 01 | 0 | 0 | DIS DITHER CHA | | DIS DITHER CHB | | 0 | 0 |
| 03 | 0 | 0 | 0 | 0 | 0 | 0 | CHA GAINEN | 0 |
| 04 | 0 | 0 | 0 | 0 | 0 | 0 | CHB GAINEN | 0 |
| 06 | 0 | 0 | 0 | 0 | 0 | 0 | TEST PATTERN EN | RESET |
| 07 | 0 | 0 | 0 | SPECIAL MODE1 CHA | | | EN FOVR | 0 |
| 08 | 0 | 0 | 0 | SPECIAL MODE1 CHB | | | 0 | 0 |
| 09 | 0 | 0 | 0 | 0 | 0 | 0 | ALIGN TEST PATTERN | DATA FORMAT |
| 0A | 0 | 0 | 0 | 0 | CHA TEST PATTERN | | | |
| 0B | CHB TEST PATTERN | | | | 0 | 0 | 0 | 0 |
| 0C | 0 | 0 | 0 | 0 | CHA DIGITAL GAIN | | | |
| 0D | CHB DIGITAL GAIN | | | | 0 | 0 | 0 | 0 |
| 0E | CUSTOM PATTERN[13:6] | | | | | | | |
| 0F | CUSTOM PATTERN[5:0] | | | | | 0 | 0 | 0 |
| 13 | LOW SPEED MODE | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 15 | 0 | CHA PDN | CHB PDN | 0 | STANDBY | GLOBAL PDN | 0 | CONFIG PDN PIN |
| 27 | CLK DIV | | 0 | 0 | 0 | 0 | 0 | 0 |
| 2A | SERDES TEST PATTERN | | IDLE SYNC | TRP LAYER TESTMODE EN | FLIP ADC DATA | LANE ALIGN | FRAME ALIGN | TXMIT LINKDATA DIS |
| 2B | 0 | 0 | 0 | 0 | 0 | 0 | CTRL K | CTRL F |
| 2F | SCRAMBLE EN | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 30 | OCTETS PER FRAME | | | | | | | |
| 31 | 0 | 0 | 0 | FRAMES PER MULTIFRAME | | | | |
| 34 | SUBCLASSV | | | 0 | 0 | 0 | 0 | 0 |
| 3A | SYNC REG | SYNC REQ EN | 0 | 0 | OUTPUT CURRENT SEL | | | |
| 3B | LINK LAYER TESTMODE SEL[2:0] | | | LINK LAYER RPAT | 0 | PULSE DET MODES | | |
| 3C | FORCE LMFC COUNT | LMFC COUNT INIT | | | | | RELEASE ILANE SEQ | |
| 422 | 0 | 0 | 0 | 0 | 0 | 0 | SPECIAL MODE2 CHA | 0 |
| 434 | 0 | 0 | DIS DITH CHA | 0 | DIS DITH CHA | 0 | 0 | 0 |
| 522 | 0 | 0 | 0 | 0 | 0 | 0 | SPECIAL MODE2 CHB | 0 |
| 534 | 0 | 0 | DIS DITH CHB | 0 | DIS DITH CHB | 0 | 0 | 0 |

9.6.1 Summary of Special Mode Registers

Table 10 lists the location, value, and functions of special mode registers in the device.

Table 10. Special Modes Summary

| | MODE | LOCATION | VALUE AND FUNCTION |
|----------------|--------------------|----------------------------------|--|
| Dither mode | DIS DITH CHA | 01h (bits 5-4), 434h (bits 5, 3) | Creates a noise floor cleaner and improves SFDR; see the Internal Dither Algorithm section. 0000 = Dither disabled 1111 = Dither enabled |
| | DIS DITH CHB | 01h (bits 3-2), 534h (bits 5, 3) | |
| Special mode 1 | SPECIAL MODE 1 CHA | 07h (bits 4-2) | Use for improved HD3. 000 = Default after reset 010 = Use for frequency < 120 MHz 111 = Use for frequency > 120 MHz |
| | SPECIAL MODE 1 CHB | 08h (bits 4-2) | |
| Special mode 2 | SPECIAL MODE 2 CHA | 422h (bits 1-0) | Helps improve HD2. 00 = Default after reset 11 = Improves HD2 |
| | SPECIAL MODE 2 CHB | 522h (bits 1-0) | |

9.6.2 Serial Register Descriptions

9.6.2.1 Register 01h (address = 01h)

Figure 165. Register 01h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|----------------|---|----------------|---|------|------|
| 0 | 0 | DIS DITHER CHA | | DIS DITHER CHB | | 0 | 0 |
| W-0h | W-0h | R/W-0h | | R/W-0h | | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 11. Register 01h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|---|
| 7-6 | 0 | W | 0h | Must write 0. |
| 5-4 | DIS DITHER CHA | R/W | 0h | These bits enable or disable the on-chip dither. Control these bits with bits 5 and 3 of register 434h. 00 = Dither enabled 11 = Dither disabled. Improves SNR by 0.4 dB for input frequencies up to 170 MHz. |
| 3-2 | DIS DITHER CHB | R/W | 0h | These bits enable or disable the on-chip dither. Control these bits with bits 5 and 3 of register 534h. 00 = Dither enabled 11 = Dither disabled. Improves SNR by 0.4 dB for input frequencies up to 170 MHz. |
| 1-0 | 0 | W | 0h | Must write 0. |

9.6.2.2 Register 03h (address = 03h)
Figure 166. Register 03h

| | | | | | | | |
|------|------|------|------|------|------|------------|------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | 0 | 0 | 0 | 0 | CHA GAINEN | 0 |
| W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | R/W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 12. Register 03h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------|------|-------|---|
| 7-2 | 0 | W | 0h | Must write 0. |
| 1 | CHA GAINEN | R/W | 0h | Digital gain enable bit for channel A. 0 = Digital gain disabled 1 = Digital gain enabled |
| 0 | 0 | W | 0h | Must write 0. |

9.6.2.3 Register 04h (address = 04h)
Figure 167. Register 04h

| | | | | | | | |
|------|------|------|------|------|------|------------|------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | 0 | 0 | 0 | 0 | CHB GAINEN | 0 |
| W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | R/W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 13. Register 04h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------|------|-------|---|
| 7-2 | 0 | W | 0h | Must write 0. |
| 1 | CHB GAINEN | R/W | 0h | Digital gain enable bit for channel B. 0 = Digital gain disabled 1 = Digital gain enabled |
| 0 | 0 | W | 0h | Must write 0. |

9.6.2.4 Register 06h (address = 06h)
Figure 168. Register 06h

| | | | | | | | |
|------|------|------|------|------|------|-----------------|--------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | 0 | 0 | 0 | 0 | TEST PATTERN EN | RESET |
| W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after reset

Table 14. Register 06h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------------|------|-------|---|
| 7-2 | 0 | W | 0h | Must write 0. |
| 1 | TEST PATTERN EN | R/W | 0h | This bit enables the test pattern selection for the digital outputs. 0 = Normal operation 1 = Test pattern output enabled |
| 0 | RESET | R/W | 0h | Software reset applied. This bit resets all internal registers to the default values and self-clears to 0. |

9.6.2.5 Register 07h (address = 07h)
Figure 169. Register 07h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|------|-------------------|---|---|---------|------|
| 0 | 0 | 0 | SPECIAL MODE1 CHA | | | EN FOVR | 0 |
| W-0h | W-0h | W-0h | R/W-0h | | | R/W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 15. Register 07h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------------|------|-------|--|
| 7-5 | 0 | W | 0h | Must write 0. |
| 4-2 | SPECIAL MODE1 CHA | R/W | 0h | 010 = For frequencies < 120 MHz 111 = For frequencies > 120 MHz |
| 1 | EN FOVR | R/W | 0h | 0 = Normal OVR on OVRx pins 1 = Enable fast OVR on OVRx pins |
| 0 | 0 | W | 0h | Must write 0. |

9.6.2.6 Register 08h (address = 08h)
Figure 170. Register 08h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|------|-------------------|---|---|------|------|
| 0 | 0 | 0 | SPECIAL MODE1 CHB | | | 0 | 0 |
| W-0h | W-0h | W-0h | R/W-0h | | | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 16. Register 08h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------------|------|-------|--|
| 7-5 | 0 | W | 0h | Must write 0. |
| 4-2 | SPECIAL MODE1 CHB | R/W | 0h | 010 = For frequencies < 120 MHz 111 = For frequencies > 120 MHz |
| 1-0 | 0 | W | 0h | Must write 0. |

9.6.2.7 Register 09h (address = 09h)
Figure 171. Register 09h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|------|------|------|------|--------------------|-------------|
| 0 | 0 | 0 | 0 | 0 | 0 | ALIGN TEST PATTERN | DATA FORMAT |
| W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 17. Register 09h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------------|------|-------|---|
| 7-2 | 0 | W | 0h | Must write 0. |
| 1 | ALIGN TEST PATTERN | R/W | 0h | This bit aligns test patterns across the outputs of the four channels. 0 = Test patterns of four channels are free-running 1 = Test patterns of all four channels are aligned |
| 0 | DATA FORMAT | R/W | 0h | This bit sets the digital output data format. 0 = Twos complement 1 = Offset binary |

9.6.2.8 Register 0Ah (address = 0Ah)
Figure 172. Register 0Ah

| | | | | | | | |
|------|------|------|------|------------------|---|---|---|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | 0 | 0 | CHA TEST PATTERN | | | |
| W-0h | W-0h | W-0h | W-0h | R/W-0h | | | |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 18. Register 0Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------------|------|-------|---|
| 7-4 | 0 | W | 0h | Must write 0. |
| 3-0 | CHA TEST PATTERN | R/W | 0h | These bits control the test pattern for channel A after the TEST PATTERN EN bit is set. 0000 = Normal operation 0001 = All 0's 0010 = All 1's 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101. 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 16383. 0101 = Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits. 0110 = Deskew pattern: data are 3AAAh. 1000 = PRBS pattern: data are a sequence of pseudo random numbers. 1001 = 8-point sine-wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: 0, 2399, 8192, 13984, 16383, 13984, 8192, and 2399. Others = Do not use |

9.6.2.9 Register 0Bh (address = 0Bh)
Figure 173. Register 0Bh

| | | | | | | | |
|------------------|---|---|---|------|------|------|------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| CHB TEST PATTERN | | | | 0 | 0 | 0 | 0 |
| R/W-0h | | | | W-0h | W-0h | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 19. Register 0Bh Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------------|------|-------|---|
| 7-4 | CHB TEST PATTERN | R/W | 0h | These bits control the test pattern for channel B after the TEST PATTERN EN bit is set. 0000 = Normal operation 0001 = All 0's 0010 = All 1's 0011 = Toggle pattern: data alternate between 101010101010 and 010101010101. 0100 = Digital ramp: data increment by 1 LSB every clock cycle from code 0 to 16383. 0101 = Custom pattern: output data are the same as programmed by the CUSTOM PATTERN register bits. 0110 = Deskew pattern: data are 3AAAh. 1000 = PRBS pattern: data are a sequence of pseudo random numbers. 1001 = 8-point sine-wave: data are a repetitive sequence of the following eight numbers that form a sine-wave: 0, 2399, 8192, 13984, 16383, 13984, 8192, and 2399. Others = Do not use |
| 3-0 | 0 | W | 0h | Must write 0. |

9.6.2.10 Register 0Ch (address = 0Ch)
Figure 174. Register 0Ch

| | | | | | | | |
|------|------|------|------|------------------|---|---|---|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | 0 | 0 | CHA DIGITAL GAIN | | | |
| W-0h | W-0h | W-0h | W-0h | R/W-0h | | | |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 20. Register 0Ch Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------------|------|-------|---|
| 7-4 | 0 | W | 0h | Must write 0. |
| 3-0 | CHA DIGITAL GAIN | R/W | 0h | These bits set the digital gain for individual channels. Register settings are listed in Table 21 . |

Table 21. Channel Digital Gain

| REGISTER VALUE | DIGITAL GAIN (dB) | MAXIMUM INPUT VOLTAGE (V _{PP}) |
|----------------|-------------------|--|
| 0000 | 0 | 2.0 |
| 0001 | 0.5 | 1.89 |
| 0010 | 1 | 1.78 |
| 0011 | 1.5 | 1.68 |
| 0100 | 2 | 1.59 |
| 0101 | 2.5 | 1.50 |
| 0110 | 3 | 1.42 |
| 0111 | 3.5 | 1.34 |
| 1000 | 4 | 1.26 |
| 1001 | 4.5 | 1.19 |
| 1010 | 5 | 1.12 |
| 1011 | 5.5 | 1.06 |
| 1100 | 6 | 1.00 |

9.6.2.11 Register 0Dh (address = 0Dh)
Figure 175. Register 0Dh

| | | | | | | | |
|------------------|---|---|---|------|------|------|------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| CHB DIGITAL GAIN | | | | 0 | 0 | 0 | 0 |
| R/W-0h | | | | W-0h | W-0h | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 22. Register 0Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------------|------|-------|---|
| 7-4 | CHB DIGITAL GAIN | R/W | 0h | These bits set the digital gain for the individual channels. Register settings are listed in Table 21 . |
| 3-0 | 0 | W | 0h | Must write 0. |

9.6.2.12 Register 0Eh (address = 0Eh)
Figure 176. Register 0Eh

| | | | | | | | |
|----------------------|---|---|---|---|---|---|---|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| CUSTOM PATTERN[13:6] | | | | | | | |
| R/W-0h | | | | | | | |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 23. Register 0Eh Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------------|------|-------|---|
| 7-0 | CUSTOM PATTERN[13:6] | R/W | 0h | These bits set the custom pattern[13:6] for all channels. |

9.6.2.13 Register 0Fh (address = 0Fh)
Figure 177. Register 0Fh

| | | | | | | | |
|---------------------|---|---|---|---|---|------|------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| CUSTOM PATTERN[5:0] | | | | | | 0 | 0 |
| R/W-0h | | | | | | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 24. Register 0Fh Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|---------------------|------|-------|--|
| 7-2 | CUSTOM PATTERN[5:0] | R/W | 0h | These bits set the custom pattern[5:0] for all channels. |
| 1-0 | 0 | W | 0h | Must write 0. |

9.6.2.14 Register 13h (address = 13h)
Figure 178. Register 13h

| | | | | | | | |
|----------------|------|------|------|------|------|------|------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| LOW SPEED MODE | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| R/W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 25. Register 13h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|---|
| 7 | LOW SPEED MODE | R/W | 0h | Use this bit for sampling frequencies < 25 MSPS. 0 = Normal operation 1 = Low-speed mode is enabled |
| 6-0 | 0 | W | 0h | Must write 0. |

9.6.2.15 Register 15h (address = 15h)
Figure 179. Register 15h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|---------|---------|------|---------|------------|------|-----------------|
| 0 | CHA PDN | CHB PDN | 0 | STANDBY | GLOBAL PDN | 0 | PDN PIN DISABLE |
| W-0h | R/W-0h | R/W-0h | W-0h | R/W-0h | R/W-0h | W-0h | R/W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 26. Register 15h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|----------------|------|-------|---|
| 7 | 0 | W | 0h | Must write 0. |
| 6 | CHA PDN | R/W | 0h | Power-down channel A. 0 = Normal operation 1 = Power-down channel A if the PDN PIN DISABLE register bit is set |
| 5 | CHB PDN | R/W | 0h | Power-down channel B. 0 = Normal operation 1 = Power-down channel B if the PDN PIN DISABLE register bit is set |
| 4 | 0 | W | 0h | Must write 0. |
| 3 | STANDBY | R/W | 0h | ADCs of both channels enter standby. 0 = Normal operation 1 = Standby |
| 2 | GLOBAL PDN | R/W | 0h | Global power-down. 0 = Normal operation 1 = Global power-down |
| 1 | 0 | W | 0h | Must write 0. |
| 0 | PDN PINDISABLE | R/W | 0h | This bit disables the power-down control from the pin. 0 = Normal operation 1 = Power-down pin is disabled; use register settings for power-down operations |

9.6.2.16 Register 27h (address = 27h)
Figure 180. Register 27h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------|------|------|------|------|------|------|------|
| CLK DIV | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| R/W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 27. Register 27h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|---------|------|-------|---|
| 7-6 | CLK DIV | R/W | 0h | Internal clock divider for the input sample clock. 00 = Clock divider bypassed 01 = Divide-by-1 10 = Divide-by-2 11 = Divide-by-4 |
| 5-0 | 0 | W | 0h | Must write 0. |

9.6.2.17 Register 2Ah (address = 2Ah)
Figure 181. Register 2Ah

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------------|-----------|-----------------------|---------------|------------|-------------|-------------------------|--------|
| SERDES TEST PATTERN | IDLE SYNC | TRP LAYER TESTMODE EN | FLIP ADC DATA | LANE ALIGN | FRAME ALIGN | TX LINK CONFIG DATA DIS | |
| R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; -n = value after

Table 28. Register 2Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------------------|------|-------|--|
| 7-6 | SERDES TEST PATTERN | R/W | 0h | 00 = Normal operation 01 = Outputs clock pattern: output is 10101010 10 = Encoded pattern: output is 1111111100000000 11 = PRBS sequence: output is $2^{15} - 1$ |
| 5 | IDLE SYNC | R/W | 0h | This bit sets the output pattern when SYNC~ is high. 0 = Sync code is K28.5 (BCBCh) 1 = Sync code is BC50h |
| 4 | TRP LAYER TESTMODE EN | R/W | 0h | This bit generates the long transport layer test pattern mode according to section 5.1.6.3 of the JESD204B specification. 0 = Test mode disabled 1 = Test mode enabled |
| 3 | FLIP ADC DATA | R/W | 0h | 0 = Normal operation 1 = Output data order is reversed: MSB – LSB |
| 2 | LANE ALIGN | R/W | 0h | This bit inserts a lane alignment character (K28.3) for the receiver to align to the lane boundary per section 5.3.3.5 of the JESD204B specification. 0 = Normal operation 1 = Inserts lane alignment characters |
| 1 | FRAME ALIGN | R/W | 0h | This bit inserts a frame alignment character (K28.7) for the receiver to align to the lane boundary per section 5.3.3.4 of the JESD204B specification. 0 = Normal operation 1 = Inserts frame alignment characters |
| 0 | TX LINK CONFIG DATA DIS | R/W | 0h | This bit disables sending the initial link alignment (ILA) sequence when SYNC~ is de-asserted. 0 = Normal operation 1 = ILA disabled |

9.6.2.18 Register 2Bh (address = 2Bh)
Figure 182. Register 2Bh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|------|------|------|------|--------|--------|
| 0 | 0 | 0 | 0 | 0 | 0 | CTRL K | CTRL F |
| W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | R/W-0h | R/W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 29. Register 2Bh Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------|------|-------|---|
| 7-2 | 0 | W | 0h | Must write 0. |
| 1 | CTRL K | R/W | 0h | Enable bit for the number of frames per multiframe. 0 = Default is 9 (20X mode) frames per multiframe 1 = Frames per multiframe can be set in register 31h |
| 0 | CTRL F | R/W | 0h | Enable bit for the number of octets per frame. 0 = 20X mode using one lane per ADC (default is F = 2) 1 = Octets per frame can be specified in register 30h |

9.6.2.19 Register 2Fh (address = 2Fh)
Figure 183. Register 2Fh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|------|------|------|------|------|------|------|
| SCRAMBLE EN | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| R/W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 30. Register 2Fh Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------|------|-------|---|
| 7 | SCRAMBLE EN | R/W | 0h | Scramble enable bit in the JESD204B interface. 0 = Scrambling disabled 1 = Scrambling enabled |
| 6-0 | 0 | W | 0h | Must write 0. |

9.6.2.20 Register 30h (address = 30h)
Figure 184. Register 30h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|---|---|---|---|---|---|---|
| OCTETS PER FRAME | | | | | | | |
| R/W-0h | | | | | | | |

LEGEND: R/W = Read/Write; -n = value after

Table 31. Register 30h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------------|------|-------|---|
| 7-0 | OCTETS PER FRAME | R/W | 0h | These bits set the number of octets per frame (F). 01 = 20X serialization: two octets per frame 11 = 40X serialization: four octets per frame |

9.6.2.21 Register 31h (address = 31h)
Figure 185. Register 31h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|------|------------------------|---|---|---|---|
| 0 | 0 | 0 | FRAMES PER MULTI FRAME | | | | |
| W-0h | W-0h | W-0h | R/W-0h | | | | |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 32. Register 31h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------------------|------|-------|--|
| 7-5 | 0 | W | 0h | Must write 0. |
| 4-0 | FRAMES PER MULTI FRAME | R/W | 0h | These bits set the number of frames per multiframe. After reset, the default settings for frames per multiframe are: 20X mode: K = 8 For each mode, K must not be set to a lower value. |

9.6.2.22 Register 34h (address = 34h)
Figure 186. Register 34h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----------|---|---|------|------|------|------|------|
| SUBCLASSV | | | 0 | 0 | 0 | 0 | 0 |
| R/W-0h | | | W-0h | W-0h | W-0h | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 33. Register 34h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-----------|------|-------|---|
| 7-5 | SUBCLASSV | R/W | 0h | JESD204B subclass setting. 000 = Subclass 0 backward compatibility with JESD204A 001 = Subclass 1 deterministic latency using the SYSREF signal 010 = Subclass 2 deterministic latency using SYNC~ detection |
| 4-0 | 0 | W | 0h | Must write 0. |

9.6.2.23 Register 3Ah (address = 3Ah)
Figure 187. Register 3Ah

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------|-------------|------|------|--------------------|---|---|---|
| SYNC REQ | SYNC REQ EN | 0 | 0 | OUTPUT CURRENT SEL | | | |
| R/W-0h | R/W-0h | W-0h | W-0h | R/W-0h | | | |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 34. Register 3Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------------|------|-------|--|
| 7 | SYNC REQ | R/W | 0h | This bit generates a synchronization request only when the SYNC REQ EN register bit is set. 0 = Normal operation 1 = Generates sync request |
| 6 | SYNC REQ EN | R/W | 0h | 0 = Sync request is made with the SYNC~ pins 1 = Sync request is made with the SYNC REQ register bit |
| 5-4 | 0 | W | 0h | Must write 0. |
| 3-0 | OUTPUT CURRENT SEL | R/W | 0h | JESD output buffer current selection. 0000 = 16 mA 0001 = 15 mA 0010 = 14 mA 0011 = 13 mA 0100 = 20 mA 0101 = 19 mA 0110 = 18 mA 0111 = 17 mA 1000 = 8 mA 1001 = 7 mA 1010 = 6 mA 1011 = 5 mA 1100 = 12 mA 1101 = 11 mA 1110 = 10 mA 1111 = 9 mA |

9.6.2.24 Register 3Bh (address = 3Bh)
Figure 188. Register 3Bh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------------|---|---|-----------------|------|-----------------|---|---|
| LINK LAYER TESTMODE | | | LINK LAYER RPAT | 0 | PULSE DET MODES | | |
| R/W-0h | | | R/W-0h | W-0h | R/W-0h | | |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 35. Register 3Bh Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|---------------------|------|-------|--|
| 7-5 | LINK LAYER TESTMODE | R/W | 0h | These bits generate a pattern according to section 5.3.3.8.2 of the JESD204B specification. 000 = Normal ADC data 001 = D21.5 (high-frequency jitter pattern) 010 = K28.5 (mixed-frequency jitter pattern) 011 = Repeat initial lane alignment (generates a K28.5 character and continuously repeats lane alignment sequences) 100 = 12 octet RPAT jitter pattern |
| 4 | LINK LAYER RPAT | R/W | 0h | This bit changes the running disparity in the modified RPAT pattern test mode (only when link layer test mode = 100). 0 = Normal operation 1 = Changes disparity |
| 3 | 0 | W | 0h | Must write 0. |
| 2-0 | PULSE DET MODES | R/W | 0h | These bits select different detection modes for SYSREF (subclass 1) and SYNC~ (subclass2). Register settings are listed in Table 36 . |

Table 36. PULSE DET MODES Register Settings

| D2 | D1 | D0 | FUNCTIONALITY |
|------------|-------------------|----|--|
| 0 | Don't care | 0 | Allow all pulses to reset input clock dividers |
| 1 | Don't care | 0 | Do not allow reset of analog clock dividers |
| Don't care | 0 to 1 transition | 1 | Allow one pulse immediately after the 0 to 1 transition to reset the divider |

9.6.2.25 Register 3Ch (address = 3Ch)
Figure 189. Register 3Ch

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------------|-----------------|---|---|---|---|------------------|---|
| FORCE LMFC COUNT | LMFC COUNT INIT | | | | | RELEASE ILAN SEQ | |
| R/W-0h | R/W-0h | | | | | R/W-0h | |

LEGEND: R/W = Read/Write; -n = value after

Table 37. Register 3Ch Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|------------------|------|-------|---|
| 7 | FORCE LMFC COUNT | R/W | 0h | 0 = Normal operation 1 = Enables using a different starting value for the LMFC counter |
| 6-2 | LMFC COUNT INIT | R/W | 0h | If SYSREF is transmitted to the digital block, the LMFC count resets to 0 and K28.5 stops transmitting when the LMFC count reaches 31. The initial value that the LMFC count resets to can be set using LMFC COUNT INIT. In this manner, the Rx can be synchronized early because the Rx receives the LANE ALIGNMENT SEQUENCE early. The FORCE LMFC COUNT register bit must be enabled. |
| 1-0 | RELEASE ILAN SEQ | R/W | 0h | These bits delay the lane alignment sequence generation by 0, 1, 2, or 3 multiframe after the code group synchronization. 00 = 0 01 = 1 10 = 2 11 = 3 |

9.6.2.26 Register 422h (address = 422h)
Figure 190. Register 422h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|------|------|------|------|-------------------|------|
| 0 | 0 | 0 | 0 | 0 | 0 | SPECIAL MODE2 CHA | 0 |
| W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-1h | W-0h |

LEGEND: W = Write only; -n = value after

Table 38. Register 422h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------------|------|-------|--|
| 7-2 | 0 | W | 0h | Must write 0. |
| 1 | SPECIAL MODE2 CHA | W | 1h | Always write 1 for improved HD2 performance. |
| 0 | 0 | W | 0h | Must write 0. |

9.6.2.27 Register 434h (address = 434h)
Figure 191. Register 434h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|--------------|------|--------------|------|------|------|
| 0 | 0 | DIS DITH CHA | 0 | DIS DITH CHA | 0 | 0 | 0 |
| W-0h | W-0h | R/W-0h | W-0h | R/W-0h | W-0h | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 39. Register 434h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|-------|---|
| 7-6 | 0 | W | 0h | Must write 0. |
| 5 | DIS DITH CHA | R/W | 0h | Set this bit along with bits 5 and 4 of register 01h. 00 = Default 11 = Dither is disabled for channel A. In this mode, SNR typically improves by 0.5 dB at 70 MHz. |
| 4 | 0 | W | 0h | Must write 0. |
| 3 | DIS DITH CHA | R/W | 0h | Set this bit along with bits 5 and 4 of register 01h. 00 = Default 11 = Dither is disabled for channel A. In this mode, SNR typically improves by 0.5 dB at 70 MHz. |
| 2-0 | 0 | W | 0h | Must write 0. |

9.6.2.28 Register 522h (address = 522h)
Figure 192. Register 522h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|------|------|------|------|------|-------------------|------|
| 0 | 0 | 0 | 0 | 0 | 0 | SPECIAL MODE2 CHB | 0 |
| W-0h | W-0h | W-0h | W-0h | W-0h | W-0h | W-1h | W-0h |

LEGEND: W = Write only; -n = value after

Table 40. Register 522h Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|-------------------|------|-------|--|
| 7-2 | 0 | W | 0h | Must write 0. |
| 1 | SPECIAL MODE2 CHB | W | 1h | Always write 1 for better HD2 performance. |
| 0 | 0 | W | 0h | Must write 0. |

9.6.2.29 Register 534h (address = 534h)

Figure 193. Register 534

| | | | | | | | |
|------|------|--------------|------|--------------|------|------|------|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | 0 | DIS DITH CHB | 0 | DIS DITH CHB | 0 | 0 | 0 |
| W-0h | W-0h | R/W-0h | W-0h | R/W-0h | W-0h | W-0h | W-0h |

LEGEND: R/W = Read/Write; W = Write only; -n = value after

Table 41. Register 534 Field Descriptions

| Bit | Field | Type | Reset | Description |
|-----|--------------|------|-------|---|
| 7-6 | 0 | W | 0h | Must write 0. |
| 5 | DIS DITH CHB | R/W | 0h | Set this bit along with bits 3 and 2 of register 01h. 00 = Default 11 = Dither is disabled for channel B. In this mode, SNR typically improves by 0.5 dB at 70 MHz. |
| 4 | 0 | W | 0h | Must write 0. |
| 3 | DIS DITH CHB | R/W | 0h | Set this bit along with bits 3 and 2 of register 01h. 00 = Default 11 = Dither is disabled for channel B. In this mode, SNR typically improves by 0.5 dB at 70 MHz. |
| 2-0 | 0 | W | 0h | Must write 0. |

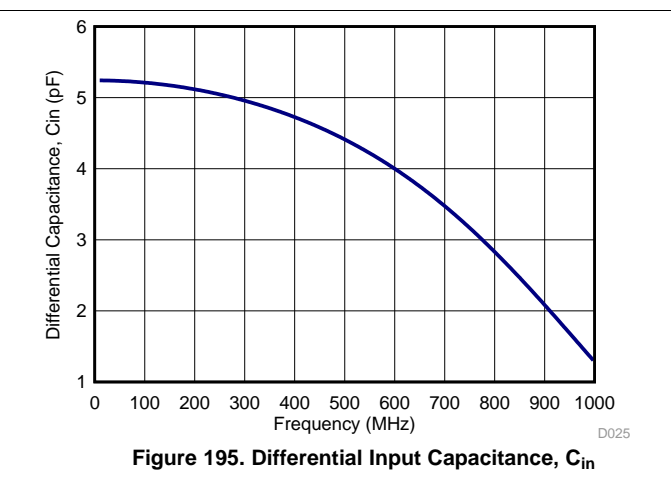
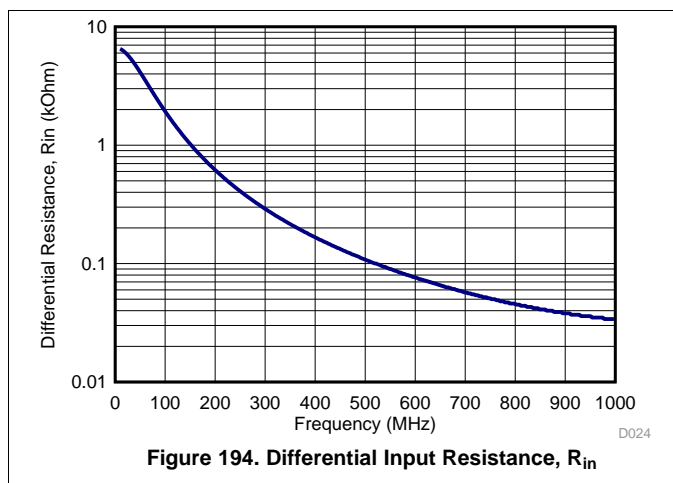
10 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

10.1 Application Information

Typical applications involving transformer-coupled circuits are discussed in this section. Transformers (such as ADT1-1WT or WBC1-1) can be used up to 250 MHz to achieve good phase and amplitude balances at ADC inputs. When designing the dc driving circuits, the ADC input impedance must be considered. Figure 194 and Figure 195 show the impedance ($Z_{in} = R_{in} || C_{in}$) across the ADC input pins.



10.2 Typical Applications

10.2.1 Driving Circuit Design: Low Input Frequencies

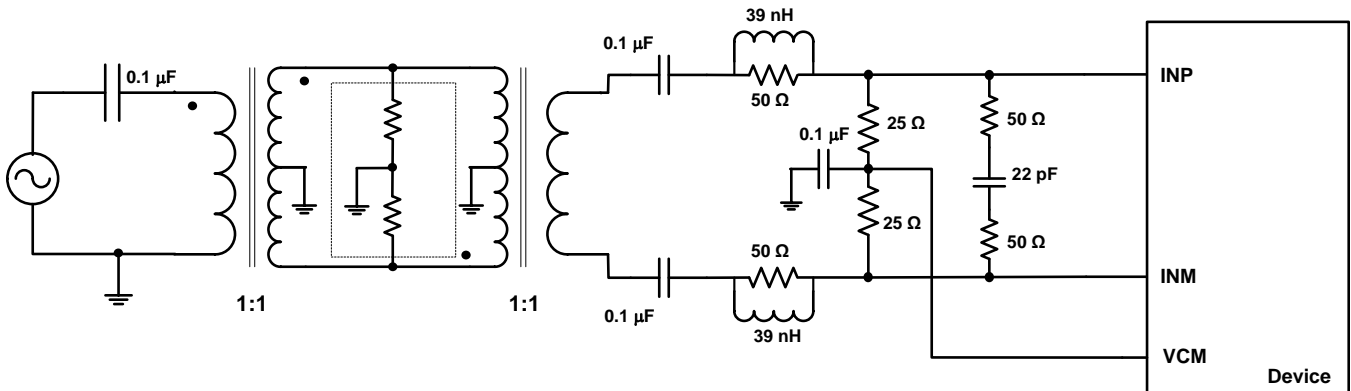


Figure 196. Driving Circuit for Low Input Frequencies

10.2.1.1 Design Requirements

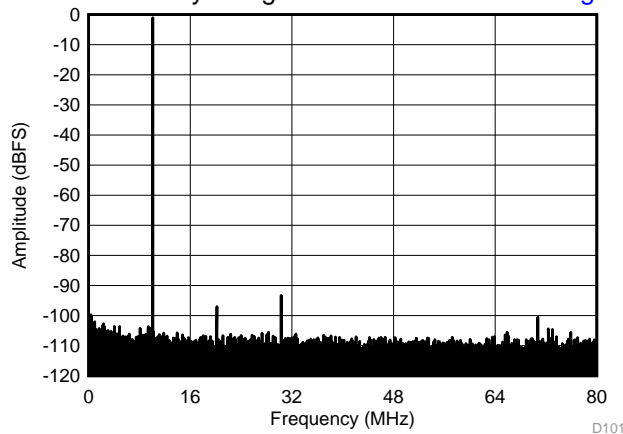
For optimum performance, the analog inputs must be driven differentially. An optional 5-Ω to 15-Ω resistor in series with each input pin can be kept to damp out ringing caused by package parasitics. The drive circuit may have to be designed to minimize the affect of kick-back noise generated by sampling switches opening and closing inside the ADC, as well as ensuring low insertion loss over the desired frequency range and matched impedance to the source.

10.2.1.2 Detailed Design Procedure

A typical application using two back-to-back coupled transformers is illustrated in Figure 196. The circuit is optimized for low input frequencies. An external R-C-R filter using 50-Ω resistors and a 22-pF capacitor is used. With the series inductor (39 nH), this combination helps absorb the sampling glitches.

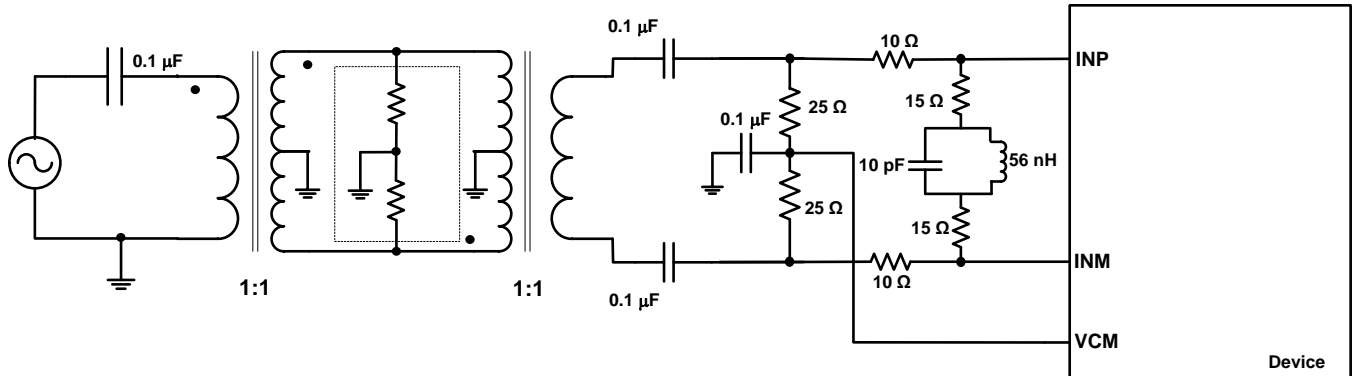
10.2.1.3 Application Curves

Figure 197 shows the performance obtained by using the circuit illustrated in Figure 196.



$$f_S = 160 \text{ MSPS}, \text{ SNR} = 72.4 \text{ dBFS}, f_{IN} = 10 \text{ MHz}, \\ \text{SFDR} = 92.3 \text{ dBc}$$

Figure 197. FFT for 10-MHz Input Signal (Dither On)

Typical Applications (continued)
10.2.2 Driving Circuit Design: Input Frequencies Between 100 MHz to 230 MHz

Figure 198. Driving Circuit for Mid-Range Input Frequencies ($100 \text{ MHz} < f_{\text{IN}} < 230 \text{ MHz}$)
10.2.2.1 Design Requirements

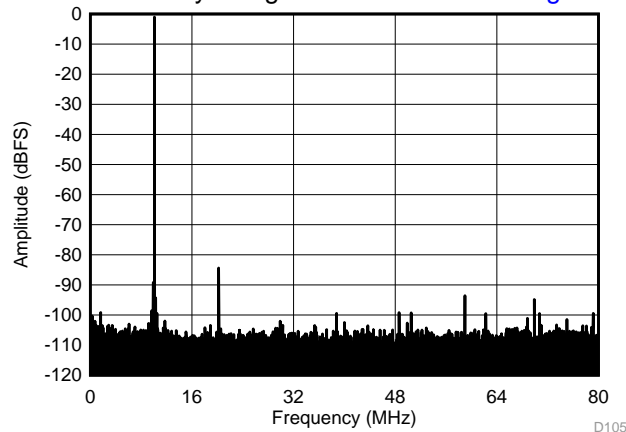
See the [Design Requirements](#) section for further details.

10.2.2.2 Detailed Design Procedure

When input frequencies are between 100 MHz to 230 MHz, an R-LC-R circuit can be used to optimize performance, as shown in [Figure 198](#).

10.2.2.3 Application Curve

[Figure 199](#) shows the performance obtained by using the circuit shown in [Figure 198](#).



$f_{\text{S}} = 160 \text{ MSPS}$, $\text{SNR} = 70.6 \text{ dBFS}$, $f_{\text{IN}} = 170 \text{ MHz}$,
 $\text{SFDR} = 94.4 \text{ dBc}$

Figure 199. FFT for 170-MHz Input Signal (Dither On)

Typical Applications (continued)

10.2.3 Driving Circuit Design: Input Frequencies Greater than 230 MHz

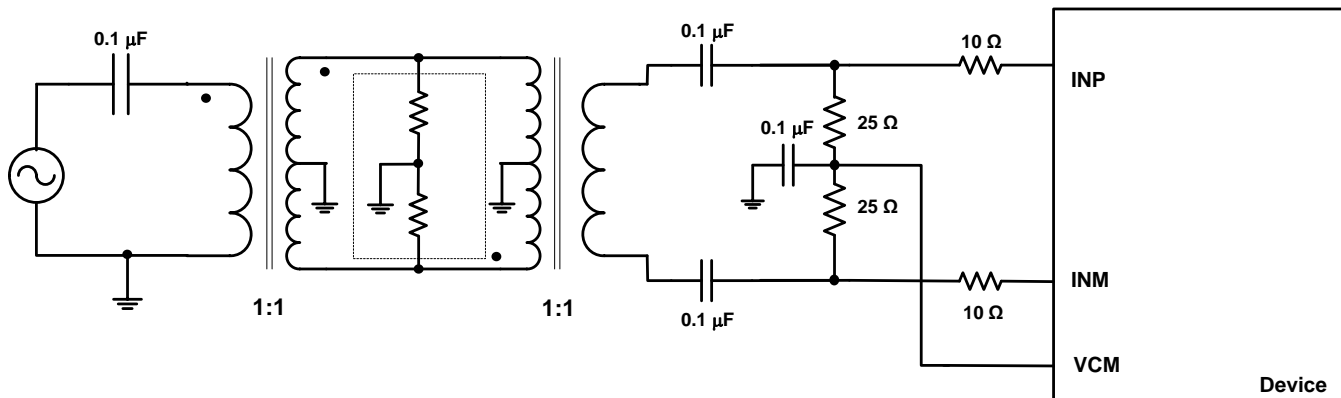


Figure 200. Driving Circuit for High Input Frequencies ($f_{IN} > 230$ MHz)

10.2.3.1 Design Requirements

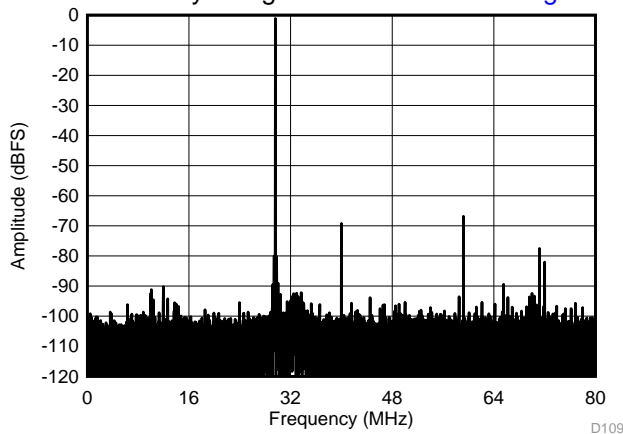
See the [Design Requirements](#) section for further details.

10.2.3.2 Detailed Design Procedure

For high input frequencies (> 230 MHz), using the R-C-R or R-LC-R circuit does not show significant improvement in performance. However, a series resistance of $10\ \Omega$ can be used, as shown in [Figure 200](#).

10.2.3.3 Application Curve

[Figure 201](#) shows the performance obtained by using the circuit shown in [Figure 200](#).



$$f_S = 160 \text{ MSPS}, \text{ SNR} = 63.2 \text{ dBFS}, f_{IN} = 450 \text{ MHz}, \\ \text{SFDR} = 65.7 \text{ dBc}$$

Figure 201. FFT for 450-MHz Input Signal (Dither On)

11 Power-Supply Recommendations

The device requires a 1.8-V nominal supply for AVDD and DVDD. There are no specific sequence power-supply requirements during device power-up. AVDD and DVDD can power up in any order.

12 Layout

12.1 Layout Guidelines

The ADC32J4x EVM layout can be used as a reference layout to obtain the best performance. A layout diagram of the EVM top layer is provided in [Figure 202](#). Some important points to remember when laying out the board are:

1. Analog inputs are located on opposite sides of the device pin out to ensure minimum crosstalk on the package level. To minimize crosstalk onboard, the analog inputs must exit the pin out in opposite directions as much as possible, as shown in the reference layout of [Figure 202](#).
2. In the device pin out, the sampling clock is located on a side perpendicular to the analog inputs in order to minimize coupling between them. This configuration is also maintained on the reference layout of [Figure 202](#) as much as possible.
3. Keep digital outputs away from the analog inputs. When these digital outputs exit the pin out, the digital output traces must not be kept parallel to the analog input traces because this configuration may result in coupling from digital outputs to analog inputs and degrade performance. All digital output traces to the receiver [such as a field-programmable gate array (FPGA) or an application-specific integrated circuit (ASIC)] must be matched in length to avoid skew among outputs.
4. At each power-supply pin (AVDD and DVDD), a 0.1- μF decoupling capacitor must be kept close to the device. A separate decoupling capacitor group consisting of a parallel combination of 10- μF , 1- μF , and 0.1- μF capacitors can be kept close to the supply source.

12.2 Layout Example

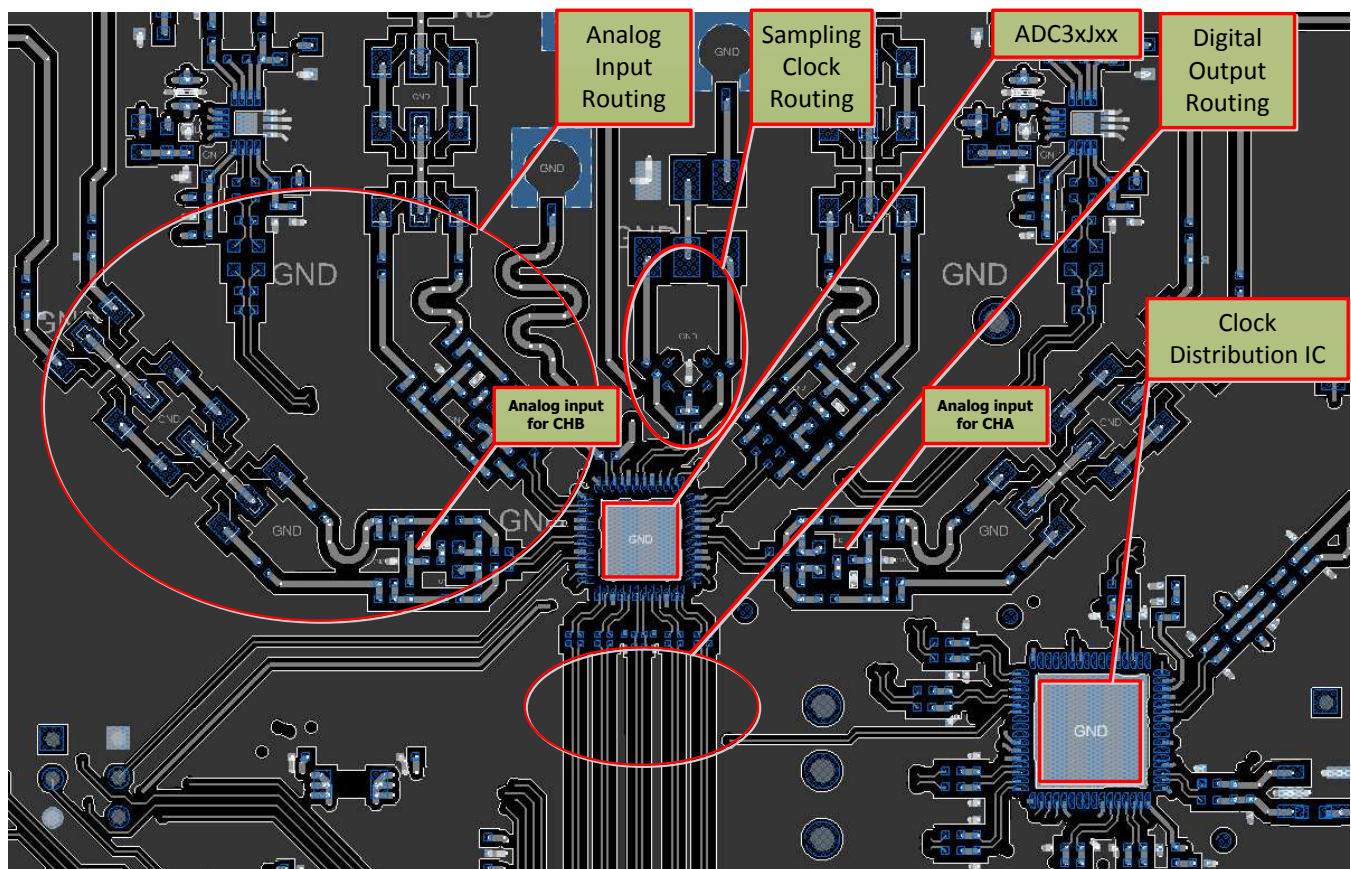


Figure 202. Typical Layout of the ADC32J4x Board

13 器件和文档支持

13.1 相关链接

表 42 列出了快速访问链接。范围包括技术文档、支持与社区资源、工具和软件，并且可以快速访问样片或购买链接。

表 42. 相关链接

| 器件 | 产品文件夹 | 样片与购买 | 技术文档 | 工具与软件 | 支持与社区 |
|----------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|
| ADC32J45 | 请单击此处 | 请单击此处 | 请单击此处 | 请单击此处 | 请单击此处 |
| ADC32J44 | 请单击此处 | 请单击此处 | 请单击此处 | 请单击此处 | 请单击此处 |
| ADC32J43 | 请单击此处 | 请单击此处 | 请单击此处 | 请单击此处 | 请单击此处 |
| ADC32J42 | 请单击此处 | 请单击此处 | 请单击此处 | 请单击此处 | 请单击此处 |

13.2 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

13.3 商标

E2E is a trademark of Texas Instruments.
PowerPAD is a trademark of Texas Instruments, Inc.
All other trademarks are the property of their respective owners.

13.4 静电放电警告



这些装置包含有限的内置 ESD 保护。存储或装卸时，应将导线一起截短或将装置放置于导电泡棉中，以防止 MOS 门极遭受静电损伤。

13.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

14 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。 这些信息是针对指定器件可提供的最新数据。 这些数据会在无通知且不对本文档进行修订的情况下发生改变。 欲获得该数据表的浏览器版本，请查阅左侧的导航栏。

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| ADC32J42IRGZR | ACTIVE | VQFN | RGZ | 48 | 2500 | RoHS & Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32J42 | Samples |
| ADC32J42IRGZT | ACTIVE | VQFN | RGZ | 48 | 250 | RoHS & Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32J42 | Samples |
| ADC32J43IRGZR | ACTIVE | VQFN | RGZ | 48 | 2500 | RoHS & Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32J43 | Samples |
| ADC32J43IRGZT | ACTIVE | VQFN | RGZ | 48 | 250 | RoHS & Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32J43 | Samples |
| ADC32J44IRGZR | ACTIVE | VQFN | RGZ | 48 | 2500 | RoHS & Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32J44 | Samples |
| ADC32J44IRGZT | ACTIVE | VQFN | RGZ | 48 | 250 | RoHS & Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32J44 | Samples |
| ADC32J45IRGZR | ACTIVE | VQFN | RGZ | 48 | 2500 | RoHS & Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32J45 | Samples |
| ADC32J45IRGZT | ACTIVE | VQFN | RGZ | 48 | 250 | RoHS & Green | NIPDAUAG | Level-3-260C-168 HR | -40 to 85 | AZ32J45 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADC32J42IRGZR | VQFN | RGZ | 48 | 2500 | 330.0 | 16.4 | 7.3 | 7.3 | 1.5 | 12.0 | 16.0 | Q2 |
| ADC32J43IRGZR | VQFN | RGZ | 48 | 2500 | 330.0 | 16.4 | 7.3 | 7.3 | 1.5 | 12.0 | 16.0 | Q2 |
| ADC32J44IRGZR | VQFN | RGZ | 48 | 2500 | 330.0 | 16.4 | 7.3 | 7.3 | 1.5 | 12.0 | 16.0 | Q2 |
| ADC32J45IRGZR | VQFN | RGZ | 48 | 2500 | 330.0 | 16.4 | 7.3 | 7.3 | 1.5 | 12.0 | 16.0 | Q2 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADC32J42IRGZR | VQFN | RGZ | 48 | 2500 | 350.0 | 350.0 | 43.0 |
| ADC32J43IRGZR | VQFN | RGZ | 48 | 2500 | 350.0 | 350.0 | 43.0 |
| ADC32J44IRGZR | VQFN | RGZ | 48 | 2500 | 350.0 | 350.0 | 43.0 |
| ADC32J45IRGZR | VQFN | RGZ | 48 | 2500 | 350.0 | 350.0 | 43.0 |

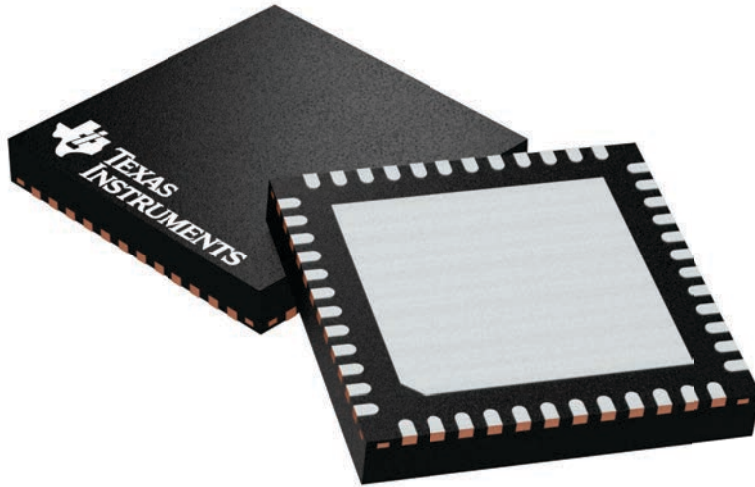
GENERIC PACKAGE VIEW

RGZ 48

VQFN - 1 mm max height

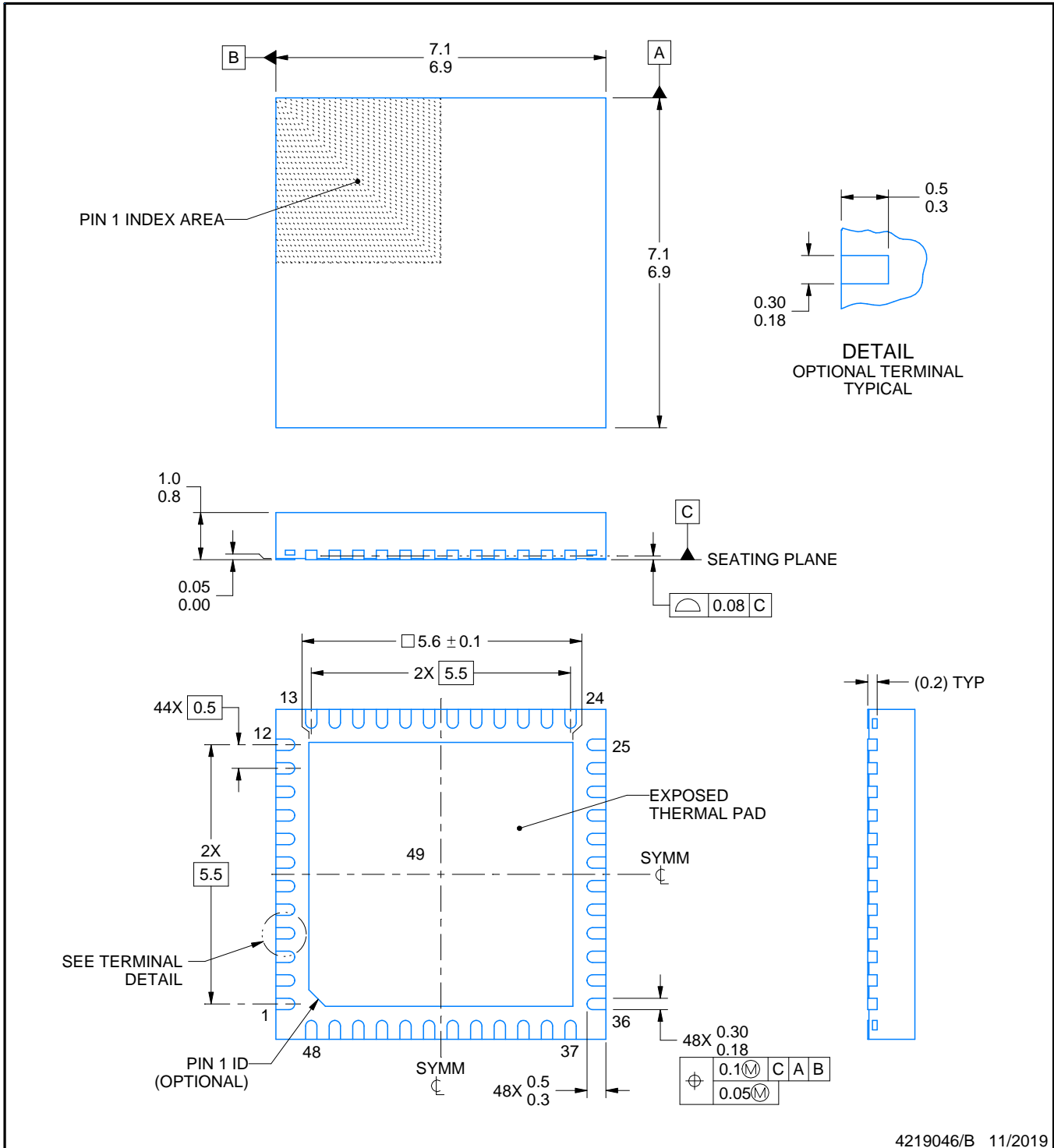
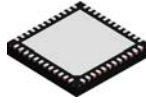
7 x 7, 0.5 mm pitch

PLASTIC QUADFLAT PACK- NO LEAD



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4224671/A



4219046/B 11/2019

NOTES:

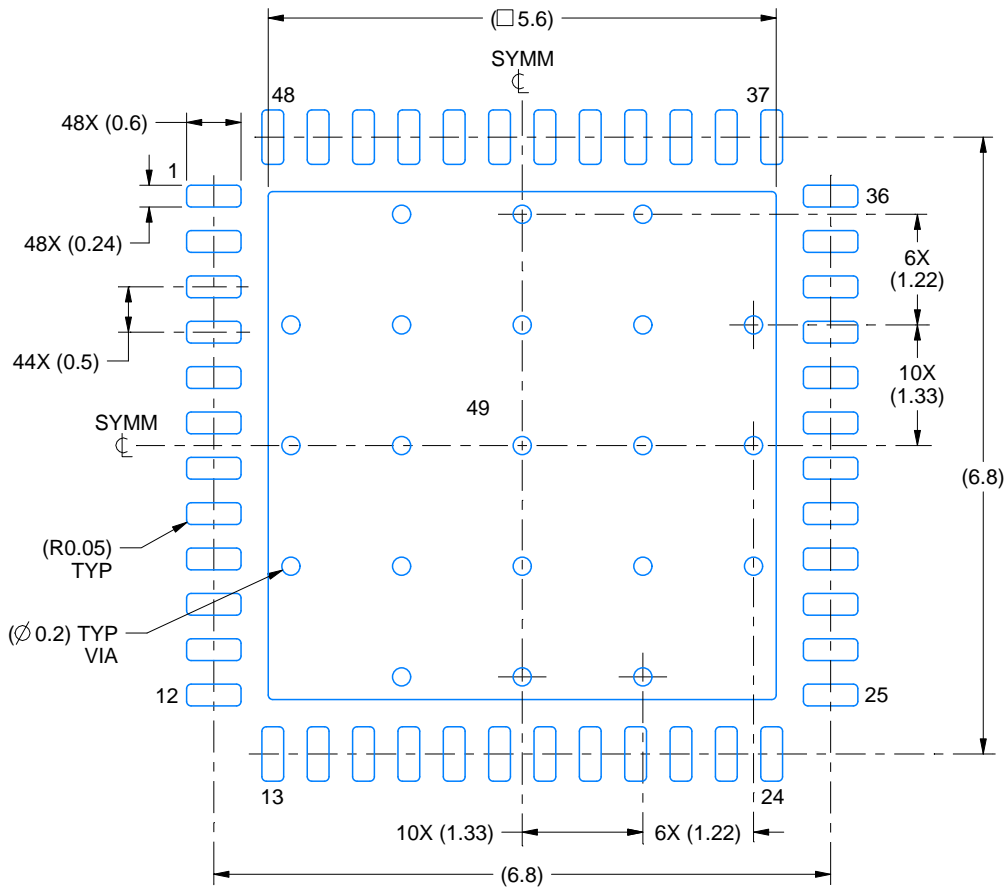
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

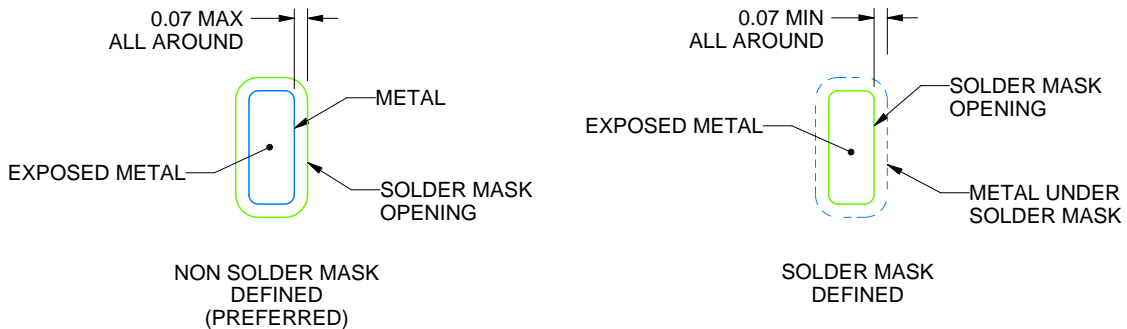
RGZ0048D

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:12X



SOLDER MASK DETAILS

4219046/B 11/2019

NOTES: (continued)

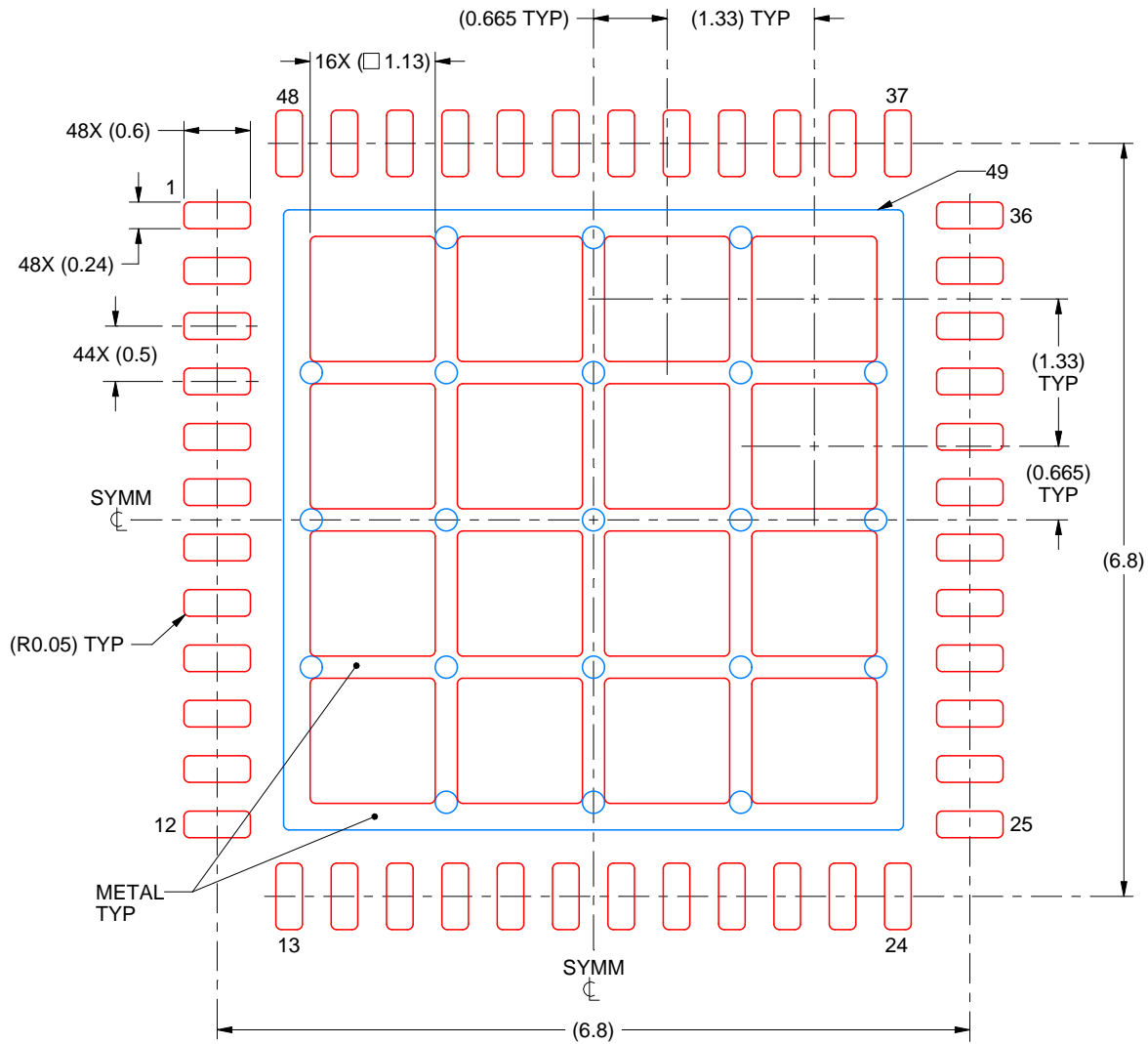
- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

EXAMPLE STENCIL DESIGN

RGZ0048D

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
 BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 49
 66% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
 SCALE:15X

4219046/B 11/2019

NOTES: (continued)

- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

重要声明和免责声明

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